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M. Sc. in Electrical and Computer Engineering

# **Contribution for the Study of Inductive Fault Current Limiters in Electrical Distribution Grids**

Dissertation to obtain the degree of Doctor of Philosophy in  
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*To my family and friends...*

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## Abstract

Inductive type fault current limiters with superconducting tapes are emerging devices that provide technology for the advent of modern electrical grids, helping to mitigate operational problems that such grids can experience as well as preventing the often-costly upgrade of power equipment, namely protections. The development of such limiters leads to several design challenges regarding the constitutive parts of those devices, namely the magnetic core, primary winding and superconducting secondary.

Fault current limiters are required to operate at overcurrents during a certain amount of time. The operation at such currents can lead to harmful effects due to mechanical, electromagnetic and thermal stresses, especially in the superconducting tape. Since the operation principle of fault current limiters envisaged in this thesis is based on the superconducting-normal transition of superconducting materials, the study of its transient behaviour is an important research subject.

In this work, an electromagnetic methodology based on the characteristics of the constitutive parts of the limiters, previously developed and compared to finite element modelling simulations with very similar results, is simulated and validated with experimental results. Furthermore, the current in the superconducting tape is modelled from experimental results with the purpose of predicting the temperature of the material during normal and fault operation conditions, by employing a thermal-electrical analogy. These results are also compared to experimental measurements. A fast simulation tool, with computation times in the order of minutes, is also developed in Simulink, from Matlab environment.

With the developed simulation tool, it is possible to quickly predict the transient electromagnetic-thermal behaviour of an inductive type fault current limiter operating in electrical grids, namely the line current and primary linked flux, as well as current and temperature in the superconducting tape.

**Keywords:** Electromagnetic-Thermal Coupling, Inductive Fault Current Limiters, Modelling, Superconducting Tapes, Transient Simulations.



## Resumo

Os limitadores de corrente de defeito do tipo indutivo com fitas supercondutoras são dispositivos emergentes que fornecem tecnologia para o advento das redes elétricas modernas, ajudando a mitigar problemas operacionais que tais redes podem experienciar, assim como prevenir uma atualização, geralmente dispendiosa, do equipamento da rede, nomeadamente ao nível das proteções. Do desenvolvimento de tais limitadores, decorrem diversos desafios de desenho respeitantes às partes constitutivas desses dispositivos, nomeadamente o núcleo magnético, enrolamento primário convencional e o secundário supercondutor.

É requisito que os limitadores de corrente de defeito operem em regime de sobrecorrente. Tal regime de operação pode conduzir a efeitos potencialmente destrutivos devido a esforços mecânicos, eletromagnéticos e térmicos, em especial na fita supercondutora. Uma vez que o princípio de operação dos limitadores de corrente de defeito abordados nesta dissertação é baseado na transição entre as fases supercondutora-normal dos materiais supercondutores, o estudo do comportamento transitório é um importante assunto de investigação.

Neste trabalho, uma metodologia assente nos princípios eletromagnéticos e baseada nas características das partes constitutivas dos limitadores, previamente desenvolvida e comparada a simulações por elementos finitos com resultados bastante semelhantes, é simulada e validada com recurso a resultados experimentais. Adicionalmente, a corrente na fita supercondutora é modelizada a partir de resultados experimentais com o propósito de determinar a temperatura do material durante operação normal e em falha, utilizando uma analogia térmica-elétrica. Estes resultados também são comparados com medições experimentais. Uma ferramenta de simulação rápida, com tempos de computação na ordem dos minutos, fora, também, desenvolvida em Simulink, do ambiente de computação Matlab.

Com recurso à ferramenta de simulação desenvolvida, é possível determinar, de uma forma rápida, o comportamento transitório eletromagnético-térmico de um limitador de corrente de falha indutivo em redes elétricas, designadamente a corrente de linha e fluxo ligado com o primário, assim como a corrente e temperatura na fita supercondutora.

**Palavras-chave:** Acoplamento Eletromagnético-térmico, Fitas Supercondutoras, Limitadores de Corrente de Falha Supercondutores, Modelização, Simulações em Regime Transitório.



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## List of Symbols

Symbol	Meaning
$A$	Surface area ( $m^2$ ) or cross section area ( $m^2$ ) or value of magnetomotive force ( $A \cdot t$ )
$A_{Conv}$	Surface area subjected to convection ( $m^2$ )
$A_f$	Constant of the auxiliary sinusoidal function (A)
$A_k$	Surface area of heat exchange of layer $k$ ( $m^2$ )
$a$	Geometrical parameter in four points method (m)
$a_0$	Fitting parameter in the methodology based on the maximum hysteresis loop (H)
$B$	Flux density (T) or value of magnetomotive force ( $A \cdot t$ )
$B_f$	Constant of the auxiliary sinusoidal function ( $A^{-1}$ )
$b$	Geometrical parameter in four points method (m)
$b_0$	Fitting parameter in the methodology based on the maximum hysteresis loop (H)
$C$	Heat capacity ( $J \cdot K^{-1}$ ) or value of magnetomotive force ( $A \cdot t$ ) or capacitance (F)
$C_{Ag(i)}$	Volumetric heat capacity of inner layer of silver ( $J \cdot m^{-3} \cdot K^{-1}$ ) or capacitance representing the volumetric heat capacity of inner layer of silver (F)
$C_{Ag(o)}$	Volumetric heat capacity of outer layer of silver ( $J \cdot m^{-3} \cdot K^{-1}$ ) or capacitance representing the volumetric heat capacity of outer layer of silver (F)
$C_{Cu(i)}$	Volumetric heat capacity of inner layer of copper ( $J \cdot m^{-3} \cdot K^{-1}$ ) or capacitance representing the volumetric heat capacity of inner layer of copper (F)
$C_{Cu(o)}$	Volumetric heat capacity of outer layer of copper ( $J \cdot m^{-3} \cdot K^{-1}$ ) or capacitance representing the volumetric heat capacity of outer layer of copper (F)
$C_{Hast}$	Volumetric heat capacity of Hastelloy ( $J \cdot m^{-3} \cdot K^{-1}$ ) or capacitance representing the volumetric heat capacity of Hastelloy (F)
$C_{YBCO}$	Volumetric heat capacity of YBCO ( $J \cdot m^{-3} \cdot K^{-1}$ ) or capacitance representing the volumetric heat capacity of YBCO (F)
$C_k$	Capitance representing the volumetric heat capacity of layer $k$ (F)
$c$	Geometrical parameter in four points method (m) or specific heat capacity ( $J \cdot kg^{-1} \cdot K^{-1}$ )
$c_0$	Fitting parameter in the methodology based on the maximum hysteresis loop

$c_k$	Specific heat of layer $k$ ( $\text{J}\cdot\text{kg}^{-1}\cdot\text{K}^{-1}$ )
$D$	Value of magnetomotive force ( $\text{A}\cdot\text{t}$ )
$d$	Geometrical parameter in four points method (m)
$d_0$	Fitting parameter in the methodology based on the maximum hysteresis loop ( $(\text{A}\cdot\text{t})^{-1}$ )
$d_k$	Mass density of layer $k$ ( $\text{kg}\cdot\text{m}^{-3}$ )
$E$	Electrical field ( $\text{V}\cdot\text{m}^{-1}$ ) or scaling factor of current
$E_C$	Critical electrical field ( $\text{V}\cdot\text{m}^{-1}$ )
$E_{\%}$	Error between simulation and experimental results (%)
$e$	Geometrical parameter in four points method (m)
$F$	Scaling factor of current
$f$	Frequency (Hz) or auxiliary sinusoidal function (A)
$G$	Scaling factor of current
$H$	Magnetic field ( $\text{A}\cdot\text{m}^{-1}$ ) or scaling factor of current
$h_0$	Parameter for calculation of the convective heat transfer coefficient
$h_1$	Parameter for calculation of the convective heat transfer coefficient
$h_2$	Parameter for calculation of the convective heat transfer coefficient
$h_3$	Parameter for calculation of the convective heat transfer coefficient
$h_4$	Parameter for calculation of the convective heat transfer coefficient
$h_5$	Parameter for calculation of the convective heat transfer coefficient
$h_{Conv}$	Convective heat transfer coefficient ( $\text{W}\cdot\text{m}^{-2}\cdot\text{K}^{-1}$ )
$h_{Conv(i)}$	Convective heat transfer coefficient of inner surface ( $\text{W}\cdot\text{m}^{-2}\cdot\text{K}^{-1}$ )
$h_{Conv(o)}$	Convective heat transfer coefficient of outer surface ( $\text{W}\cdot\text{m}^{-2}\cdot\text{K}^{-1}$ )
$I$	Current amplitude (A)
$I_0$	Current fitting parameter (A)
$I_1$	Amplitude of the current in primary (A)
$I_{2,p}$	Maximum amplitude of the superconducting current (A)
$I_C$	Critical current (A)

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$I_{SC}$	Short-circuit current of a grid (A)
$I_{l\%}$	Limiting capacity (%)
$I_{p_1}$	Current fitting parameter (A)
$I_{p_2}$	Current fitting parameter (A)
$I_{HTS}^*$	Maximum induced current in the superconducting element for which line current is not limited (A)
$i_1$	Current in primary (A)
$i_2$	Induced current in superconducting ring (A)
$i_{2,F}$	Current in secondary during fault operation (A)
$i_{2,N}$	Current in secondary during normal operation (A)
$i_{Ag(i)}$	Current in inner layer of silver (A)
$i_{Ag(o)}$	Current in outer layer of silver (A)
$i_{Cu(i)}$	Current in inner layer of copper (A)
$i_{Cu(o)}$	Current in outer layer of copper (A)
$i_{Hast}$	Current in Hastelloy (A)
$i_L$	Line current (A)
$i_{YBCO}$	Current in YBCO (A)
$i_l$	Limited current (A)
$i_p$	Prospective current (A)
$i_k$	Current of layer $k$ (A)
$J$	Current density ( $A \cdot m^{-2}$ )
$J_C$	Critical current density ( $A \cdot m^{-2}$ )
$k$	Thermal conductivity ( $W \cdot m^{-1} \cdot K^{-1}$ )
$k_{Ag}$	Thermal conductivity of silver ( $W \cdot m^{-1} \cdot K^{-1}$ )
$k_{Cu}$	Thermal conductivity of copper ( $W \cdot m^{-1} \cdot K^{-1}$ )
$k_{Hast}$	Thermal conductivity of Hastelloy ( $W \cdot m^{-1} \cdot K^{-1}$ )
$k_{YBCO}$	Thermal conductivity of YBCO ( $W \cdot m^{-1} \cdot K^{-1}$ )

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$k_k$	Thermal conductivity of layer $k$ ( $\text{W}\cdot\text{m}^{-1}\cdot\text{K}^{-1}$ )
$L$	Inductance (H)
$L_1$	Inductance of primary (H)
$L_2$	Inductance of secondary (H)
$L_M$	Mutual inductance (H)
$l$	Mean magnetic path length (m)
$l_k$	Length of layer $k$ (m)
$m$	Mass of a material (kg)
$N$	Transform ratio
$N_1$	Number of turns of primary
$N_2$	Number of turns of secondary
$N_{Aux}$	Number of turns of auxiliary coil
$n$	$n$ -index
$P_{Ag(i)}$	Current representing heat generated in inner layer of silver (A)
$P_{Ag(o)}$	Current representing heat generated in outer layer of silver (A)
$P_{Cu(i)}$	Current representing heat generated in inner layer of copper (A)
$P_{Cu(o)}$	Current representing heat generated in outer layer of copper (A)
$P_{Hast}$	Current representing heat generated in Hastelloy (A)
$P_{YBCO}$	Current representing heat generated in YBCO (A)
$P_k$	Current representing heat generated in layer $k$ (A)
$Q$	Amount of heat (J)
$\dot{Q}_{Cond}$	Rate of conduction heat flow ( $\text{J}\cdot\text{s}^{-1}$ )
$\dot{Q}_{Conv}$	Rate of convection heat flow ( $\text{J}\cdot\text{s}^{-1}$ )
$R$	Resistance ( $\Omega$ )
$R_1$	Resistance 1 of signal conditioning ( $\Omega$ ) or resistance of primary ( $\Omega$ )
$R_2$	Resistance 2 of signal conditioning ( $\Omega$ ) or resistance of secondary ( $\Omega$ )
$R_3$	Resistance 3 of signal conditioning ( $\Omega$ )

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$R_4$	Resistance 4 of signal conditioning ( $\Omega$ )
$R_{Conv(i)}$	Electrical resistance representing the convective heat exchange with liquid nitrogen in inner surface ( $\Omega$ )
$R_{Conv(o)}$	Electrical resistance representing the convective heat exchange with liquid nitrogen in outer surface ( $\Omega$ )
$R_{e,Ag(i)}$	Electrical resistance of inner layer of silver ( $\Omega$ )
$R_{e,Ag(o)}$	Electrical resistance of outer layer of silver ( $\Omega$ )
$R_{e,Cu(i)}$	Electrical resistance of inner layer of copper ( $\Omega$ )
$R_{e,Cu(o)}$	Electrical resistance of outer layer of copper ( $\Omega$ )
$R_{e,Hast}$	Electrical resistance of Hastelloy ( $\Omega$ )
$R_{e,YBCO}$	Electrical resistance of YBCO ( $\Omega$ )
$R_{t,Ag(i)}$	Thermal resistance of inner layer of silver ( $\Omega$ )
$R_{t,Ag(o)}$	Thermal resistance of outer layer of silver ( $\Omega$ )
$R_{t,Cu(i)}$	Thermal resistance of inner layer of copper ( $\Omega$ )
$R_{t,Cu(o)}$	Thermal resistance of outer layer of copper ( $\Omega$ )
$R_{t,Hast}$	Thermal resistance of Hastelloy ( $\Omega$ )
$R_{t,YBCO}$	Thermal resistance of YBCO ( $\Omega$ )
$R_{t,k}$	Thermal resistance of layer $k$ simulating conduction ( $\Omega$ )
$S$	Cross section area of magnetic core ( $m^2$ )
$T$	Temperature (K)
$T_0$	Temperature of liquid nitrogen (77.3 K)
$T_{Ag(i)}$	Temperature of inner layer of silver (K)
$T_{Ag(o)}$	Temperature of outer layer of silver (K)
$T_{Cu(i)}$	Temperature of inner layer of copper (K)
$T_{Cu(o)}$	Temperature of outer layer of copper (K)
$T_D$	Measured temperature from silicon diode (K)
$T_{Hast}$	Temperature of Hastelloy (K)

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$T_{LN_2}$	Temperature of liquid nitrogen (K)
$T_{YBCO}$	Temperature of YBCO (K)
$T_k$	Temperature of layer $k$ (K)
$t$	Time (s)
$t_{SC}$	Instantaneous time after short-circuit (s)
$t_k$	Sample $k$ of discrete time (s)
$U$	Voltage drop (V)
$U_C$	Critical voltage drop (V)
$u_1$	Voltage drop at the primary (V)
$u_{Aux}$	Voltage drop of auxiliary coil (V)
$u_{FCL}$	Voltage drop at the terminals of the fault current limiter (V)
$u_{Grid}$	Grid voltage (V)
$v_0$	Output voltage (V)
$v_1$	Terminal 1 of input voltage (V)
$v_2$	Terminal 2 of input voltage (V)
$v_D$	Voltage drop at terminals of silicon diode (V)
$x_{Exp}$	Experimental quantity (A or Wb or K)
$x_{Sim}$	Simulated quantity (A or Wb or K)
$\gamma$	Fitting parameter
$\delta$	Fitting parameter
$\kappa$	Fitting parameter
$\lambda_a$	Ascending branch of linked flux (Wb)
$\lambda_d$	Descending branch of linked flux (Wb)
$\rho$	Resistivity ( $\Omega\cdot m$ )
$\rho_0$	Additional resistivity ( $\Omega\cdot m$ )
$\rho_{Ag(i)}$	Electrical resistivity of inner layer of silver ( $\Omega\cdot m$ )
$\rho_{Ag(o)}$	Electrical resistivity of outer layer of silver ( $\Omega\cdot m$ )

$\rho_{Cu(i)}$	Electrical resistivity of inner layer of copper ( $\Omega\cdot\text{m}$ )
$\rho_{Cu(o)}$	Electrical resistivity of outer layer of copper ( $\Omega\cdot\text{m}$ )
$\rho_{Hast}$	Electrical resistivity of Hastelloy ( $\Omega\cdot\text{m}$ )
$\rho_{YBCO}$	Electrical resistivity of YBCO ( $\Omega\cdot\text{m}$ )
$\rho_{YBCO,N}$	Electrical resistivity of YBCO in normal state ( $\Omega\cdot\text{m}$ )
$\rho_{YBCO,S}$	Electrical resistivity of YBCO in superconducting state ( $\Omega\cdot\text{m}$ )
$\rho_k$	Electrical resistivity of layer $k$ ( $\Omega\cdot\text{m}$ )
$\tau_1$	Time constant parameter (s)
$\tau_2$	Time constant parameter (s)
$\psi_0$	Linked flux with the primary in a magnetic core without secondary (Wb)
$\psi_{FCL}$	Primary linked flux of a fault current limiter (Wb)
$\nabla T$	Thermal gradient ( $\text{K}\cdot\text{m}^{-1}$ )
$\Delta T$	Temperature variation (K)
$\Delta t$	Time step (s)



## List of Acronyms

<b>Acronym</b>	<b>Meaning</b>
(RE)BCO	Alloy of rare-earth element with barium-copper-oxide
1G	First generation superconducting material
2G	Second generation superconducting material
ABB	Asea Brown Boveri Company
AC	Alternating current
APER	Aperture
Bi-2212	Bismuth-strontium-calcium-copper-oxide, $\text{Bi}_2\text{Sr}_2\text{CaCu}_2\text{O}_{8+x}$
Bi-2223	Bismuth-strontium-calcium-copper-oxide, $(\text{Bi,Pb})_2\text{Sr}_2\text{Ca}_2\text{Cu}_3\text{O}_{10-x}$
BLCO	Barium-lanthanum-copper-oxide
BSCCO	Bismuth-strontium-calcium-copper-oxide
CLiP	Current limiting protector
CNC	Computer numeric machine
CRIEPI	Central Research Institute of the Electric Power Industry
DC	Direct current
DIG	Digits
EMTP	Electromagnetic Transient Program
FCL	Fault current limiter
FEM	Finite element modelling
GTO	Gate turn-off thyristor
GUI	Graphical user interface
HBCCO	Mercury-barium-calcium-copper-oxide
HTS	High-temperature superconductivity or high-temperature superconducting
IBAD	Ion beam assisted deposition
IEEE	Institute of Electrical and Electronics Engineers
IEL	Instytut Elektrotechniki

IGBT	Insulated-gate bipolar transistor
iSFCL	Inductive superconducting fault current limiter from Bruker
LTS	Low-temperature superconductivity or low-temperature superconductor
MagLev	Magnetic levitation
MOCVD	Metal organic chemical vapour deposition
MRI	Magnetic resonance imaging
NPLC	Number of power line cycles
RTD	Resistance temperature detector
rms	Root-mean-square
S/N	Superconducting/normal transition
SEM	Scanning electron microscopy
SFCL	Superconducting fault current limiter
SFCLT	Superconducting fault current limiter-transformer
SMES	Superconducting magnetic energy storage
TBCCO	Thallium-barium-calcium-copper-oxide
TSMG	Top-seeded melt growth
YBCO	Yttrium-barium-copper-oxide



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## ***Introduction***

The increased penetration of distributed power generation in electrical distribution and transmission power grids generally leads to higher fault current levels. To cope with such fault current levels, besides the topological measures based on splitting into sub-grids or busbars, there are several devices such as high voltage fuses, pyrotechnic breakers, air-core reactors and power electronic circuit breakers. However, these conventional measures and devices present some drawbacks as the case of the permanent increase of the impedance not only at fault operation regime but also at nominal operation regime. For these reasons, fault current limiters (FCLs) based on superconducting materials have been developed, in which superior performance can be achieved in comparison with conventional current limiting devices. Features such as negligible impedance at nominal conditions, fast and effective current limitation, and fast and automatic recovery after a fault can be accomplished by superconducting FCLs [1].

Superconducting materials, especially those based on ceramic oxides, are currently under intense research and development (R&D) and their recent developments show potential viability for practical applications in power systems due to excellent electrical and magnetic properties of such developed materials. On the one hand, the replacement of conventional conductors by superconductors in electrical equipment, such as cables, transformers and machines, provides lower losses in the electrical systems and, on the other hand, emerging devices are appearing without any counterpart in the conventional electrical devices, such as FCLs, which can help to mitigate several faulty operation problems in electrical grids [2].

Inductive FCLs, such as transformer type, are considered as emerging devices that provide technology for electrical grids, helping to mitigate several operational problems that such grids can experience as well as preventing the upgrade of the equipment.

This work addresses the topic of FCLs which is an evolving topic in the field of electrical grids. Before real application of FCLs in distribution electrical grids, several problems need to be investigated whereby this document presents a contribution to the study of these type of FCLs, addressing the design, modelling and experimental assessment of an inductive type FCL prototype.

## 1.1 Background and Motivation

The emergence of distributed generation triggered the connection of new power plants to transmission and distribution networks which consequently leads to an increased risk of steady-state overload and potential of short-circuit occurrences. Strengthening the grid with new parallel routes contributes to mitigating steady-state overload but not for short-circuit faults whereby additional measures should be taken into account [1], [3], [4].

Electrical power protections are designed to maintain power networks highly reliable and fault-safe, contributing to cost savings and operational optimisation of such networks. It is very common the oversizing of such equipment to cope with faults, especially those based on short-circuit occurrences, whose values may highly exceed the nominal ones by a factor of 100 or higher [5]. However, oversizing electrical power protections tends to be expensive.

Besides protective relays and circuit breakers, classical measures to ease fault occurrences in the power system relies on the use of artificial rising resistances and/or inductances, such as air-coil reactors, or high stray impedance of transformers and generators. Topological measures, such as splitting the grid by reducing the number of sources that could feed a fault, constitutes other option but with significant investment costs and loss of interconnectivity. Fuses and pyrotechnic breakers are also considered measures, however, replacement is needed after a fault suppression and current flow is interrupted in the affected path [6].

It is required a more effective way to limit the consequences of fault occurrences and maintain the power system optimised during normal regime operation. Such desired characteristics can be found in FCLs. Ideally, an FCL is a device that does not affect the power system during normal conditions but during a fault imposes very quickly a high resistance and/or inductance that limits surge currents. This device can be installed in almost all locations of the power system.

Due to their electric and magnetic properties, HTS materials may be used in the development of current limiters. Generally, the principle of operation of these devices is based on the superconducting/normal (S/N) transition of HTS materials as well as the magnetic core saturation effect [7]–[9], although wide developed topologies where there is no transition also exist.

The key requirements of an FCL are:

- Insignificant resistance and inductance under normal unfaulted operation regime hence negligible influence on a power system.
- Detection and response to all short-circuit fault occurrences in a short period of time.
- Very high limiting resistance and/or inductance under fault operation regime so current limitation is achieved and fault suppressed.

- Automatic and quick recovery after a fault clearance.
- Reliable successive limitation of faults without damage.
- Negligible harmonics introduction in the power system during normal operation.
- No adverse impact on power system protective devices.

Among all different topologies of FCLs, the resistive and inductive types are the most mature. The resistive limiter is the one that has been most developed [10]–[12]. This topology uses an HTS material in series with the line circuit and uses the transition S/N to limit short-circuit currents. Its design is potentially the most compact, however, the need for current leads results in losses even during normal operation. On the other hand, inductive FCLs require an iron core which makes them relatively heavy but they exempt current leads. Besides, they require less amounts of superconductor and are robust against hot-spot formation [13]. The inductive type limiter is considered in this work.

## 1.2 Research Problem

The discovery of high-temperature superconducting (HTS) materials, in 1986, allowed the emergence of several power applications impacting, for example, power quality, limitation of faulty operation occurrences and weight and volume of equipment.

The FCL of inductive type is foreseen as an enabling technology for electrical grids, including dispersed, embedded or distributed generation. FCLs present themselves as attractive devices to protect such grids due to their inherent ability to limit short-circuit levels.

The interest in inductive type FCLs has increased due to the development of HTS tapes allowing to overcome design limitations found in FCLs based on HTS bulk materials, such as reduced size and mechanical robustness. HTS tapes are currently under intense R&D in order to develop them with excellent electrical and mechanical properties such as large currents facing high magnetic fields, continuous long length fabrication, tensile strain and stress properties as well as joining and contact techniques.

The development of this work aims answering the following research question:

*How can the properties of the constitutive parts of an inductive type FCL be taken into account to model, simulate and design such limiter?*

The research question can be addressed considering the following hypothesis:

*If a modelling methodology based on the constitutive parts of the inductive FCL provides effective simulation results when compared to real experimental results, then it can be used to predict the behaviour of the FCL in electrical grids.*

### 1.3 Objectives

This work pursues the following objectives:

- Study and modelling of the properties of superconducting tapes concerning the inherent electromagnetic-thermal phenomena when operating as current limiter.
- Development of a fast simulation tool for transient prediction of the behaviour of the FCL operating in electrical grids subjected to short-circuit fault occurrences.
- Prototyping of a laboratory-scale FCL and experimental tests in a test electrical grid.
- Development of a graphical user interface (GUI) for data collection of experimental data, such as line current, primary linked flux, superconducting current and temperature in superconductor surface.
- Comparison between simulation and experimental results in order to validate simulation methodologies.

### 1.4 Outline of the Thesis

This thesis is structured into six main chapters, one chapter of references and four appendixes, in which its technical vocabulary is, as far as possible, in accordance with the international electrotechnical terminology, published in the International Standard IEC 60050<sup>1</sup>.

A brief description of the topics covered in each main chapter is as follows:

- 1 – Introduction: Gives a general overview of the features of inductive type FCLs, addresses the background and motivation as well as the objectives to conduct the research.
- 2 – Literature Review: In this chapter, the types of faults and mechanisms to deal with them are summarised, with special focus on inductive type FCLs. Commercial superconducting materials, namely bulks and tapes, are presented and their properties addressed. Joining of superconducting tapes is also discussed. The most common simulation methodologies to predict the behaviour of inductive FCLs in electrical grids are presented and the development status of this type of limiters, in terms of prototypes, are assessed.
- 3 – Design and Modelling of the Inductive FCL: The necessary baseline to conduct this work is discussed in this chapter. The design of the constitutive parts of the developed prototype are presented. Modelling of electromagnetic-thermal dependent properties of the superconducting element, such as critical current density,  $n$ -value, resistivity, thermal conductivity, volumetric

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<sup>1</sup> Available online at <http://www.electropedia.org/>.

heat capacity and convective heat coefficient is carried out. The electromagnetic-thermal behaviour of the limiter (composed of all constitutive parts) is also modelled.

- 4 – Simulation of the Inductive FCL: The implemented simulation methodology, in Simulink, from Matlab, is described in this chapter. The results provided by this methodology, namely, the line current, primary linked flux, hysteresis loop, superconducting current and temperature in the surface of superconductor are presented for different prospective line current scenarios.
- 5 – Experimental Validation of Models: Simulation models are validated with experimental data in this chapter. The experimental details of the test setup (prototype, power equipment and measuring units) are presented and a comparison between simulation and experimental results is made.
- 6 – Conclusions: A general summary of the performed activities and corresponding conclusions, as well as the future work, are presented in this chapter.

## 1.5 Original Contributions

The original contributions of this work are related to design, modelling, simulation, prototyping and experimental testing. The main contributions are:

- Design:
  - Design of a cryostat and a holder for superconducting rings. This design, focusing an easy assembly for experimental tests, allows to house the secondary (which is supported by the holder, made by Celeron) in an open bath of liquid nitrogen provided by the cryostat. The cryostat, made by extruded polystyrene, is inserted around a limb of the magnetic core of the limiter.
  - Design of a holder for soldering and development of superconducting rings. With this holder, made by stainless-steel, both terminals of superconducting tape segments are soldered with a specific curvature, in order to build short-circuited rings that wound the magnetic core of the limiter.
- Modelling:
  - Development of an electromagnetic model, based on empirical knowledge, describing the dynamical behaviour of the induced currents in the superconducting secondary (short-circuited ring wound around the magnetic core) of the limiter as a function of the primary magnetomotive force and time after the beginning of short-circuit fault.

- Simulation:
  - Development of a fast simulation tool for transient prediction of the electromagnetic-thermal behaviour of the limiter operating in electrical grids subjected to fault occurrences. The developed tool, implemented in Simscape Power Systems from Simulink/Matlab, extends a previously developed one that only considered the electromagnetic behaviour of the limiter, by adding a block that predicts the current and temperature in the superconducting secondary of the limiter. With this tool, the fault current limiter is inserted in electrical grids and subjected to fault occurrences where line current, primary linked flux as well as current and temperature in superconducting secondary are predicted. With the developed tool, simulations considering long-term short-circuit faults (e.g., 2 seconds) take less than 5 minutes of computation time.
- Prototyping:
  - Prototyping of a laboratory-scale fault current limiter. The limiter is composed of a closed two-legged magnetic core, a primary winding made by copper wire and a short-circuited superconducting secondary, made by commercial superconducting tape, housed in a cryostat. Conceptually, the prototype is equivalent to a power transformer with a short-circuited secondary. This prototype is introduced in a test electrical grid subjected to short-circuit faults.
- Experimental testing:
  - Development of a user interface for data logging from a data acquisition board (NI-6008) over USB interface and a digital multimeter (Keithley-2001) over IEEE-488 interface. This interface allows to start and stop data logging, of both measuring devices, at the same timestamps.
  - Prototyping of a Rogowski coil for measuring the induced current in superconducting secondary. This coil is adapted to the reduced dimensions of the superconducting tape and cryostat. It is open ended and flexible, allowing it to be wound around the superconducting tape.
  - Validation of a reverse engineering methodology based on the maximum hysteresis loop of the inductive limiter. Previously validated by finite element modelling (FEM) simulations, this methodology is validated in this work by comparing simulation results with experimental measurements performed in the developed prototype.

## 1.6 Publications

The publications performed during the development of this work, [9], [14]–[20], are listed following:

- N. Vilhena, P. Arsenio, J. Murta-Pina, A. Pronto, and A. Alvarez, ‘A Methodology for Modeling and Simulation of Saturated Cores Fault Current Limiters’, *IEEE Transactions on Applied Superconductivity*, vol. 25, no. 3, pp. 1–4, Jun. 2015. DOI: 10.1109/TASC.2014.2374179.
- N. Vilhena, P. Arsénio, J. Murta-Pina, A. G. Pronto, and A. Álvarez, ‘Development of a Simulink Model of a Saturated Cores Superconducting Fault Current Limiter’, vol. 450, L. M. Camarinha-Matos, T. A. Baldissera, G. Di Orio, and F. Marques, Eds. Cham: Springer International Publishing, 2015, pp. 415–422. DOI: 10.1007/978-3-319-16766-4\_44.
- J. Murta-Pina, P. Pereira, J. M. Ceballos, A. Alvarez, N. Amaro, A. Pronto, J. Silva, and P. Arsenio, ‘Validation and Application of Sand Pile Modeling of Multiseeded HTS Bulk Superconductors’, *IEEE Transactions on Applied Superconductivity*, vol. 25, no. 3, pp. 1–5, Jun. 2015. DOI: 10.1109/TASC.2014.2366073.
- R. Ferreira, J. M. Pina, N. Vilhena, P. Arsénio, A. G. Pronto, and J. Martins, ‘Analysis of the Effects of Asymmetric Faults in Three-Phase Superconducting Inductive Fault Current Limiters’, *Journal of Physics: Conference Series*, vol. 507, no. 3, p. 32036, May 2014. DOI: 10.1088/1742-6596/507/3/032036.
- P. Arsénio, N. Vilhena, J. Murta-Pina, A. Pronto, and A. Álvarez, ‘Design Aspects and Test of an Inductive Fault Current Limiter’, *Electrical, Control and Communication Engineering*, vol. 5, no. 1, pp. 40–45, Jan. 2014. DOI: 10.2478/ecce-2014-0006.
- P. Arsénio, N. Vilhena, J. M. Pina, A. Pronto, and A. Álvarez, ‘Design Aspects and Test of a Magnetic Shielding Inductive Fault Current Limiter’, in *14th International Symposium ‘Topical Problems in the Field of Electrical and Power Engineering’ and ‘Doctoral School of Energy and Geotechnology II’*, 2014.
- P. Arsenio, T. Silva, N. Vilhena, J. M. Pina, and A. Pronto, ‘Analysis of Characteristic Hysteresis Loops of Magnetic Shielding Inductive Fault Current Limiters’, *IEEE Transactions on Applied Superconductivity*, vol. 23, no. 3, pp. 5601004–5601004, Jun. 2013. DOI: 10.1109/TASC.2012.2235896.
- J. M. Pina, P. Pereira, A. Pronto, P. Arsénio, and T. Silva, ‘Modelling and Simulation of Inductive Fault Current Limiters’, *Physics Procedia*, vol. 36, pp. 1248–1253, Jan. 2012. DOI: 10.1016/j.phpro.2012.06.284.





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## *Literature Review*

This section introduces a comprehensive analysis of the classic and emerging fault current limiting technologies for electrical grid protection. The several types of faults and measures to mitigate those events are discussed. Following, superconducting materials for applications on current limitation, i.e. bulks and tapes, are presented. The thermal properties of superconducting tapes are presented and joining techniques of those tapes are characterised. Also in this chapter, simulation methodologies of inductive type FCL are discussed. Lastly, the development status of such FCLs are presented.

### **2.1 Faults and Protection of Electrical Grids**

An electrical grid is an extremely complex system composed of several equipment and lines separating producers and consumers. As any complex system, it is subjected to fault occurrences leading to possible abnormal regimes of operation. Due to such occurrences, fault limiting technologies are employed in order to provide higher robustness against faults thus avoiding or mitigating damaging consequences.

#### **2.1.1 Types of Faults**

Due to several reasons, electrical failures can occur in the power system equipment which leads to an abnormal regime of operation causing short-circuit currents or interruption of current flow. In a 3-phase electrical grid, faults can occur between phases, between phases and earth, or both. According to [21], a single phase-to-ground fault is the most common fault in power systems, making up about 70% to 80% of fault occurrences. In another reference, single phase-to-ground is pointed to be more than 90% [22].

Fault occurrences in power systems are practically inevitable. The main causes of faults are due to failure of joints on cables, failure of circuit breakers or weather factors, such as lightning strikes, accumulation of snow or ice, heavy rain, strong winds, floods and fires, falling trees or animals [23]. The current generated under these faults can exceed 100 times the rated current of the grid [24].

Power system faults are the result of abnormalities, which involves failure in the power system equipment with respect to the parameters of the system, such as voltage, current, power or frequency. Faults can be shunt, series or combination of faults. Figure 2.1 illustrates the possible faults of a power system. A shunt fault is characterised by the flowing of current between the earth and one or more phases or between phases at the frequency of the power system. A series fault consists of unequal impedance

among phases, commonly caused by the interruption of, at least, one phase. A combination fault is the occurrence of a shunt and a series fault simultaneously [8], [23].

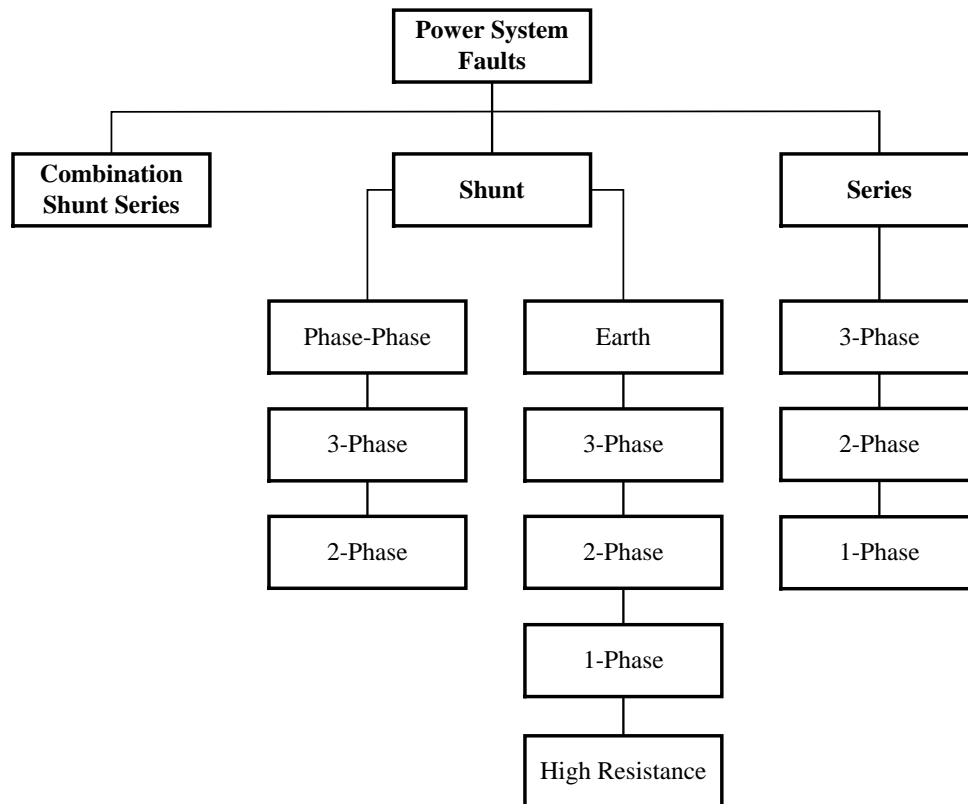


Figure 2.1 – Power system faults. Adapted from IEC Electropedia 448-13-02.

### 2.1.2 Fault Current Protection

Short-circuit currents can be eased by recurring to the well-known topological measures based on splitting the grid into sub-grids, splitting of busbars or even building new substations. These measures solve almost all fault issues and ensure future growth, however, can be costly and time-consuming for utilities. Other possibilities to protect power systems against fault currents are based on devices, such as current limiting fuses, pyrotechnic breakers, air-core reactors and also power electronic based devices.

Fuses began to be used many decades ago and are able to limit the current and isolate the faulted section. However, this kind of devices have non-negligible thermal losses in normal operation and after a fault lead to an interruption in the respective network branch and need to be replaced.

Another possibility is the use of pyrotechnic breakers, commercially known as  $I_s$ -Limiters or current limiting protectors (CLiP). A pyrotechnic breaker contains a fuse in parallel to a busbar, which contains a pyrotechnic cartridge. For this reason, the normal losses are lower than using a simple fuse. In the case of failure, the pyrotechnic cartridge is fired by an electronic system destroying the busbar of the

pyrotechnic breaker and thus cutting off the network branch since the fuse is also destroyed due to overcurrent flow. Therefore, this device also needs to be replaced by a new one after a fault occurrence.

The air-core reactor constitutes another alternative. This device is self-activating and limits the current due to the voltage drop across its terminals. The impedance of the air-core reactor is linearly variable as a function of current but presents considerable impedance in normal operation.

Power electronic circuit breakers are also used for current limiting purposes. Thyristor controlled series compensators, as well as self-commutated solid state devices, like gate turn-off thyristors (GTO) and insulated-gate bipolar transistors (IGBT), are examples of power electronic based devices [6], [25].

Comparing FCLs to the traditional devices, besides the capability to limit higher currents, the normal losses during normal regime are lower and fast activation and recovery time can be achieved with FCLs. Disadvantages are related to the need for medium to large-sized devices and associated costs of development and maintenance. As depicted in Figure 2.2, there are several locations in the electrical grid where FCLs can be introduced. The main benefits of integrating FCL in the grid are [26]:

- Generator connection (1): An FCL in the generator connection reduces the short-circuits arising from the generator, lowering the short-circuit levels in the connected network.
- Power station auxiliaries (2): Generally, short-circuit levels of power station auxiliaries are high, which can be reduced by FCLs.
- Network coupling (3): Security of supply and reduction of disturbances between networks can be ensured by FCLs.
- Busbar coupling (4 and 5): By employing an FCL between busbar, higher interconnection is achieved without necessarily increasing the short-circuit levels. The same benefits as network coupling are expected.
- Shunting current limiting reactors (6): In normal operation, the FCL shunting current limiting reactor, provides a lower resistive path, improving losses.
- Transformer feeder (7 and 8): An FCL can be introduced to protect the transformer and subsequent devices or only subsequent devices. This can be performed in order to avoid upgrading of devices.
- Busbar connection (9): When feeding critical loads, the FCL can be introduced to protect such load against short-circuits and avoid changes in the network.
- Combination with other superconducting devices (10): When operating other superconducting devices in which current limitation is not the main purpose, such as superconducting cables or superconducting magnetic energy storage (SMES), an FCL can be used in order to avoid quench of these devices during short-circuits.

- Coupling local generation sources (11): When introducing new distributed generation units in the grid, their contribution to short-circuit levels can be reduced by using FCLs.
- Closing ring circuits (12): Using an FCL in ring circuits, lower losses and protection against short-circuit currents are guaranteed.

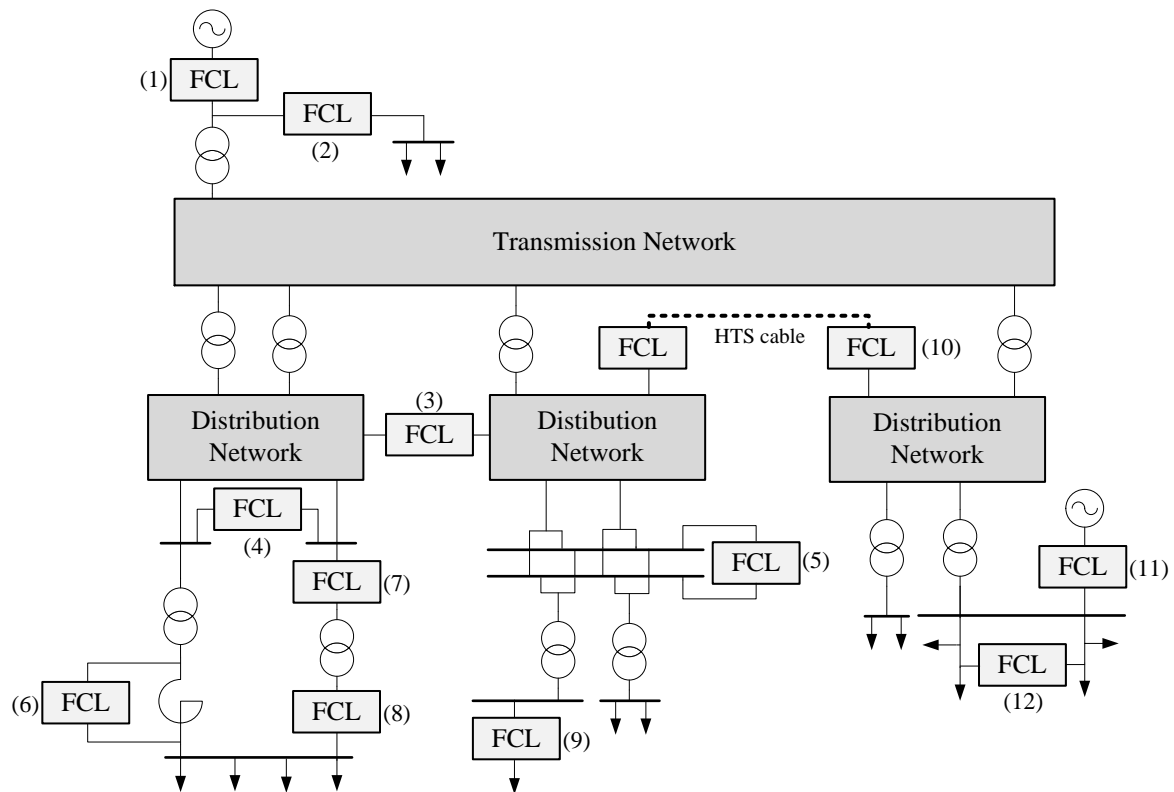


Figure 2.2 – Possible locations of FCLs in the electrical power grids. Adapted from [26].

The behaviour of the line current as a function of the different regimes of operation with and without an FCL is illustrated in Figure 2.3. A summary and comparison of the traditional current limiting approaches and FCLs in terms of losses during normal operation regime, recovery time after a fault, size and cost is shown in Table 2.1.

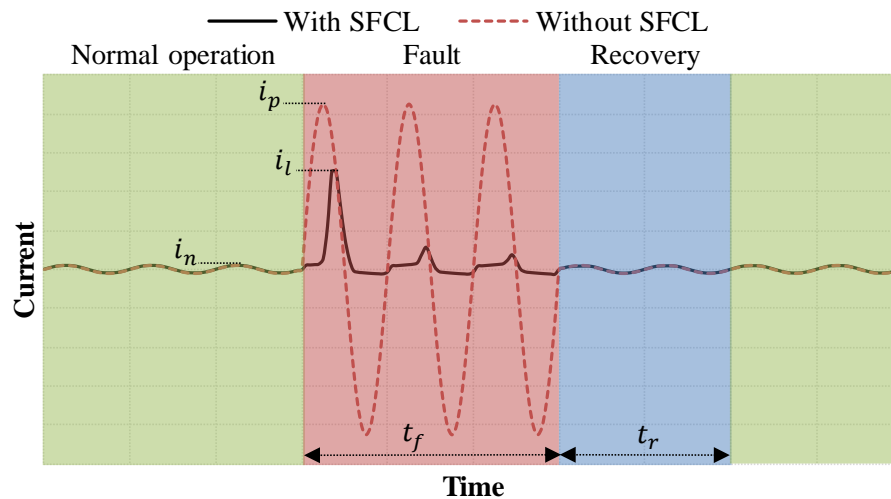


Figure 2.3 – Line current behaviour subjected to different regimes of operation with and without an FCL.

Table 2.1 – Comparison of traditional current limiting approaches with FCLs.

<i>Technology</i>	<i>Normal Losses</i>	<i>Recovery Time</i>	<i>Size</i>	<i>Cost</i>
Fuse	Low	No recovery	Small	Low but needs replacement
Pyrotechnic breaker	Low	No recovery	Small	High and needs replacement
Air-core reactor	High	Moderately fast	Large	Moderate
Power electronic breaker	Low to moderate	Fast	Small	Moderate
Circuit breaker	Low	After reclosing	Small	Moderate
Superconducting FCL of inductive type	Very low	Fast	Medium to large	High
Superconducting FCL of resistive type	Very low	Moderately fast	Medium	High

Considering fault current protection of electrical distribution grids, several criteria must be taken into account such as:

- Admissible short-circuit current.
- Recovery time after a fault.
- Time response to successive faults.
- Withstand time of the limiter during a long-term fault.
- Normal-regime voltage drop across FCL terminals.

In a 3-phase electrical circuit, faults can be symmetrical or asymmetrical, as depicted in Figure 2.4 and Figure 2.5, respectively. In symmetrical faults, which are 3-phase ground faults and 3-phase short-circuit faults, all the phases are affected. Asymmetrical faults include 2-phase ground faults, 2-phase short-circuit fault and single-phase ground fault.

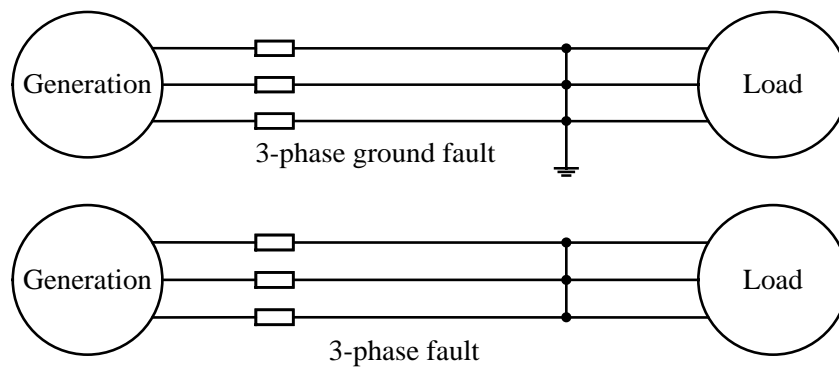


Figure 2.4 –Types of symmetrical short-circuit faults in 3-phase systems.

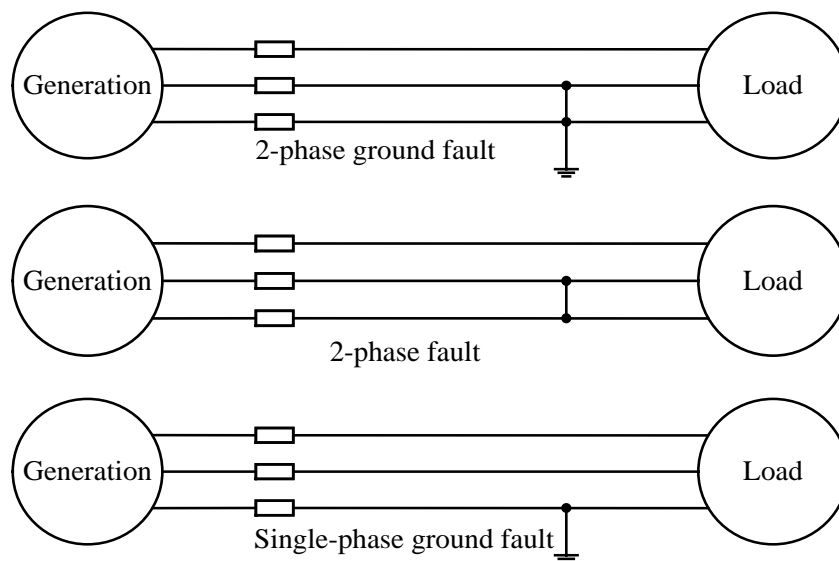


Figure 2.5 –Types of asymmetrical short-circuit faults in 3-phase systems.

The occurrence of short-circuit currents create thermal effects on conductors and equipment as well as mechanical effects, particularly excessive electromagnetic forces and mechanical stresses in line conductors, busbars and transformer windings, for instance [23].

## 2.2 Superconducting Materials for Applications on Current Limitation

The phenomenon of superconductivity was discovered in 1911 by Heike Kamerlingh Onnes when researching the electrical properties of mercury. Onnes had found that when mercury was cooled until 4.2 K, loses abruptly its electrical resistance to less than  $10^{-6} \Omega$ , as depicted in Figure 2.6. This state of matter was called by the discoverer as “(...) *the state of superconductivity*” [27]. Since then, several metals, alloys and compounds with superconducting properties have been discovered.

Superconducting materials have a set of particular electromagnetic properties. Under a certain critical temperature, their resistivity is negligible and the magnetic flux density is expelled from the material. This perfect diamagnetism is called Meissner effect, i.e. the exclusion of magnetic field from the core of the superconducting material.

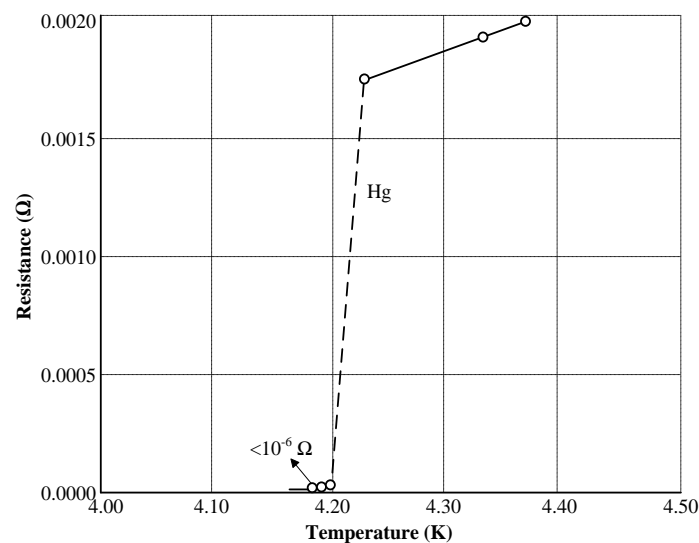


Figure 2.6 – Electrical resistance of mercury as a function of temperature, measured by Onnes. Adapted from the original measurement of H. K. Onnes.

In the early years after the discovery of the superconducting phenomenon, the range of temperatures of the discovered superconducting materials was confined to values around the temperature of the liquid helium [28]. However, the scenario changed dramatically since the discovery of the high-temperature superconductivity in barium-lanthanum-copper-oxide (BLCO) by the year of 1986 [29]. Other materials with such characteristics have been developed, mostly based on copper-oxide materials, such as bismuth (BSCCO), yttrium (YBCO), thallium (TBCCO) or mercury (HBCCO) based compounds.

The development of superconductors operating at high temperatures constitutes an intense field of investigation [30]. For power applications, only HTS materials can be employed since only these are economically viable due to reduced cooling costs [31], [32].

Superconducting materials for applications in current limiters are commercially available under the form of bulks and tapes. Bulks, mostly made of YBCO, are obtained by a process known as top-seeded melt growth (TSMG) which consists in a method to fabricate single or multiple grain superconductors. The seeds, which act as nucleation centres, are placed on the top surface of YBCO compacted pellets and subjected to heat-treatment processes followed by melt texture growth heating cycles in order to meet the bulks. Unfortunately, the TSMG process is confined to small scale and simple material geometries [33]–[35].

In the case of tapes, most adequate for FCLs due to long length tape availability and mechanical robustness, the most common compounds are BSCCO, i.e. first generation (1G) tape, and YBCO, i.e. second generation (2G) tape. The latter are also known as coated conductors and are best suited for working on higher magnetic fields than 1G tapes. Therefore, coated conductors are best suited for inductive FCLs [36].

### 2.2.1 Bulks

Bulk materials have a wide set of applications, such as motors, generators, magnetic levitation (MagLev), and magnetic resonance imaging (MRI), due to the high magnetic fields that can be trapped. Examples of commercial bulks are shown in Figure 2.7. Despite the wide range of applications, bulks are susceptible to cracking due to irregular thermal expansion of their body and, therefore, long-term operation is compromised [37].



Figure 2.7 – Superconducting bulks for experimental tests. (a) Magnetic levitation block. (b). Magnetic shielding cylinder.

### 2.2.2 Tapes

When compared to 1G tapes, 2G tapes take advantage of their improved properties, such as mechanical robustness, operation at higher magnetic field and critical current. For fault current limiting purposes, 2G conductors are also expected to recover after a high current flow more easily than 1G conductors [38]. These 2G coated conductors, as illustrated in Figure 2.8, are manufactured by a continuous process using thin film deposition techniques in order to apply the superconducting material on buffered metal substrates. The manufacturing steps include electroplating, sputtering, electro-polishing, ion beam assisted deposition (IBAD) and metal organic chemical vapour deposition (MOCVD).

The IBAD process consists of a sputtering of a stack of buffer layers that develops a texture for the superconductor material deposition. The MOCVD is the deposition of the superconductor, based on (RE)BCO materials. Further details concerning the manufacturing process can be found in [36], [39], [40].

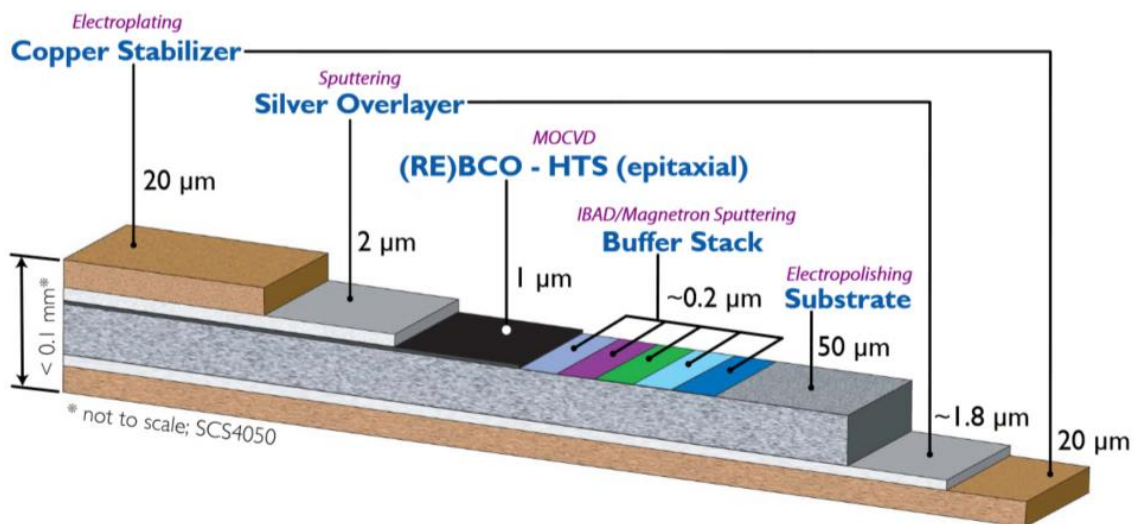


Figure 2.8 – Configuration of SuperPower SCS4050 HTS coated conductor. From [41].

### 2.3 Thermal Properties of Superconducting Tapes

Thermodynamics is a very important subject in superconducting power applications since the effects of thermal energy play a significant role in the performance of these devices. Thermal stability is a very important factor for reliable operation of HTS materials. For this reason, generally, superconducting tapes have a set of layers with the purpose of mechanical and thermal reinforcement. In this section, the most important thermal properties of superconducting tapes for the design and modelling of the inductive limiter are presented.

### 2.3.1 Heat Transfer Mechanisms

Heat transfer can be achieved by three types of thermal exchange: conduction, convection and radiation [32]. With these mechanisms, changes in temperature may or not occur. Generally, temperature changes due to the transfer of energy. However, in the case of latent heat, energy is transferred without any change in temperature due to a phase transition. In conduction, the heat is exchanged without any transport of matter between two materials in contact. There is a temperature gradient and the heat flux is oriented according to this gradient. By means of convection, the heat is exchanged among a surface that separates a solid body from a fluid, or a mixture of two fluids. For the specific case of this work, the heat flow is between the surface of the superconducting tape and liquid nitrogen (LN<sub>2</sub>). Four type of thermal exchange can occur in this case: convective boiling, nucleation boiling, transition boiling and film boiling [42]. Lastly, through electromagnetic radiation, a heated body can emit energy via electromagnetic waves.

### 2.3.2 Absorption of Heat by Solids and Liquids

Two of the most important thermal properties are thermal conductivity and heat capacity. The former is a quantity representing how efficiently a solid conductor transports heat, and the latter is a parameter representing the available internal energy of the material. Also important, since the superconductor is immersed in a cryostat, the convective heat transfer coefficient is a parameter representing how efficiently the generated heat in the superconducting tape is absorbed by liquid nitrogen.

#### 2.3.2.1 Thermal Conductivity

The thermal conductivity is the ability of a medium with a temperature field to transmit heat through a surface element. It can also be interpreted as the efficiency of a solid conducting heat. The thermal conductivity, generally represented by  $k$ , can be explained according to the Fourier's law of conduction given by (2.1),

$$\dot{Q}_{Cond} = k \cdot A \cdot \nabla T \quad (2.1)$$

where  $\dot{Q}_{Cond}$  is the rate of conduction heat flow and  $\nabla T$  is the thermal gradient imposed across a sectional area  $A$ .

In the particular case of superconducting coated conductors, the thermal conductivity is strongly temperature dependent and distinct behaviours can be exhibited from the different layers of the conductor [43], [44].

### 2.3.2.2 Heat Capacity

The heat capacity,  $C$ , corresponds to the quantity of heat needed to increase the temperature of a medium by one degree. It corresponds to the ratio between the amount of heat  $Q$  that the material absorbs or loses and the corresponding temperature variation  $\Delta T$ . This relationship is expressed in (2.2),

$$Q = C \cdot \Delta T \quad (2.2)$$

The heat capacity per unit mass is known as specific heat capacity, given by (2.3),

$$c = \frac{C}{m} \quad (2.3)$$

where  $m$  is the mass of the material.

### 2.3.2.3 Convective Heat Transfer Coefficient

In the case of thermal exchange between a solid and a fluid surrounding it, the rate of heat flow is given by (2.4),

$$\dot{Q}_{Conv} = h_{Conv} \cdot A_{Conv} \cdot \Delta T \quad (2.4)$$

where  $h_{Conv}$  is the convective heat transfer coefficient,  $A_{Conv}$  is the surface area of the solid in contact to the fluid and  $\Delta T$  is the temperature difference between the surface and the liquid. The convective heat transfer coefficient is an important factor for thermal stability of the superconducting element.

## 2.4 Joining of Superconducting Tapes

Although the continuous length of commercial superconducting tapes has reached hundreds of meters, the average current density and its homogeneity tends to decrease as the length increases. Therefore, it is useful to join tapes in order to maintain high current densities as well as homogeneity in long lengths [40], [41], [45], [46]. Joining superconducting tapes constitutes a critical issue concerning the development of HTS applications. Power devices employing tapes, such as SMES systems or FCLs, are likely to require joined segments of conductors, i.e. windings and short-circuited rings. This constitutes a challenge with respect to closed-loop and joining techniques [47].

The need for long length coated conductors has been motivating manufacturers to scale up their manufacturing processes in order to accomplish such need. Although the recent advances, joining coated conductors is still essentially to e.g. repair a quenched section of conductor, short-circuiting a winding or building a current lead [48].

Resistance-free lap and bridge joint alignments can be performed by joining the superconducting layers which is done through removing overlayers followed by micro-joining and oxygenation annealing processes. The micro-joining process is carried out by applying heat and pressure under vacuum inside

a joining chamber followed by an oxygenation-annealing process which helps recovering the superconducting properties degraded during the previous procedure [49].

There are two main types of joints. In the first type, brazing and soldering, a low melt temperature filler metal is used to establish a path between two surfaces. In the second type, welding, the surfaces are joined by melting and/or pressing together without any filler metal. The latter technique enables lower contact resistance, which can constitute an important advantage, however, tends to be more difficult to manufacture [46], [50]. Perfect joints are fundamental for superconducting applications. In contrast to brazing or soldering techniques, a diffusion joint allows performing superconducting joints, which does not use any filler metal. Joining superconducting tapes by diffusion is expected to reduce the resistance across the joint.

For each process of joining techniques, lap and bridge joint designs can be performed. For the case of the lap joint, such design is performed by lapping two tapes, such as Figure 2.9 (a) suggests. On the other hand, for the bridge joint design, it is used a third tape as a bridge on top of two tape parts, as presented in Figure 2.9 (b). The arrangement of test specimens into joining holder can be:

- Linear type: The Coated Conductor is short-circuited in order to perform a segment, so current leads are available.
- Ring type: The Coated Conductor is short-circuited in order to perform a ring, so no current leads are available.

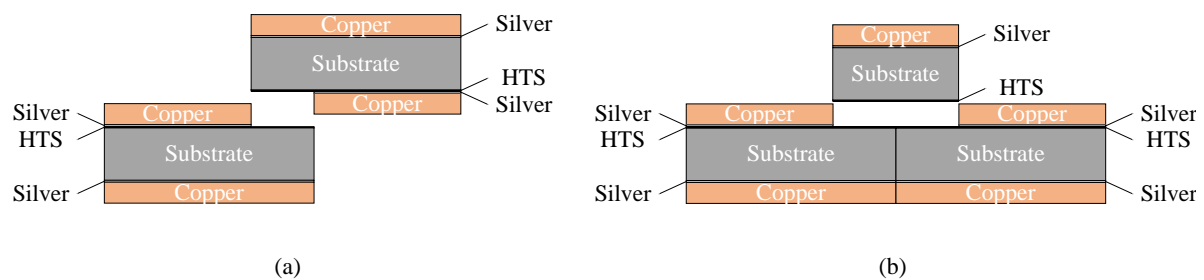


Figure 2.9 –Types of joints. (a) Lap joint. (b) Bridge joint.

The furnace should have adequate size to accommodate the joining holders. The test specimens should be processed under uniaxial pressure provided by screws or springs on the holders in order to facilitate soldering, as depicted in Figure 2.10. To reduce contact resistance, overlayers can be removed, e.g. by chemical etching, prior to the application of the joining technique.

In the case of diffusion techniques at high temperatures, an oxygenation-annealing recovery process under high-pressure oxygen atmosphere is required. In this process, the oxygen partial pressure and

temperature are fundamental parameters for ensuring thermodynamic stability of the superconducting tape [51], [52].

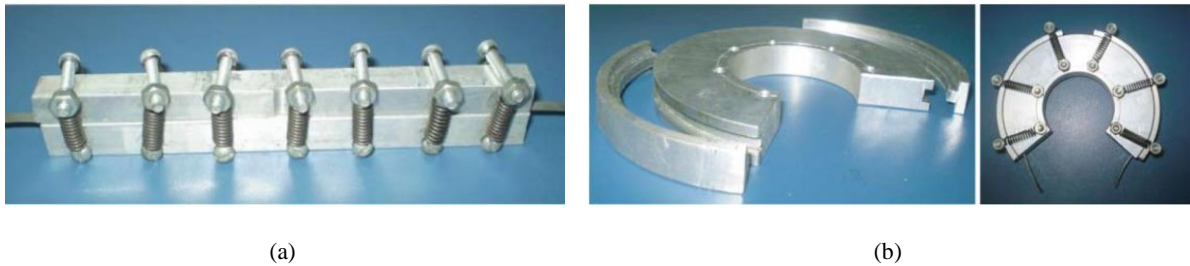


Figure 2.10 – Examples of joining holders. (a) Linear type. (b) Ring type. From [53].

Another alternative for making closed-loop windings can be performed by cutting the coated conductor along the length of its middle width and leaving both ends uncut in order to ensure the loop. This technique was originally proposed in [54] and used a diamond wheel to slit the coated conductor. One centimetre sections of both ends of the coated conductor sample have not been cut in order to form the closed-loop. The “wind-and-flip” method, allowing manufacturing a superconducting winding without the need for joints, was suggested. This method was claimed in the patent [55]. Application possibilities with this kind of closed-loop windings have been examined, such as transformers and FCLs in [56], [57]. As a drawback, this method is not suited for large-scale devices due to problems of upscaling the technique.

## 2.5 Simulation of Inductive FCLs

Fault current limiters have been tested with success and are foreseen as an enabling technology for electrical power applications, such as microgrids or networks with distributed generation [58], [59]. The two main types of FCLs, i.e. resistive and inductive, have a distinct set of features and principle of operation, as explained following.

Resistive type limiters are inserted in series with the line under protection. In a normal regime operation, the line current is lower than the critical current of the superconducting element so there is no current limitation. However, for fault situations when the line current increases for higher values than the critical current, the superconducting element quenches rapidly thus leading to current limitation due to a high resistive state of the superconducting element. Generally, the current starts to be limited before the first peak of the short-circuit is reached. The recovery of the device following a fault clearance tends to be slower when compared to inductive type FCLs [60]. It is common the placement of a shunt conductor with the superconducting element, as illustrated in Figure 2.11, in order to prevent damage of the superconductor in case of quench.

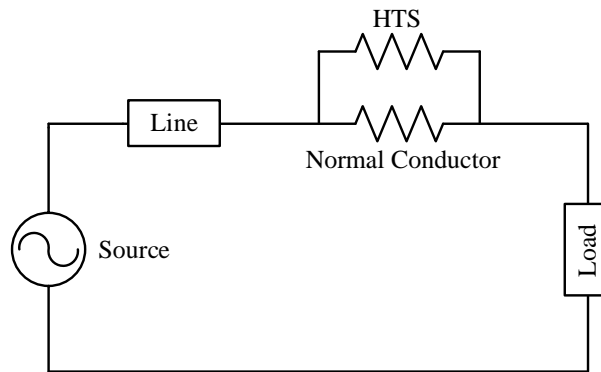


Figure 2.11 – Single-phase equivalent circuit with a resistive type FCL. The HTS is shunted with another conductor in order to prevent irreversible damage during quench.

Inductive type FCLs are conceptually equivalent to a transformer with short-circuited secondary<sup>2</sup>, as illustrated in Figure 2.12 [61]. The magnetic core can be open or closed and is wound by a primary coil connected in series to the line under protection, as illustrated in Figure 2.13. The short-circuited secondary is built from a superconducting material.

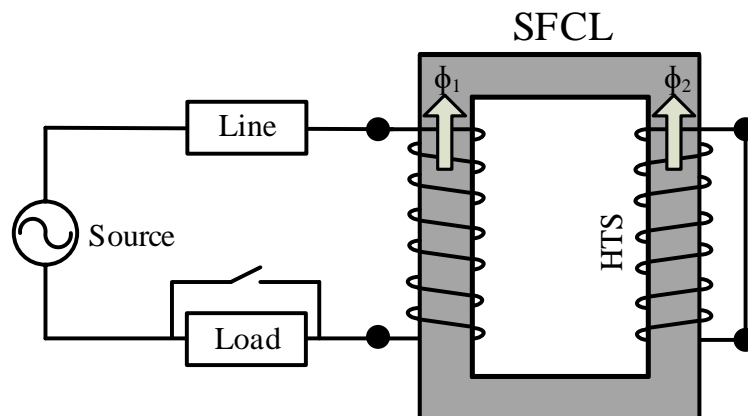


Figure 2.12 – Conceptual diagram of an inductive type FCL with a closed magnetic core.

<sup>2</sup> Saturated core FCL can also be considered as inductive type. In the saturated core limiter, the current is also limited by the insertion of an inductance in the line but the principle of operation is different. There is a primary winding inserted in series with the line under protection and a secondary DC biasing coil built from a superconducting material that permanently magnetises an iron core. For a more deeply understanding of its principle of operation and modelling strategies, see [9], [14]. Despite its importance and related aspects, this type of limiter is not considered for the purposes of this work.

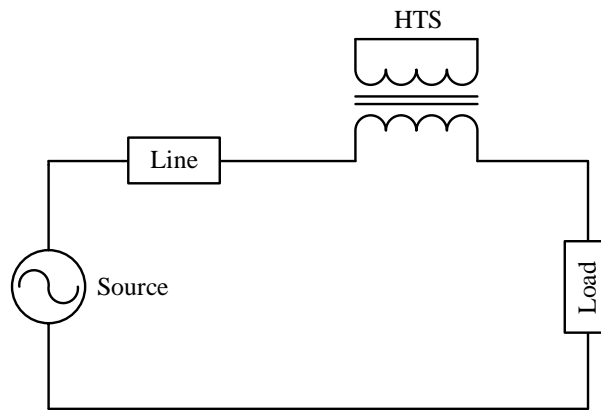


Figure 2.13 – Single-phase equivalent circuit with an inductive type FCL.

During normal operation regime, the developed magnetomotive force in the primary is cancelled through the opposite magnetomotive force developed by the short-circuited secondary, ensuring negligible voltage drop at the terminals of the primary, since no magnetic flux flows in the magnetic core, as shown in Figure 2.14 (a). When a fault occurs, the line current increases abruptly which induces high currents in the secondary, thus quenching the HTS material. Therefore, the inductance of the primary increases due to the penetration of magnetic flux in the core, as shown in Figure 2.14 (b). For these reasons, the limiter is passively triggered. When the fault is suppressed, the limiter recovers its original state in few seconds [1], [62].

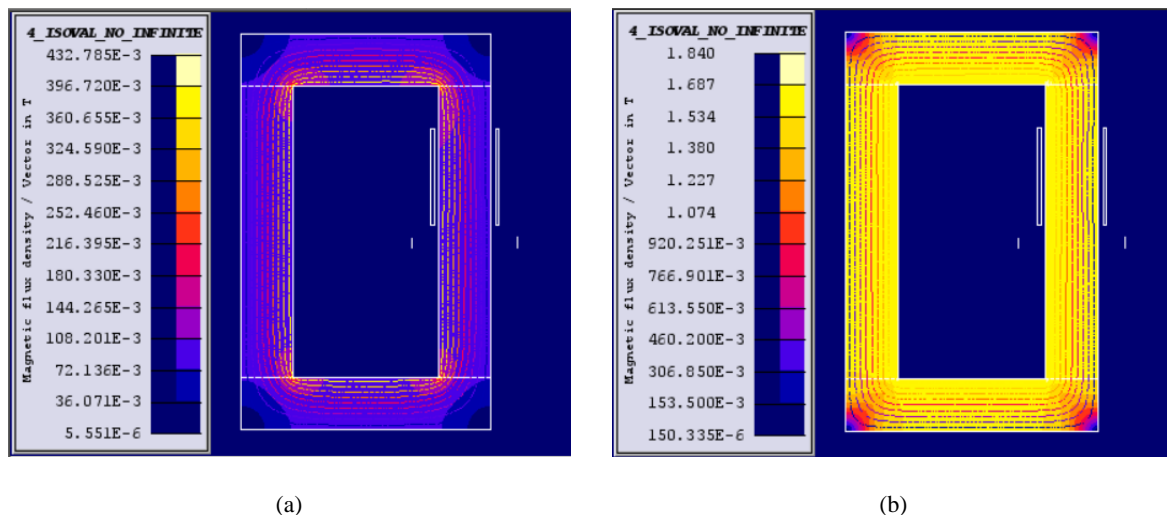


Figure 2.14 – Magnetic flux density map of the limiter simulated in Cedrat Flux2D. (a) Normal operation. (b) Fault operation.

Ideally, inductive type FCLs ensure negligible voltage drop at their terminals during normal operation regime and effective current limitation in fault operation regimes. The fast and autonomous time response to fault events and their capability to recover after fault clearances make FCLs attractive

devices to protect electrical power grids [63]–[65]. Generally, the primary of an inductive FCL is made of classic materials, such as copper or aluminium, and the secondary is built from a superconducting material. For these reasons, only the secondary needs to be cooled in a cryostat.

Simulations based on numerical methods are important tools for predicting the dynamical behaviour of power devices employing superconducting elements. Computational simulations of FCLs are necessary to understand their behaviour in electrical grids. Different methodologies have been proposed over time, such as lumped-parameters equivalent circuits, time-dependent resistances and inductances, FEM, electromagnetic-thermal coupling and reverse engineering methodologies. Following, these methodologies are presented and discussed.

## 2.5.1 Lumped-Parameters Circuit Modelling

Predicting the behaviour of FCLs in electrical grids can be performed by lumped-parameters equivalent circuits. The prediction of these equivalent circuits, generally simplified representations, is carried out by solving the equations of such circuits.

### 2.5.1.1 Steinmetz Equivalent Circuit Model

In this model, the estimation of the impedance of the FCL is based on the analytical calculations for the Steinmetz equivalent circuit of a conventional transformer but with the secondary short-circuited. The elements of the equivalent circuit, as presented in Figure 2.15<sup>3</sup>, are computed from the dimensions and properties of the magnetic core and windings [31], [66]–[68].

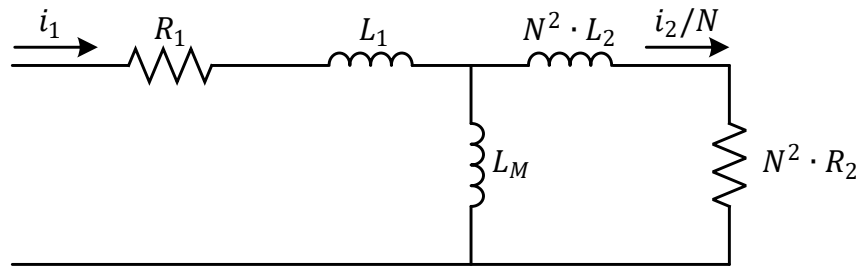


Figure 2.15 – Steinmetz equivalent circuit referred to primary.

The equations describing the Steinmetz equivalent circuit are given by (2.5),

$$\begin{cases} u_1 = R_1 \cdot i_1 + L_1 \cdot \frac{di_1}{dt} + L_M \cdot \frac{di_2}{dt} \\ 0 = R_2 \cdot i_2 + L_2 \cdot \frac{di_2}{dt} + L_M \cdot \frac{di_1}{dt} \end{cases} \quad (2.5)$$

<sup>3</sup>  $N$  is the transform ratio between the number of turns of primary,  $N_1$ , and secondary,  $N_2$ , i.e.  $N = N_1/N_2$ .

where  $u_1$ ,  $i_1$  and  $i_2$  are the voltage drop at the primary, current in the primary and current in the secondary, respectively.  $R_1$  and  $R_2$  are the resistances of primary and secondary, respectively.  $L_1$ ,  $L_2$  and  $L_M$  are the inductances of primary, secondary and mutual inductance, respectively.

### **2.5.1.2 Time-variable Resistances and Inductances**

The limiter can be represented as a time-variable resistance and/or inductance. Generally, these models are simple, not considering some dynamical characteristics of the device, such as non-linearity of the core or hysteresis. Examples can be found in [69]–[71]. In reference [72], the resistance and inductance of the FCL operating in the simulation grid is determined by using measured values of the current through the limiter in a hardware-in-the-loop configuration. Although resistance and/or inductance of FCLs varies with time, it is due to electromagnetic and thermal dependencies, e.g. current, flux density and temperature, not on time [20].

### **2.5.2 Finite Element Method**

The simulation of FCLs is often performed by computationally-intensive FEM software. Besides other options, these tools generally offer the possibility to study electromagnetic transient problems as well as thermal analyses. Several computational environments are available. The most common simulation packages for superconducting devices are: Ansys [73]–[75], Cedrat Flux2D [76]–[78], Comsol Multiphysics [79]–[81] and Femlab [82]–[84]. For accurate simulation results, both electromagnetic and thermal phenomena must be taken into account. However, when simulating transient electromagnetic and thermal interdependency, limitations have been found on commercial FEM software [85], [86]. Generally, coupled simulations are needed [87]–[89]. Besides that, simulations can be very time-consuming, even for small scale devices in simple grids. Thus, simulation of real size devices, in realistic complex grids, tends to be compromised.

### **2.5.3 Electromagnetic-Thermal Coupling**

The inclusion of heat exchange in simulation models make simulation methodologies more complex but also more accurate, since electromagnetic and thermal equations are coupled to each other.

In the reference [90], a full electromagnetic-thermal model is developed and an equivalent circuit is implemented in an electromagnetic transient program (EMTP). The full model is based on an integral formulation of the coupled electromagnetic-thermal problem at the interior of the constitutive parts of the device. The results of the complete electromagnetic-thermal model and equivalent circuit are compared and good convergence was achieved. Other examples can be found in [91]–[93].

The strong and nonlinear coupling between thermal and electrical phenomena in FCLs employing superconducting tapes is handled with relative ease by means of a thermal-electrical analogy, published in [88]. This method allows solving the heat exchange equations inside the layers of the superconducting

tape by converting the thermal properties into electrical equivalents. Further details regarding the formulation of the analogy can be found in [94], [95]. The thermal-electrical analogous elements are listed in Table 2.2.

Table 2.2 – Analogous elements of thermal and electrical properties.

<i>Thermal property</i>	<i>Electrical property</i>
Temperature (K)	Voltage (V)
Power (W)	Current (A)
Conductivity ( $\text{W}\cdot\text{m}^{-1}\cdot\text{K}^{-1}$ )	Resistance ( $\Omega$ )
Volumetric heat capacity ( $\text{J}\cdot\text{m}^{-3}\cdot\text{K}^{-1}$ )	Capacitance (F)

A one-dimensional transient heat conduction problem in a layered composite medium can be represented, for each layer, as a T-section composed of an RC electrical circuit with a current source. Once the layers are arranged in parallel, the analogy consists of T-sections, as depicted in Figure 2.16, connected in parallel. In the boundary surfaces, there is heat exchange by convection, whereby resistances simulating the convection, given by (2.6), should be inserted in parallel to the circuit,

$$R_{Conv} = \frac{1}{h_{Conv} \cdot A_{Conv}} \quad (2.6)$$

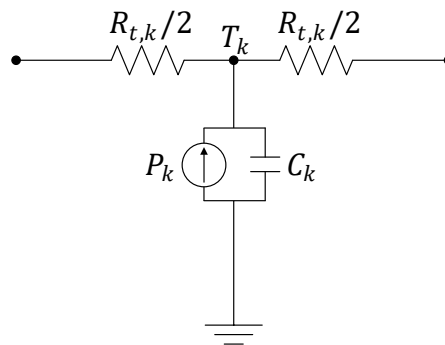


Figure 2.16 – Thermal-electrical equivalent circuit of a layer.

Relevant variables in the figure are:

- $R_{t,k}$ : thermal resistance of layer  $k$ .
- $P_k$ : current source representing heat of layer  $k$ .
- $C_k$ : capacitance representing the volumetric heat capacity of layer  $k$ .
- $T_k$ : temperature of layer  $k$ .

Temperatures are determined by the voltage drop between each corresponding point and the ground. Previous variables are governed by (2.7) to (2.9),

$$R_{t,k} = \frac{l_k}{k_k \cdot A_k} \quad (2.7)$$

$$P_k = \frac{\rho_k \cdot l_k}{A_k} \cdot i_k^2 \quad (2.8)$$

$$C_k = d_k \cdot c_k \cdot l_k \cdot A_k \quad (2.9)$$

where previous parameters correspond to:

- $l_k, k_k, A_k$ : length, thermal conductivity and surface area of heat exchange by conduction of layer  $k$ .
- $\rho_k, i_k$ : electrical resistivity and current of layer  $k$ .
- $d_k, c_k$ : mass density and specific heat capacity of layer  $k$ .

Index  $k$  can represent inner copper, outer copper, inner silver, outer silver, Hastelloy or YBCO layers.

#### 2.5.4 Characteristic Hysteresis Loops Methodology

A modelling methodology for the determination of the dynamical behaviour of inductive type limiters is presented in [96]. This methodology envisages predicting the performance of inductive limiters, aiming a reduction in computing time when compared to FEM simulations, while maintaining the reliability of the predicted dynamical performance of the FCL in complex grids.

According to the methodology, the iron core determines the behaviour of the limiter. The characteristic of the core, defined as the relation between the current in the primary,  $i_L$ , and its linked flux,  $\psi_0$ , without secondary (built from HTS material), is modelled analytically. The maximum induced current in the HTS due to the primary, without iron core, may be measured in real experiments by a Rogowski coil [97]. Thus, based on the parameters from the constitutive parts of the limiter, namely the maximum induced current of the HTS secondary and the characteristic of the device, a maximum hysteresis loop can be built, as illustrated in Figure 2.17. Current limitation is achieved in the vertical branches of the loop. In saturation this is nearly horizontal, and current is only limited by grid impedance.

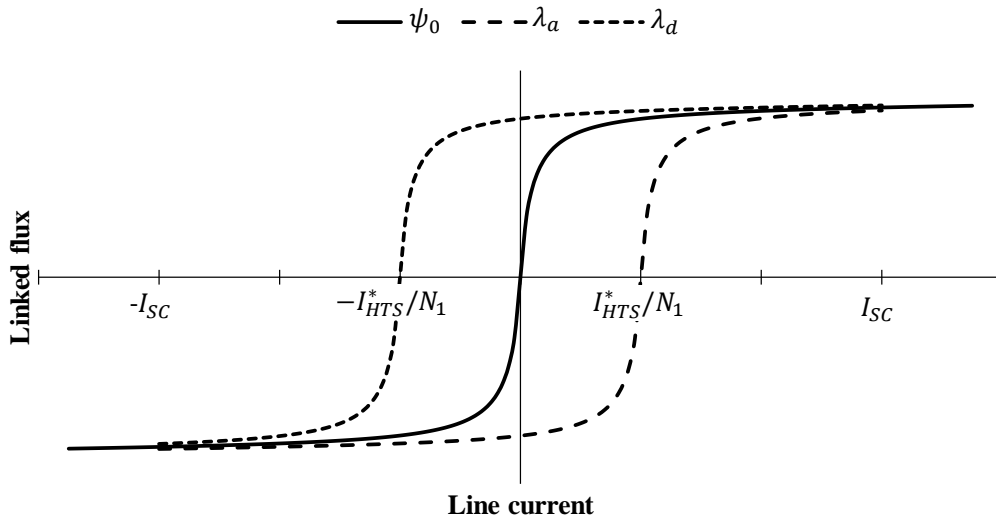


Figure 2.17 – Maximum hysteresis loop of an inductive type FCL.

The dynamical behaviour of the FCL can be predicted by determining and solving the equations of a known electrical grid, as presented in Figure 2.18. It is considered a grid with a voltage source, a line composed of a resistance and an inductance, and a load, which is short-circuited by a switch to intentionally introduce faults. To computationally solve the problem, the improved Euler method was used.

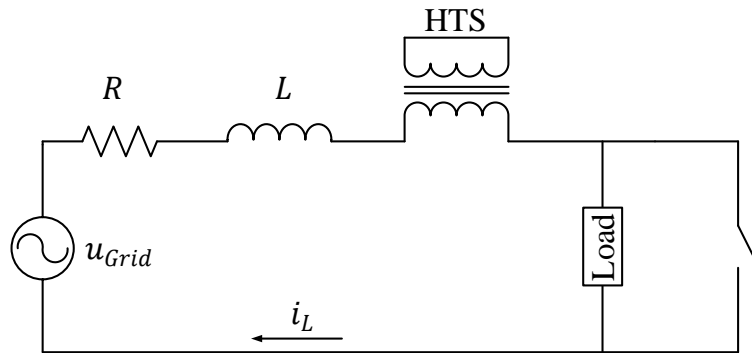


Figure 2.18 – Simulation grid with an inductive type FCL.

When a fault occurs, the time response of the circuit is given by (2.10),

$$u_{Grid} = R \cdot i_L + L \cdot \frac{di_L}{dt} + \frac{d\psi_{FCL}}{dt} \quad (2.10)$$

where  $u_{Grid}$ ,  $i_L$  and  $\psi_{FCL}$  are the grid voltage, line current and primary linked flux, respectively. The grid is composed of a resistance  $R$  and inductance  $L$ .

The previous equation is equivalent to (2.11),

$$u_{Grid} = R \cdot i_L + L \cdot \frac{di_L}{dt} + \frac{d\psi_{FCL}}{di_L} \cdot \frac{di_L}{dt} \quad (2.11)$$

By rearranging, the previous equation is equivalent to (2.12),

$$\frac{di_L}{dt} = \frac{di_L}{d\psi_{FCL}} \cdot \left( u_{Grid} - R \cdot i_L - L \cdot \frac{di_L}{dt} \right) \quad (2.12)$$

In order to computationally solve this problem, the improved Euler method is applied to discretise the equation (2.12) [98]. By applying computational solving, the simulation of this problem is fast [9].

This methodology was compared to FEM simulations and results are in great accordance [99]. Partial validation with experimental results has been made in [100]. Later, this methodology was improved by allowing to simulate complex grids with no need for the knowledge of all elements of the grid [101].

## 2.6 Development Status of Inductive FCLs

The development of inductive type limiters with HTS materials started with the use of bulks. However, poor mechanical properties such as brittleness and limited sizes due to manufacturing limits led to a decreased interest in this type of limiters since the development was restricted to small scale devices. The interest in large scale limiters of inductive type increased recently due to the technical and economic viability of manufacturing large HTS tape lengths. Following, in this chapter, the development of inductive limiters is presented and discussed.

For electrical power transmission and distribution systems, the design of inductive limiters must be considered due to several reasons [102]. The high current densities available in superconducting materials set off the development of smaller and lighter power devices when compared to conventional equivalents. The lower resistivity of superconductors reduces the losses in most power devices so that they can achieve higher power efficiency than conventional systems<sup>4</sup>. Superconductors can undergo an abrupt phase change from superconducting state to normal state, which is an advantage for several applications, such as current limiters, in which a fast change (less than one half period of line current) in resistance and/or inductance is desired in case of fault occurrences [103].

One of the first patents of an inductive FCL, if not the first one, was the U.S. Patent 4,700,257 published in 1987. This invention describes the basis of the inductive limiter in which the secondary winding is made of a low-temperature superconductor (LTS) material and therefore need to be kept in a cryogenic enclosure maintained at a temperature of 4 K. The secondary is composed of an “active” winding for compensation of the magnetomotive force of the primary, and a set of auxiliary windings designed to increase the resistance and the thermal capacity of the overall secondary in a case of a transition from

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<sup>4</sup> Please note that cooling costs must be considered.

the superconducting state to the normal state [104]. In Figure 2.19, the diagram of the limiter is described.

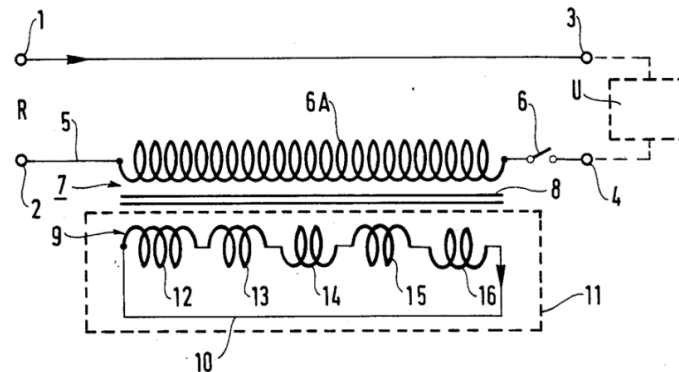


Figure 2.19 – Diagram of the single-phase AC current limiter of U. S. Patent 4,700,257. From [104].

Later, with the advent of the discovery of high-temperature superconductivity, inductive limiters employing HTS materials have been claimed, such as the U. S. Patent 5,140,290 published in 1992 [105] and the European Patent 0 620 630 A1 published in 1994 [106]. Figure 2.20 shows the drawings of the claimed devices of the aforementioned patents. More recently, several projects were developed. Following, the most important projects on inductive FCLs are presented and discussed.

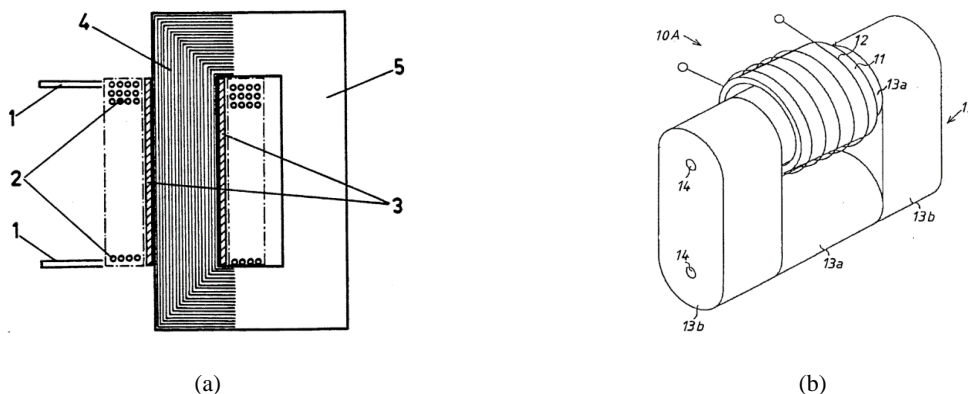


Figure 2.20 – Drawing of patented inductive FCLs. (a) Cross section of the FCL claimed in the U. S. Patent 5,140,290. (b) Perspective view of the FCL claimed in the European Patent 0 620 630 A1. From [105] and [106], respectively.

### 2.6.1 Hydro-Quebec 100 kVA FCL

A joint collaboration started in 1992 between Hydro-Québec and Siemens was established in order to develop an inductive FCL [107]. One of the main objectives was to test the availability of the FCL on the regional meshed networks of Québec, in Canada, at voltage levels up to 330 kV, avoiding to split substation busbars. The final device required Bi-2212 bulk HTS material and was developed for 100 kVA [25].

During the development, small scale prototypes with different geometries concerning the magnetic core were considered. The constitutive parts of a developed limiter are depicted in Figure 2.21 in which it is possible to observe the limiter on its closed-core geometry. For the case of the open-core geometry, the outer core portion is detached [69], [107]–[109].

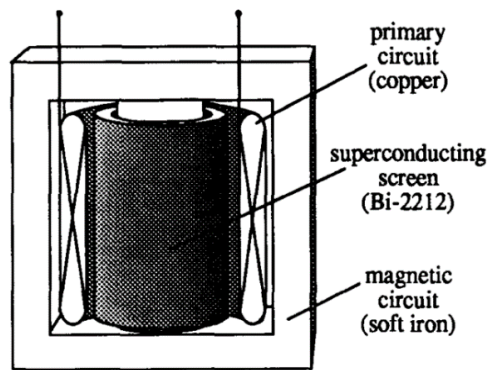


Figure 2.21 – Sketch of a Hydro-Québec Inductive FCL prototype. The inner and outer limbs of the core are detachable so that open-core and closed-core geometries can be carried out. From [69].

Short-circuit tests have been performed both at 77 K and 67–68 K in which the total device was immersed in the cooling bath. The general characteristics of the limiter on each configuration are presented in Table 2.3. Detailed information regarding the characteristics of the limiter can be found in [69].

Table 2.3 – Hydro-Québec inductive FCL prototype characteristics.

<i>Constitutive parts</i>	<i>Open-core FCL</i>	<i>Closed-core FCL</i>
Primary turns	269	111
Diameter of the primary	6.2 cm	15 cm
Cross section of the core	11.3 cm <sup>2</sup>	50 cm <sup>2</sup>
Length of the core	22 cm	75 cm
Magnetic permeability constant	~19	~600
<i>Test parameters</i>	<i>Open-core FCL</i>	<i>Closed-core FCL</i>
Nominal voltage	45 V <sub>rms</sub>	120 V <sub>rms</sub>
Nominal current	8 A <sub>rms</sub>	73 A <sub>rms</sub>
Nominal power	0.36 kVA	8.8 kVA

During the fault tests, the current was limited to about 5-8 times the nominal current and limitation always started in the first cycle after the fault [69]. In Figure 2.22, the current waveform in a fault occurrence of both open-core and closed-core geometries are presented.

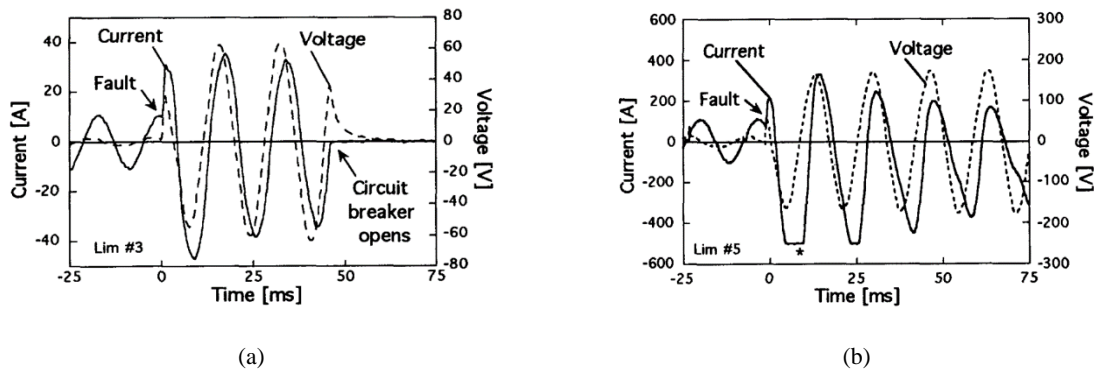


Figure 2.22 – Hydro-Québec FCL prototypes current waveforms during a fault occurrence. (a) Open-core geometry, 0.36 kVA. (b) Closed-core geometry, 8.8 kVA. From [69].

Later, a 100 kVA prototype was developed. The device required Bi-2212 with 15 cm diameter and a current density of about  $100 \text{ A/cm}^2$ . The 101 turn primary winding was made of copper and the iron core was made of 6 mm magnetic steel sheets. The total device was immersed in liquid nitrogen. Figure 2.23 shows the FEM mesh of one eighth of the full device [107].

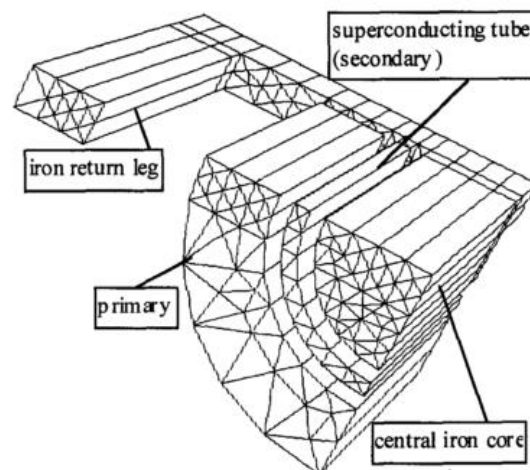


Figure 2.23 – Hydro-Québec FCL 100 kVA prototype model illustrated by its FEM mesh (one eighth of the full device). From [107].

The 100 kVA prototype was subjected to short-circuit tests. During tests, the current was limited to about 8 times the nominal current. In Figure 2.24 the current and voltage waveform during a fault is shown.

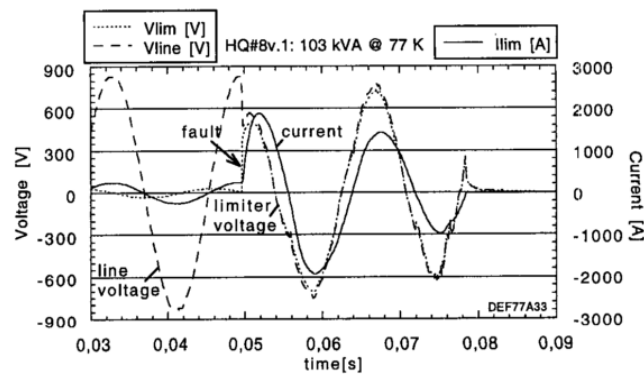


Figure 2.24 – Hydro-Québec FCL 100 kVA prototype current and voltage waveform during a fault occurrence. From [107].

## 2.6.2 ABB 1.2 MVA FCL

A 1.2 MVA, 3-phase limiter with phase to phase nominal voltage of 10.5 kV and nominal current of approximately 100 A peak was prototyped by Asea Brown Boveri (ABB), depicted in Figure 2.25. A magnetic core with 1400 mm high and diameter of 340 mm built from 4 mm thick steel sheets was developed for each phase. A 280 turns primary with 1400 mm high and diameter of 480 mm was employed. For the secondary, superconducting rings of Bi-2212 with a diameter of 380 mm, height of 80 mm and walls of 1.8 mm thick were used. The critical current density of the HTS material was  $1500 \text{ A/cm}^2$ . The total weight of this device is about 1300 kg [110].

More than 100 tests, with prospective currents of 60 kA, were performed. For such prospective current, the limited current was about 700 A in the first half-wave and below 250 A after 50 ms. In Figure 2.26, the evolution of the line current and the voltage drop over the limiter for a short-circuit test is shown [59].

Started in November 1996, this device was installed and tested during one year in the 10.5 kV auxiliary line of the NOK hydropower plant Kraftwerk am Löntsch in Switzerland. Unfortunately, no fault has occurred during the endurance test. Despite this, the test has shown that there was no degradation of the HTS material and proved the feasibility of a liquid nitrogen cooling system.

The inexistence of faults during the test does not allowed to gather pertinent information about the performance of the device during fault operation in a real grid.

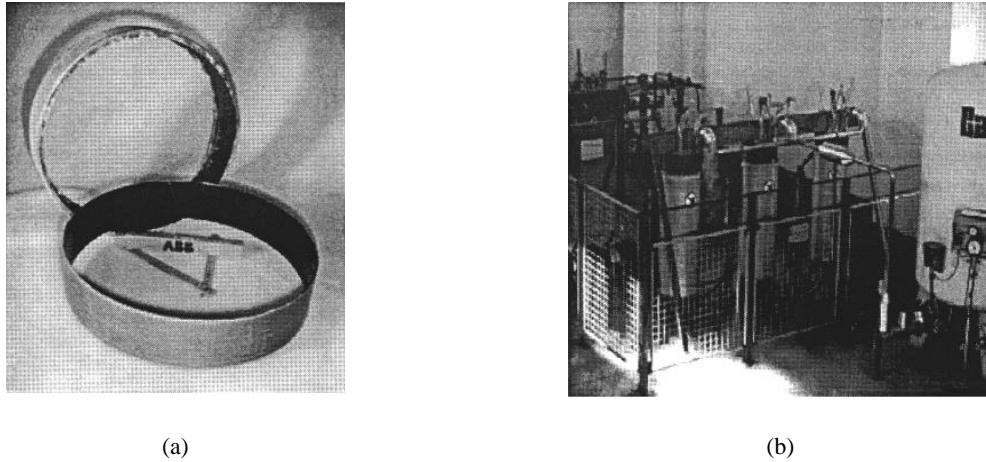


Figure 2.25 – Three-phase 1.2 MVA FCL prototyped by ABB. (a) Produced Bi-2212 bulk rings. (b) Place of installation. From [59].

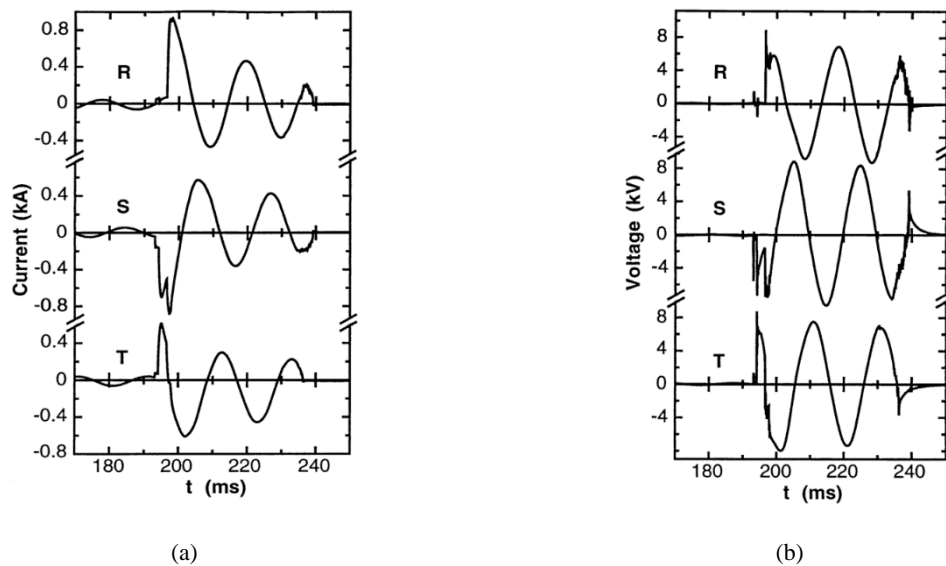


Figure 2.26 – Three-phase short-circuit results. (a) Line current. (b) Voltage drop across the limiter. From [59].

### 2.6.3 CRIEPI FCL Project

The Central Research Institute of the Electric Power Industry (CRIEPI) started to develop a single-phase limiter using an HTS cylinder built from Bi-2223 bulk as well as Bi-2212 thick film. The schematic diagram of the limiter and its photography is depicted in Figure 2.27.

The iron core is 98 mm in width, 174 mm in length and 38 mm in diameter. Wound to the core, there are a primary winding, an HTS cylinder and a control ring. The primary of the device is composed of two copper layers of 113 turns. The cylinder, as aforementioned, is built from Bi-2223 bulk or Bi-2212 thick film. A control ring, made of copper with 45 mm in diameter, 1.5 mm in thickness and 5 mm in length, is introduced with the intention to absorb some of the energy deposited during a fault [111].

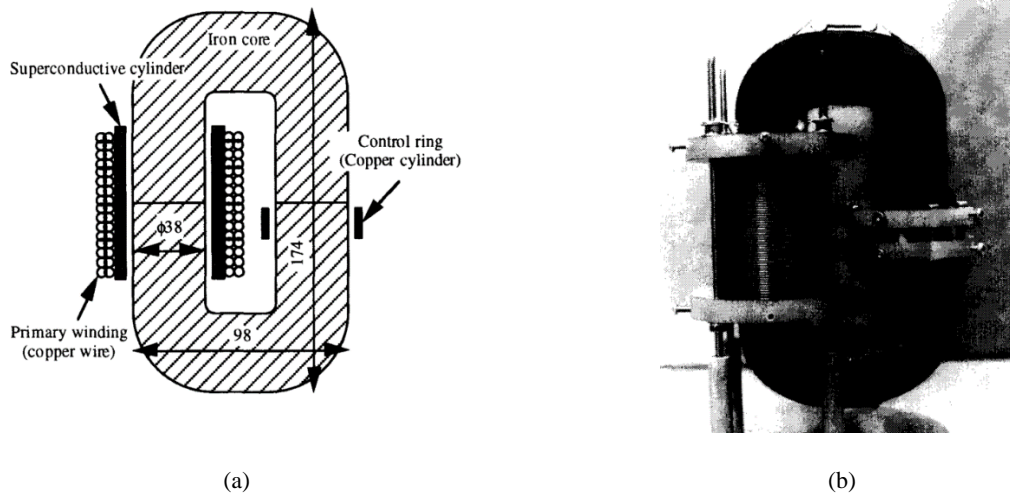


Figure 2.27 – CRIEPI limiter. (a) Schematic diagram. (b) Photography. From [111].

After tests, presented in Figure 2.28, it was chosen to adopt the Bi-2212 thick film rather than the Bi-2223 bulk since it is easier to make larger scale devices and the test results showed better current limitation and better recovery after a fault. The thick film consists of Bi-2212 deposited on a magnesium oxide substrate [111].

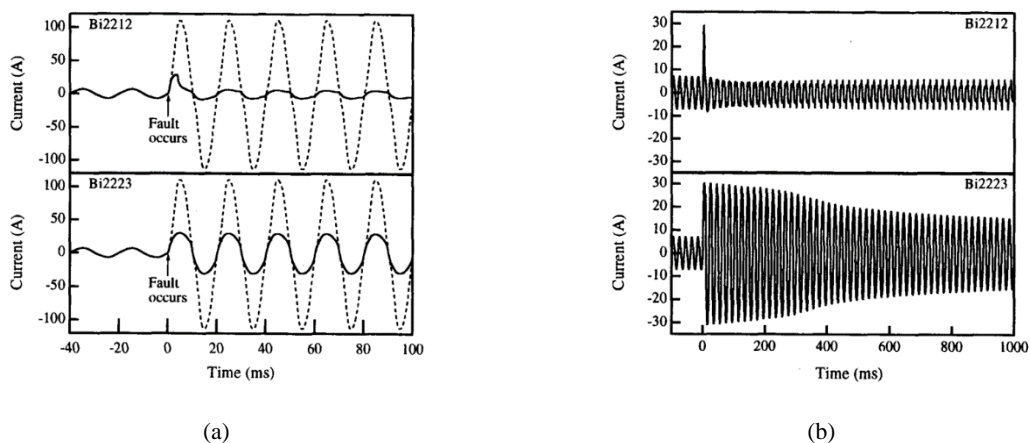


Figure 2.28 – Short-circuit results. (a) 100 ms limitation time. (b) 1000 ms limitation time. From [111].

Afterwards, an FCL rated for  $6.6 \text{ kV}_{\text{rms}}$  and  $400 \text{ A}_{\text{rms}}$  was developed. This prototype considered the same superconducting material as used in the small scale model and limits the current to about 6 times the operating current [112].

Following the previous development, another prototype was built. This prototype, presented in Figure 2.29, is rated for  $66 \text{ kV}_{\text{rms}}$  and  $1000 \text{ A}_{\text{rms}}$ . The HTS cylinder was fabricated considering a Bi-2223 thick

film with a Bi-2212 buffer layer deposited in magnesium oxide substrate. The specifications of the prototype are presented in Table 2.4. More detailed information can be found in [113].

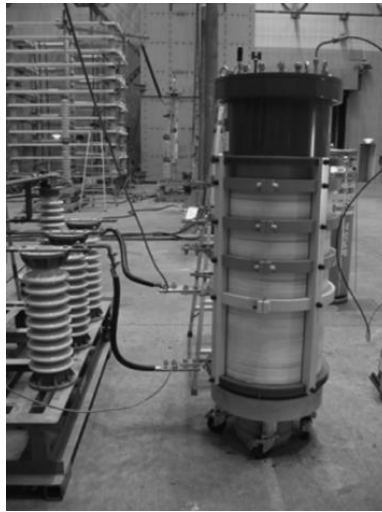


Figure 2.29 – Photography of a short-circuit test of the CIREPI limiter. From [113].

Table 2.4 – CRIEPI limiter characteristics.

<i>Constitutive parts</i>	
Primary turns	36
Diameter of the core cross section	50 mm
Height of the core	900 mm
Outer diameter of HTS cylinder	450 mm
Inner diameter of HTS cylinder	430 mm
Length of HTS cylinder	120 mm
Thickness of HTS material	0.5 mm
<i>Test parameters</i>	
Nominal voltage	3.5 kV <sub>rms</sub>

A test was conducted with a supply voltage of 3.5 kV<sub>rms</sub>. For a prospective current of 11.3 kA, the current was limited to 7.97 kA, as depicted in Figure 2.30.

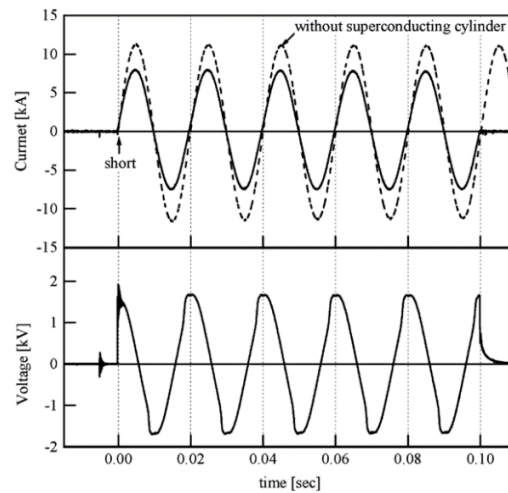


Figure 2.30 – Short-circuit results of the full-scale CRIEPI limiter. Adapted from [113].

#### 2.6.4 Nagoya University SFCLT Project

An FCL with both functions of transformer and limiter was developed in Japan between 2004 and 2008 [114]. The project was based on five main phases, in which three prototypes with rated power of 6.25 kVA, 100 kVA and 2 MVA were developed. The device works as a transformer in normal operation and works as fault current limiter during fault condition. In normal operation, the leakage impedance of the transformer is lower when compared to conventional transformers and a limiting impedance is activated in fault operation.

In Step-1 of the project, an electromagnetic transient analysis was performed in order to optimise the operating parameters of the FCL in a simplified model system. In Step-2, a scaled-down model rated for 6.25 kVA, 275 V/105 V, with NbTi coils at liquid helium temperature was designed and prototyped in which its fundamental functions were tested. In Step-3, a prototype with the same rated power and voltage as Step-2 was built with BSCCO bulk coils and tested at liquid nitrogen temperature. In Step-4, YBCO coils were employed to fabricate and test another prototype, this one rated for 100 kVA, 6.6 kV/210 V. Lastly, in Step-5 a 2 MVA, 22 kV/6.6 kV, 3-phase FCL employing YBCO, YBCO/Cu and Bi2223 tapes was developed. In the last step, a feasibility assessment of the project was also done [115].

The Step-4 device was tested and showed a limited current of 516 A at first peak and 330 A at fifth peak for a prospective current of 980 A. After the fault clearance, the device exhibited self-recovery performance, as depicted in Figure 2.31 [115].

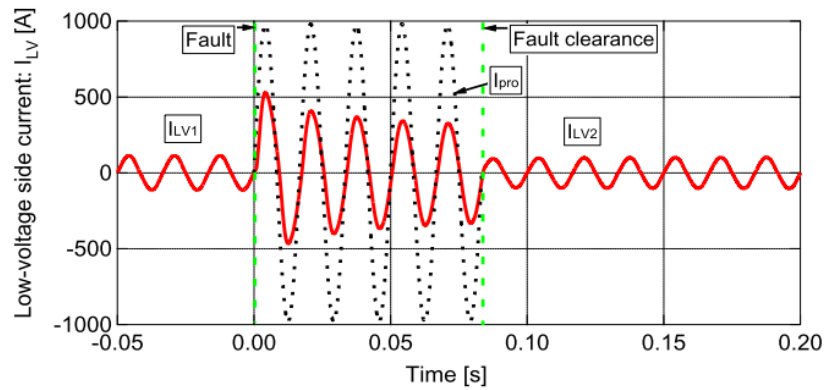


Figure 2.31 – Step-4 SFCLT Project prototype current waveform during a fault occurrence. From [115].

The 2 MVA class FCL, developed at the Step-5 of the project and depicted in Figure 2.32, is composed of three different types of windings wrapped around a two-legged closed-core per phase. The whole device is immersed in liquid nitrogen. Low-voltage windings are composed of YBCO as well as YBCO/Cu tapes and high-voltage windings are composed of Bi-2223 tape. It is mentioned 5.3% of leakage impedance during normal operation at 50 Hz [116].

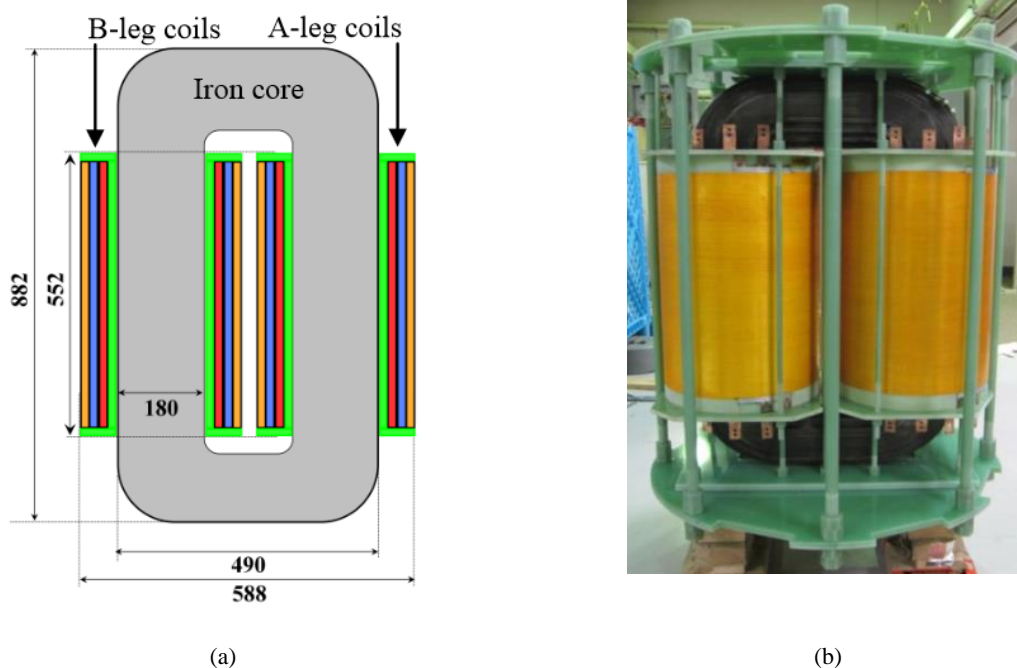


Figure 2.32 – Construction on the Step-5 SFCLT. (a) Dimensions of the device, in mm. (b) Developed device. From [115].

For a prospective current of 786 A, the current was limited to 267 A at the first peak and 145 A at the fifth peak, respectively, during a fault test. In Figure 2.33 the current waveform during the fault occurrence is shown. The decrease of the limited current during the fault time means a temporal rise of the limiting impedance of the device [116].

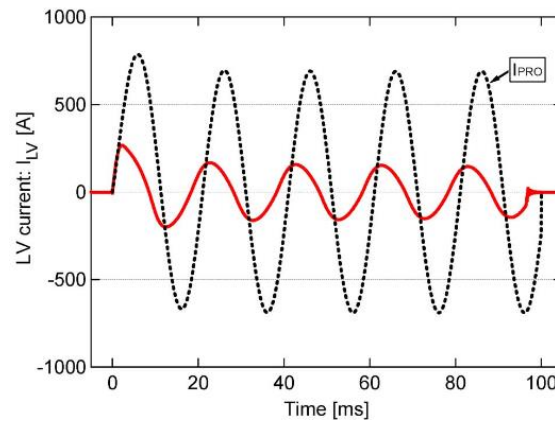


Figure 2.33 – Step-5 SFCLT Project prototype current waveform during a fault occurrence. From [116].

### 2.6.5 Bruker 40 MVA FCL

Bruker in partnership with Schneider Electric planned to introduce in 2013 an inductive FCL in a substation of the Stadtwerke Augsburg power plant in Germany that supplies the manufacturing plant of a company that produces combined heat and power systems. Started in 2010, the project was planned to last 3 years.

The three-phase so-called iSFCL was intended to be installed on a 10.6 kV branch that is fed from a 40 MVA, 10 kV/110 kV transformer and is able to limit a prospective current of 25 kA to 5 kA in the first peak and 2 kA the remainders. The response time of the limiter is about 1 ms and withstands faults up to 500 ms. Before the development of the full-scale device, a single-phase scaled-down prototype rated to 15 MVA and current of 817 A<sub>rms</sub>, depicted in Figure 2.34, was tested in the Braunschweig University. Results showed that the developed stacks of HTS modules were effective in more than 100 quench tests with duration up to 500 ms. Furthermore, it was achieved good agreement between FEM simulations and measurement results. In their last press release, in 2012, Bruker and Schneider announced that the validation test was successful.

However, significant technical difficulties with manufacturing of HTS modules for the three-phase limiter led to the termination of the project at the end of 2012. The objectives were not fully achieved but considering the performed mock-up tests in the scaled-down prototype the concept of the iSFCL was demonstrated [117].

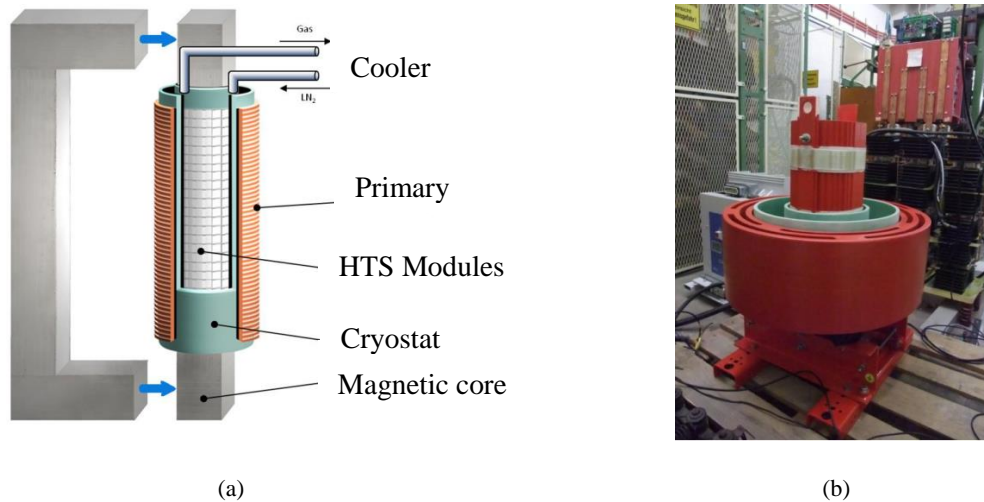


Figure 2.34 – Single-phase iSFCL. (a) Sketch. The magnetic core can be opened or closed. (b) Device with open core geometry during the mock-up test. Adapted from [117].

### 2.6.6 IEL 6 kV/0.6 kA

In 2012, the Instytut Elektrotechniki (IEL) from Poland presented the first polish FCL for distribution grids, depicted in Figure 2.35, [118]–[120]. The device, designed for 6 kV/ 0.6 kA nominal operation, presents reduced size and weight (180 kg) due to its coreless construction. The primary is built from copper and the secondary is built from 2G SuperPower tape, with reference SF12050. Numerical simulations have been performed with Flux2D from Cedrat Company. Subjected to high power tests, the device limited a first-peak prospective current of 15.67 kA to 4.94 kA [118].

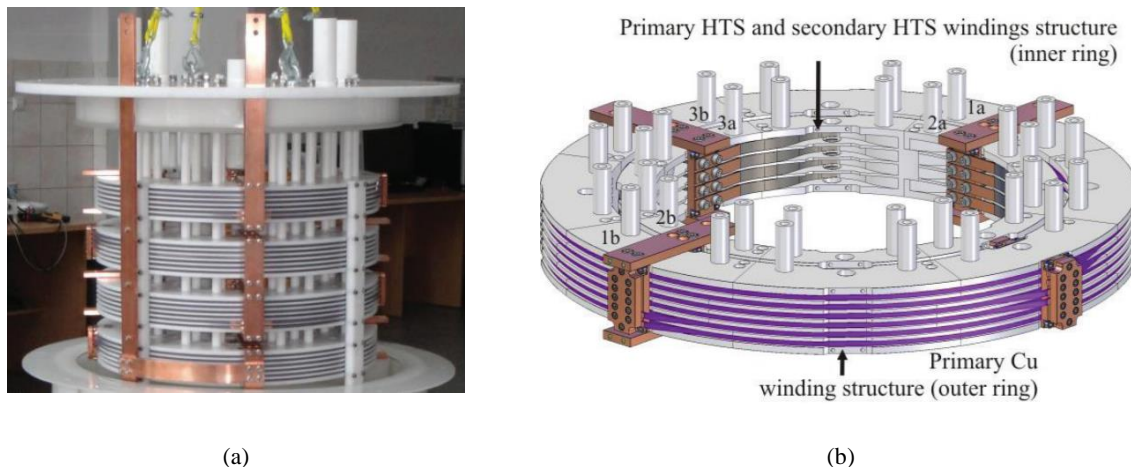


Figure 2.35 – Coreless single-phase FCL from IEL. (a) Developed device. (b) Detailed sketch of the device. Adapted from [118].

## 2.7 Summary

In this chapter, a literature review regarding fault current protection of electrical grids has been carried out. Such current protection can be performed by topological measures based on splitting the grid into sub-grids, splitting of busbars or building new substations. Despite ensuring fault protection, those measures are costly and time-consuming. Fault currents can also be mitigated by using protective devices, such as fuses, pyrotechnic breakers, air-core reactors and power electronic based devices.

The most important heat exchange mechanisms (conduction and convection) in superconducting materials used in the development of applications on current limitation have been presented and discussed.

In the case of superconducting tapes, the most common techniques used to build joints have been addressed. These techniques are applied in the development of short-circuited rings of superconducting tapes, used in inductive type FCLs.

Simulation methodologies of inductive type FCLs, such as lumped-parameters equivalent circuits (e.g., Steinmetz equivalent circuit and time-variable resistances and impedances), finite element methods, electromagnetic-thermal coupling and reverse engineering modelling (e.g., characteristic hysteresis loop methodology) have been presented and discussed.

Lastly, the development status of inductive type FCLs have been addressed, as summarised in Table 2.5. Some projects presented in Table 2.5 considered the development of several scale prototypes whereby only the data of the higher power rate prototype of each project is presented.

Table 2.5 – Summary of inductive type FCL activities.

<i>Institution</i>	<i>Country</i>	<i>Power Rating</i>	<i>HTS Material</i>	<i>References</i>
Hydro-Québec	Canada	100 kVA	Bi-2212 bulk	[25], [69], [107]–[109]
ABB	Switzerland	1.2 MVA	Bi-2212 bulk	[59], [110]
CRIEPI	Japan	66 kV, 1 kA	Bi-2212 tape Bi-2223 bulk	[111]–[113]
Nagoya University	Japan	2 MVA	YBCO tape Bi-2223 tape	[114]–[116]
Bruker	Germany	40 MVA	YBCO tape	[117]
IEL	Poland	6 kV, 0.6 kA	YBCO tape	[118]–[120]



## 3

## *Design and Modelling of the Inductive FCL*

Modelling and simulation of electromagnetic and thermal coupled problems in transient regimes of superconducting devices constitute a complex task since there is no available commercial software to directly couple this kind of problems [85], [86]. Electromagnetic and thermal behaviour of superconducting devices are commonly solved individually due to critical parameters dependencies. Since superconducting materials present highly nonlinear properties, design and modelling are of particular importance for an accurate project. In this chapter, the design and modelling of electromagnetic and thermal properties of the inductive type limiter are addressed.

### **3.1 Constitutive Parts of the Limiter**

The limiter, schematically illustrated in Figure 3.1, is composed of a magnetic core, a primary winding and a secondary superconducting ring made of 2G tape. The latter is supported by a Celeron holder and housed in a cryostat with liquid nitrogen whose dimensions are presented in Appendix A. The volume of liquid nitrogen that the cryostat can store is about 0.25 L. The primary winding, made of copper and supported by an acrylic holder, is connected in series with the line under protection.

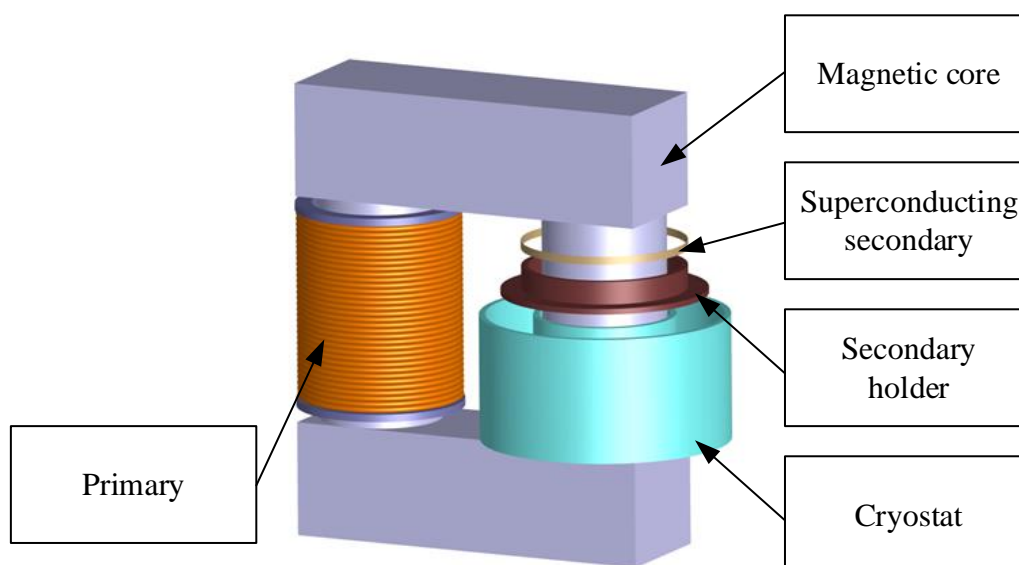


Figure 3.1 – Sketch of the inductive type limiter.

In the primary, there is also an auxiliary winding that is used to measure the linked flux. The constitutive parts that were built, i.e. primary, secondary and cryostats, are depicted in Figure 3.2.

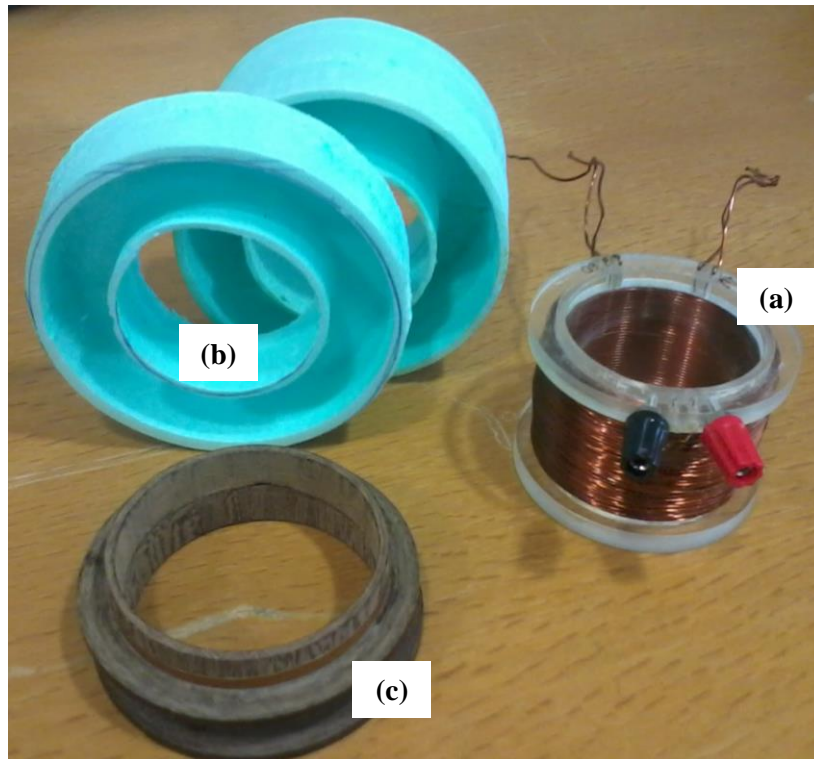


Figure 3.2 – Constitutive parts of the limiter. (a) Primary with configurable number of turns and an auxiliary winding for measurement of the linked flux. (b) Cryostats. (c) Superconducting secondary supported by a Celeron holder.

### 3.1.1 Magnetic Core

To design an inductive limiter, there are three basic configurations regarding the magnetic path: open-core, closed-core and air-core reactor (without core). The closed-core configuration is chosen for this work. Despite requiring a higher amount of material, the closed-core configuration has reduced magnetic disturbances in the surroundings since the magnetic flux stays confined in the core. Besides that, during a fault, current limitation in a closed-core configuration is generally higher when compared to the other configurations [121], [122]. A two-limbed magnetic core of a power transformer built by 0.5 mm-thick sheets of non-oriented grain electrical steel, from Oficel Electrotecnia Lda. Company, was acquired for the development of the limiter prototype. The dimensions of the core are presented in Figure 3.3. The stacking factor is 0.97.

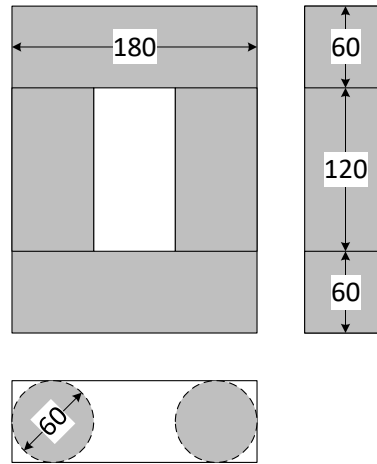


Figure 3.3 – Dimensions (in millimetres) of the magnetic core of the limiter.

### 3.1.2 Primary

The device should work under different conditions depending on the regime of operation. Under fault operation, the resistance and inductance should be high and, under normal regime, should be negligible. The inductance of the limiter, at normal operation, is basically determined by the leakage inductance of the windings. Usually, in normal conditions, the voltage drop across an FCL should be less than 5% of the rated circuit voltage in order to do not disturb the static stability of the power grid [123], [124].

Due to the ease of manufacturing and relatively low price, copper is chosen for the primary. Considering the reference [125], the maximum recommended current density of copper, at normal operation in a power transformer, is  $3 \text{ A}\cdot\text{mm}^{-2}$ . The cross section of the copper wire used is  $1.5 \text{ mm}^2$ , allowing currents up to 4.5 A in normal operation. The properties of the primary are summarised in Table 3.1.

Table 3.1 – Properties of the primary.

<i>Parameter</i>	<i>Value</i>
Material	Copper
Number of turns	60
Conductor cross section	$1.5 \text{ mm}^2$
Holder inner radius	32.5 mm
Holder outer radius	36.5 mm
Holder height	40 mm

### 3.1.3 Secondary

The secondary of the limiter is built from one single turn of Superpower SCS4050 tape, from SuperPower Company. This tape is composed of several layers, i.e. copper, silver, substrate (Hastelloy), YBCO and a buffer stack, as depicted in Figure 2.8. The copper layers of the tape have the special purpose of providing high thermal conductivity. On the other hand, the Hastelloy layer provides mechanical strength. The most important properties of the tape, concerning the development of this work, are presented in Table 3.2. Since the minimum critical current of the tape is 100 A, the magnetomotive force in the primary during normal operation should verify the condition expressed in (3.1) in order to avoid possible quenching,

$$N_1 \cdot I_1 \leq 100 \text{ A} \cdot \text{t} \quad (3.1)$$

where  $N_1$  and  $I_1$  are the number of turns and current amplitude of the primary, respectively.

Table 3.2 – Properties of the secondary.

<i>Parameter</i>	<i>Value</i>
Tape reference	Superpower SCS 4050
Number of turns	1
Tape cross section	0.4 mm <sup>2</sup>
Minimum engineering critical current density (at 77.3 K)	250 A·mm <sup>-2</sup>
Minimum <i>n</i> -value at 77.3 K	30
Holder inner radius	37 mm
Holder outer radius	40 mm
Holder height	15 mm

To implement the ring, a joining technique is required. This task constitutes a critical issue concerning the requirement of low contact resistance among the terminations of the tape to be joined. According to Superpower, soldering is an appropriate possibility [126]. Previous works have confirmed this, showing that joint resistances of soldered tapes are small enough for practical applications in FCLs [127]–[129]. Typical joint resistances in SCS4050 tapes with a 100 mm-length thin intermediate solder are in the order of 100-150 nΩ [39].

From [130], [131] it is suggested that, to reduce contact resistance, overlayers should be removed prior to the application of the joining technique. The overlayer removal can be achieved by etching

procedures. The chemical etching procedure used to remove overlayers, e.g. copper or silver, is critically important since other layers should not be affected. To remove overlayers and maintain the HTS layer integrity it is suggested the use of suitable equipment that allows controlling the dipping depth and time of the tapes in the chemical products. Kapton tape with adhesive may be attached to the intended surface to be protected against etching. The etching procedure should consider the following steps:

- a) Cleaning the tape by wiping with a clean cloth.
- b) Wetting with Methanol.
- c) Air drying.
- d) Etching with an appropriate etchant for the surrounding layer, during a determined time according to the etchant and layer properties.
  - a. Rinsing thoroughly with distilled water.
  - b. Rinsing with Methanol.
- e) Fan drying.

As a preliminary study, several samples of Superpower SCS4050 tape were dipped inside etchant<sup>5</sup> for predetermined times between 10 and 45 minutes. The result after this procedure can be observed in Figure 3.4. After this procedure, the samples were encapsulated into resin in order to be analysed. Details concerning the performed encapsulation can be found in Appendix B.



Figure 3.4 – Etched samples. (a) Front. (b) Back. The use of Kapton tape with adhesive (detached from the samples after etching procedure) provides protection of surfaces that should not be etched.

<sup>5</sup> Copper etchant with reference 667528 from Sigma Aldrich.

A microscopy of an etched sample is shown in Figure 3.5. The presence of copper can be investigated by means of an element concentration image by energy dispersive x-ray spectroscopy. The spectroscopy pattern of a virgin sample is compared to a sample with copper removed, as depicted in Figure 3.6. It was found that the copper layer is completely removed after 20 minutes of etching.

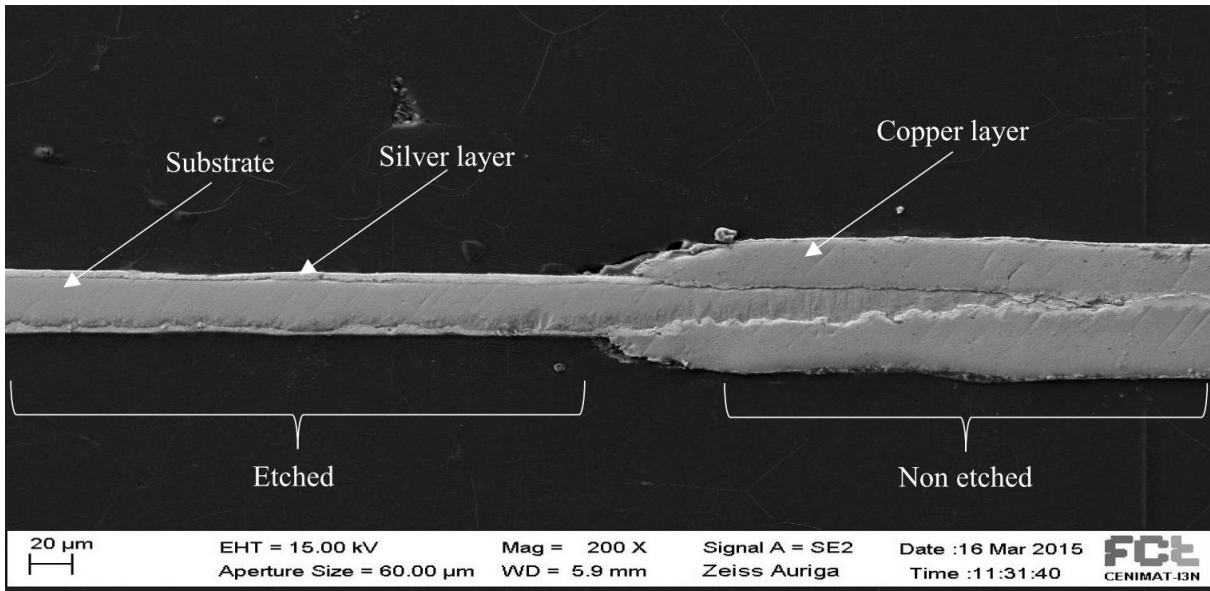


Figure 3.5 – Scanning electron microscopy of a Superpower SCS4050 tape subjected to copper etchant during 20 minutes.

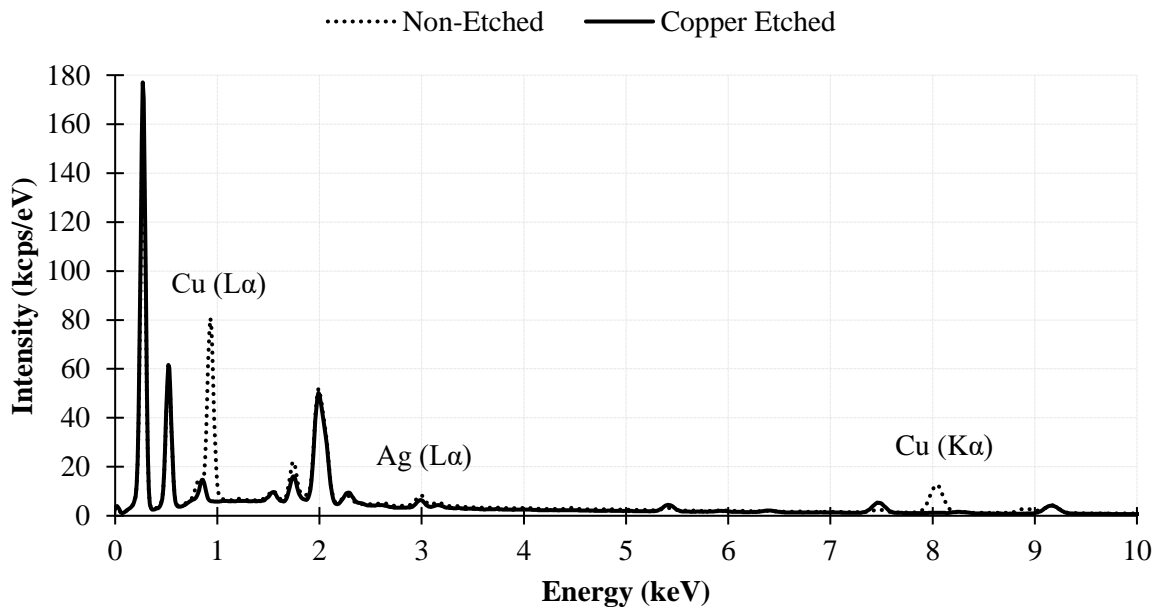


Figure 3.6 – Energy dispersive x-ray spectroscopy comparison between a copper-etched sample and a virgin sample of SuperPower SCS4050 tape.  $L\alpha$  and  $K\alpha$  are x-ray levels of transition energies.

Following the etching procedure, the soldering technique should be carried out. According to SuperPower [126], soldering should be performed at lower temperatures as possible in order to prevent degradation of the properties of the tape and avoid reduction of oxygen within the superconductor [132]. According to previous works [129], [133], [134], a bridge type joint is considered the best-suited joint for a single-turn coil. Soldering instructions from SuperPower were taken into account [126].

One segment of tape with the length of the perimeter of the ring was soldered in a face-to-face configuration to an auxiliary segment with the length of the joint. A Sn96.5-Ag3.5 solder paste was used and a stainless-steel holder for joining assembly was built to ease the manufacturing of joints, as depicted in Figure 3.7. This holder, made of stainless steel, was built in a computer numeric control (CNC) machine. The tape is wound around the cylinder and a pressure block is used to apply mechanical pressure allowing establishing the bridge joint. The soldering is performed by placing the holder with tapes wound inside a furnace at 220 °C during 15 minutes. Besides soldering, brazing and welding techniques can also be employed using this device. Bolts are used to apply appropriate mechanical pressure over the joint region. After performing the superconducting rings, a Celeron holder is used to support them, as depicted in Figure 3.8 [19].

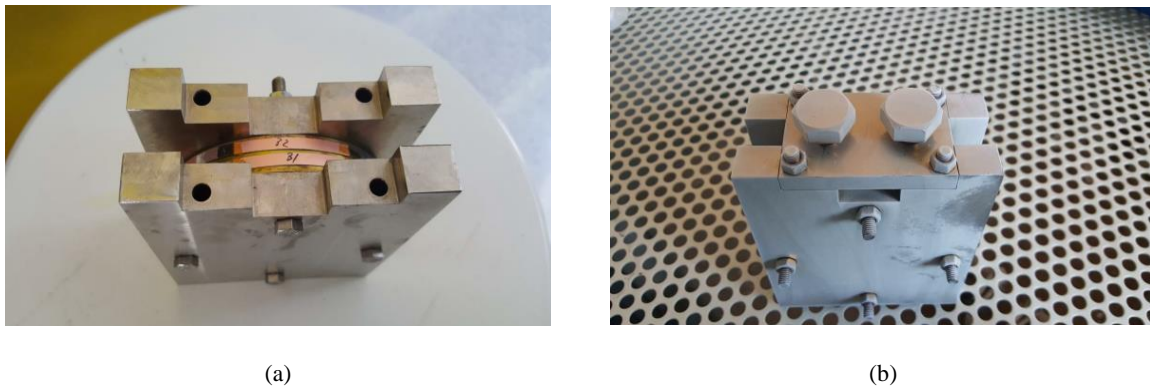


Figure 3.7 – Stainless-steel holder for soldering of superconducting rings. a) Interior detail with two tapes wound. b) Assembled device prepared for soldering.



Figure 3.8 – Celeron holder supporting superconducting rings. From [19].

## 3.2 Modelling in Transient States

In this section, the properties of the HTS tape that are strongly dependent on temperature, such as electrical resistivity, heat capacity, thermal conductivity, critical current density and  $n$ -value, are addressed [87], [135]. These properties are modelled with the purpose of simulating the thermal behaviour of this tape.

The temperature dependency of critical current density and  $n$ -value defining the  $E - J$  power law of the HTS tape is considered. This power law is used to characterise the resistivity of the HTS layer. The remaining layers composing the tape, i.e. copper, silver and Hastelloy, as well as the HTS layer in resistive state are modelled by temperature-dependent functions. The relationship between temperature and thermal conductivity, heat capacity and convective heat transfer coefficient, is also considered. Critical current inhomogeneity and geometrical imperfections of the superconducting tape are not included in the models.

On the other hand, the behaviour of the limiter, with the HTS tape included, is modelled by a maximum hysteresis loop giving estimations of the limited line current and primary linked flux. The current in the HTS tape, during normal and fault operations, is also predicted. These models are based on experimental measurements.

### 3.2.1 Electromagnetic-Thermal Behaviour of the Superconducting Tape

During fault occurrences, FCLs are required to operate at overcurrents during a certain amount of time (some hundreds of milliseconds) while circuit-breakers trip. The occurrence of such overcurrents can lead to harmful effects due to thermal stresses originated in the HTS tape. Thus, the study of its thermal stability is an important research subject [85]. The thermal stability is generally studied by applying overcurrents or heat to the HTS material, while temperature and related properties, such as electrical resistivity, current or losses, are measured [136]. To quantify temperature, thermocouples and voltage probes have been often used, see e.g. [44], [136], [137]. Resistance temperature detectors (RTDs) have also been applied, see e.g. [86], [135], [138]. However, these studies have been mostly focused on resistive type FCLs. Fewer developments have focused on inductive type limiters, see e.g. [139]–[141], as addressed in this work.

Superconducting materials can present a highly non-linear behaviour within their operating range concerning electrical resistivity, heat capacity, thermal conductivity, critical current density, and  $n$ -value. Modelling the electromagnetic and thermal behaviour of these materials is a very important task for design purposes. Considering the case of FCLs, predicting electromagnetic and thermal processes in the course of transient states plays an important role in the design of the device.

### 3.2.1.1 Critical Current Density and $n$ -value

The critical current of a superconductor can be modelled by a power law dependence that relates the electrical field  $E$  to the current density  $J$ , or equivalently the voltage drop  $U$  to the current  $I$ , as expressed in (3.2) and (3.3), respectively,

$$|E| = E_C \cdot \left(\frac{|J|}{J_C}\right)^n \quad (3.2)$$

$$|U| = U_C \cdot \left(\frac{|I|}{I_C}\right)^n \quad (3.3)$$

where the  $n$ -value is the exponent of the power law that models the transition. The critical values of electric field, current density, voltage and current are expressed by  $E_C$ ,  $J_C$ ,  $U_C$  and  $I_C$  respectively. The critical electric field is often defined as  $1 \mu\text{V/cm}$  [142].

The power law can be experimentally obtained according to IEC 61788-3 [142]. This technique consists on a four points method, as illustrated in Figure 3.9. The measurement procedure includes the application of a known DC current, by means of a DC current source, and the measurement of the voltage drop between two points.

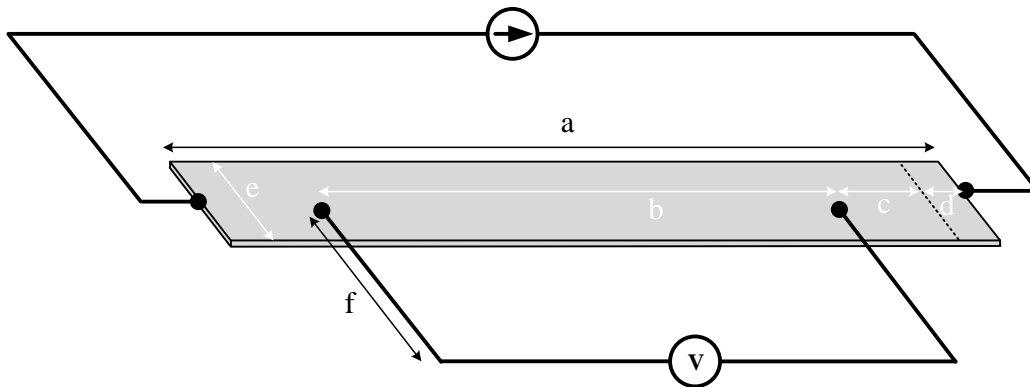


Figure 3.9 – Illustration of a tape with voltage taps for four points method measurement.

With respect to Figure 3.9 and according to IEC 61788-3, the measurement procedure must follow the constraints expressed in (3.4),

$$\begin{cases} a & \geq 5 \cdot e \\ b, c, d & \geq e \end{cases} \quad (3.4)$$

This power law has not yet been standardised for 2G conductors, only for 1G conductors [142]. However, experimental results carried out with 2G conductors show good agreement to the power law dependence. For example, in the reference [143], the power law was applied to 2G tape.

In order to measure the critical current and  $n$ -value, experimental measurements on a sample of the acquired tape were carried out, as depicted in Figure 3.10. The collected data points are presented in Figure 3.11. According to the power-law, both the experimental critical current density and  $n$ -value are higher than the minimum values presented by the manufacturer, in Table 3.2. These experimental values are presented in Table 3.3.

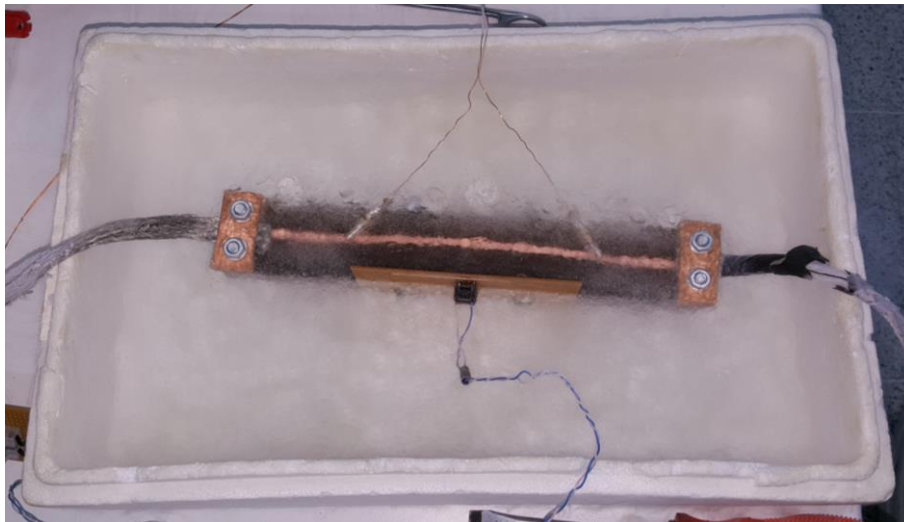


Figure 3.10 – Experimental four points method.

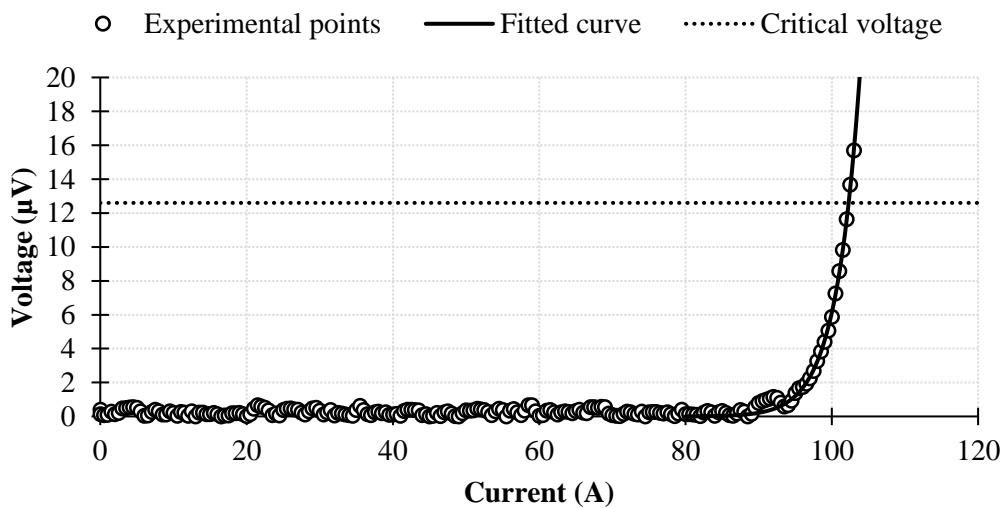


Figure 3.11 – U-I characteristic of a 4 mm wide SuperPower SCS 4050 sample. Voltage points are spaced 12.6 cm from each other. According to the  $1 \mu\text{V}/\text{cm}$  criterion,  $12.6 \mu\text{V}$  is the critical voltage drop.

Table 3.3 – Critical parameters of the sample subjected to the four points method in accordance with IEC 61788-3.

<i>Parameter (at 77.3 K, self-field)</i>	<i>Value</i>
Critical current	102.3 A
Engineering critical current density	255.8 A·mm <sup>-2</sup>
<i>n</i> -value	31.71

### 3.2.1.2 Resistivity

The electrical resistivity of the superconducting layer is extremely nonlinear below its critical temperature [142]. On the other hand, according to [144], it was found to be linear above the critical temperature, as illustrated in Figure 3.12. Thus, the modelled value for the electrical resistivity of the superconducting layer,  $\rho_{YBCO}$ , corresponds to the minimum value between superconducting state resistivity,  $\rho_{YBCO,S}$  and normal state resistivity,  $\rho_{YBCO,N}$ . The former assumes the  $E$ - $J$  power-law [142] and the latter is obtained by a linear fitting from the values shown in [144]. Calculations are performed according to (3.5),

$$\rho_{YBCO} = \min\{\rho_{YBCO,S}, \rho_{YBCO,N}\}$$

$$\begin{cases} \rho_{YBCO,S}(J, T) = \frac{E_c}{J} \cdot \left(\frac{J}{J_c(T)}\right)^{n(T)} + \rho_0 \\ \rho_{YBCO,N}(T) = 3.2 \times 10^{-8} \cdot T + 2.9 \times 10^{-6} \end{cases} \quad (3.5)$$

where  $E_c$  is the 1  $\mu$ V/cm electric field criterion of the  $E$ - $J$  power law [142],  $J$  is the current density,  $J_c$  is the critical current density,  $n$  is the  $n$ -value and  $T$  is the temperature. Due to numerical stability during computation solving, there is the presence of an additional finite resistivity  $\rho_0$ , in superconducting state. According to [76], this additional resistivity may be interpreted as the thermally activated resistance at 77.3 K and its maximum value is expressed in (3.6),

$$\rho_0 < 10^{-2} \cdot \frac{E_c}{J_c} \quad (3.6)$$

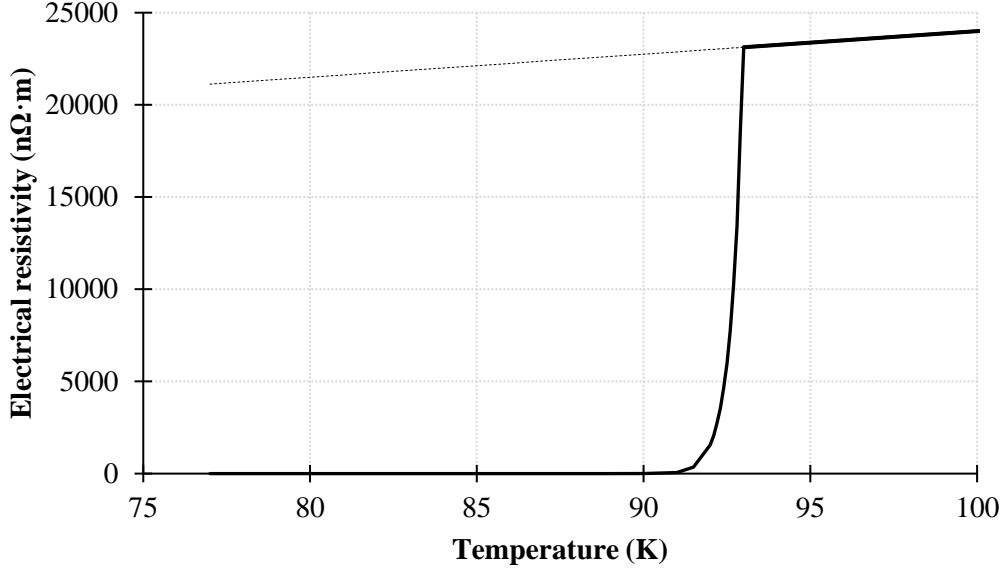


Figure 3.12 – Resistivity of superconducting layer as a function of temperature.

The temperature dependency of the critical current density and the  $n$ -value are modelled by (3.7) and (3.8), respectively [135], [145],

$$J_c(T) = J_c(T_0) \cdot \left( \frac{1 - \left(\frac{T}{T_c}\right)^\delta}{1 - \left(\frac{T_0}{T_c}\right)^\delta} \right)^\gamma \quad (3.7)$$

$$n(T) = n(T_0) \cdot \left(\frac{T_0}{T}\right)^\kappa \quad (3.8)$$

where  $T_c$  is the critical temperature of the superconductor,  $T_0$  is the liquid nitrogen temperature, and  $\delta$ ,  $\gamma$  and  $\kappa$  are fitting parameters [145]. It is considered that the decay of critical current and  $n$ -value as a function of temperature behave similarly to the results presented in [135]. Therefore, considering the measured critical values, at 77.3 K, of the tape used in this work (engineering critical current density of 255.8 A·mm<sup>-2</sup> and  $n$ -value of 31.71), the fitting parameters of (3.7) and (3.8) that present a decay of critical current and  $n$ -value as a function of temperature similar to [135] are expressed in Table 3.4.

Table 3.4 – Parameters for calculation of critical current density and  $n$ -value.

<i>Parameter</i>	<i>Value</i>
$T_0$	77.3 K
$T_C$	93.0 K
$\delta$	1.249
$\gamma$	4.963
$\kappa$	22.96

The electrical resistivities of the other layers of the HTS tape as a function of temperature are modelled in (3.9), (3.10) and (3.11) for copper, silver and Hastelloy, respectively  $\rho_{Cu}$ ,  $\rho_{Ag}$ , and  $\rho_{Hast}$  [146]–[148],

$$\rho_{Cu}(T) = 6.85 \times 10^{-11} \cdot T - 3.30 \times 10^{-9} \quad (3.9)$$

$$\rho_{Ag}(T) = 6.11 \times 10^{-11} \cdot T - 1.97 \times 10^{-9} \quad (3.10)$$

$$\rho_{Hast}(T) = 1.17 \times 10^{-10} \cdot T + 1.25 \times 10^{-6} \quad (3.11)$$

In (3.9) to (3.11) SI units are used, so resistivity comes in  $\Omega \cdot m$ . These temperature dependences are graphically illustrated in Figure 3.13.

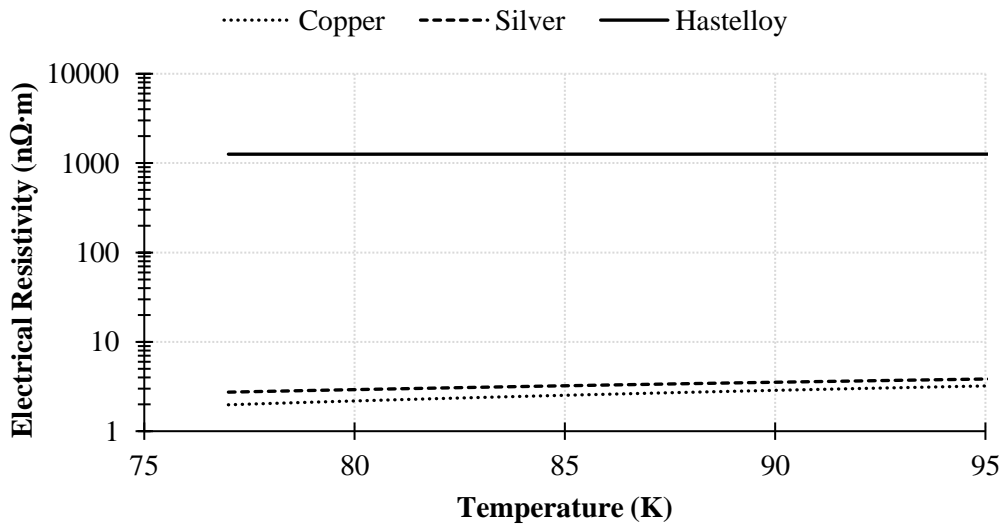


Figure 3.13 – Resistivity of layers as a function of temperature.

### 3.2.1.3 Thermal Conductivity

The thermal conductivity of YBCO layer,  $k_{YBCO}$ , is an extremely low value [149]. It is considered constant, as expressed in (3.12). Considering the remaining layers, the modelled thermal conductivities as a function of temperature are expressed in (3.13), (3.14) and (3.15) for copper, silver and Hastelloy, respectively  $k_{Cu}$ ,  $k_{Ag}$ , and  $k_{Hast}$  [146], [148], [150]. In (3.12) to (3.15) all values are given in  $W \cdot m^{-1} \cdot K^{-1}$ ,

$$k_{YBCO} = 5 \quad (3.12)$$

$$k_{Cu}(T) = 416.3 - 5.904 \times 10^{-2} \cdot T + \frac{7.087 \times 10^7}{T^3} \quad (3.13)$$

$$k_{Ag}(T) = 431.4 - 1.817 \times 10^{-2} \cdot T + \frac{1.708 \times 10^7}{T^3} \quad (3.14)$$

$$k_{Hast}(T) = 0.0238 \cdot T + 5.896 \quad (3.15)$$

These temperature dependences are graphically illustrated in Figure 3.14.

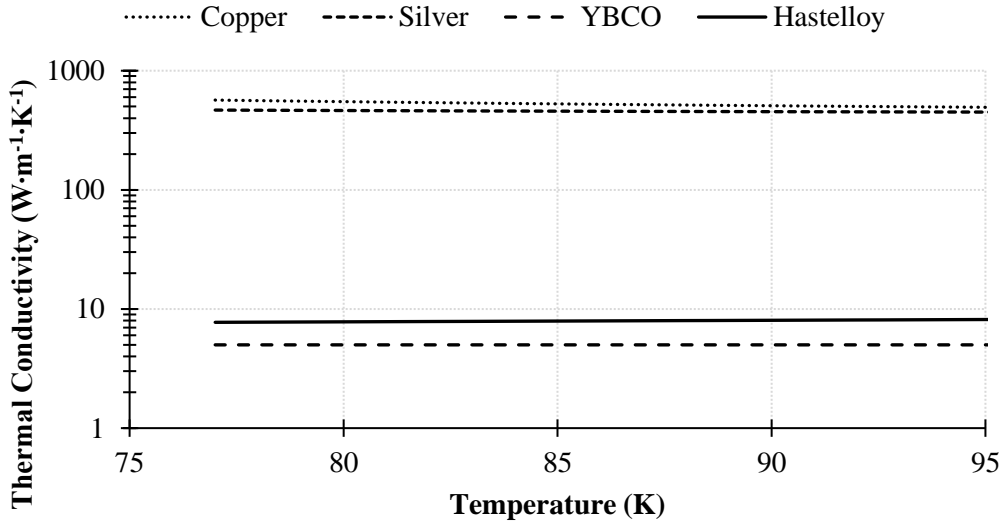


Figure 3.14 – Thermal conductivity of layers as a function of temperature.

### 3.2.1.4 Volumetric Heat Capacity

The modelled volumetric heat capacities as a function of temperature are given by (3.16), (3.17), (3.18) and (3.19) for YBCO, copper, silver and Hastelloy layers, respectively  $C_{YBCO}$ ,  $C_{Cu}$ ,  $C_{Ag}$ , and  $C_{Hast}$  [148], [151], [152]. In (3.16) to (3.19) all values are given in  $J \cdot m^{-3} \cdot K^{-1}$ ,

$$C_{YBCO}(T) = 4.051 \times 10^6 - 1.729 \times 10^8 \cdot T^{-0.9747} \quad (3.16)$$

$$C_{Cu}(T) = -9.463 \times 10^7 \cdot T^{-0.8292} + 4.279 \times 10^6 \quad (3.17)$$

$$C_{Ag}(T) = -1.983 \times 10^8 \cdot T^{-1.23} + 2.643 \times 10^6 \quad (3.18)$$

$$C_{Hast}(T) = 4.140 \times 10^6 + \frac{5.920 \times 10^5 - 4.140 \times 10^6}{1 + \left(\frac{T}{120.42}\right)^{2.39}} \quad (3.19)$$

These temperature dependences are graphically illustrated in Figure 3.15.

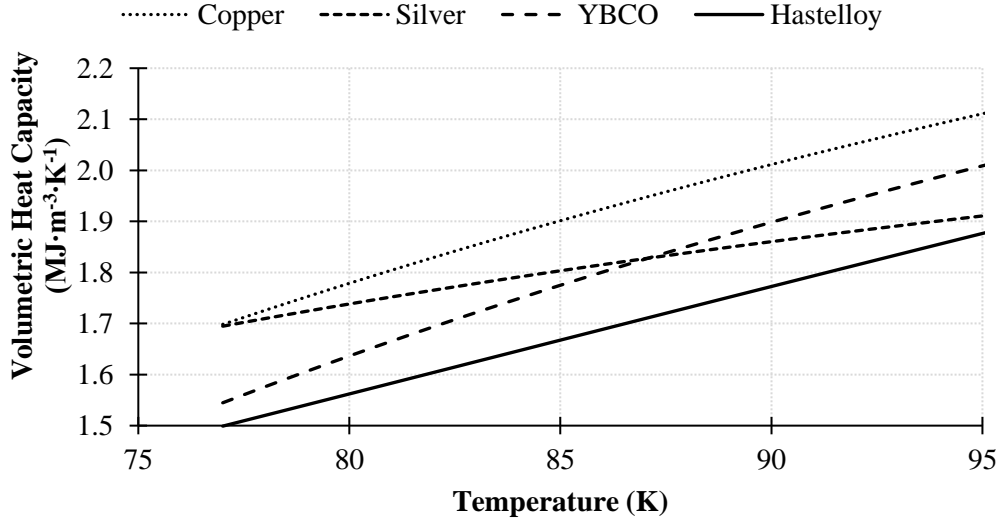


Figure 3.15 – Volumetric heat capacity of layers as a function of temperature.

### 3.2.1.5 Convective Heat Transfer

The heat flow between the surface of the coated conductor and liquid nitrogen is essentially governed by convection. The heat dissipation is very dependent on stationary and transient regimes. Four types of thermal exchange can occur, namely, convective boiling, nucleation boiling, transition boiling, and film boiling [42]. The convective heat transfer coefficient as a function of the temperature difference was described in [42], [153] and incorporated in the simulation models used in this work, as depicted in Figure 3.16. The equation (3.20) describes the temperature dependency of the coefficient,

$$h_{Conv}(\Delta T) = \begin{cases} 2000 & , \text{if } \Delta T \leq 2 \text{ K} \\ \frac{h_0 + h_1 \cdot \Delta T + h_2 \cdot \Delta T^2 + h_3 \cdot \Delta T^3 + h_4 \cdot \Delta T^4 + h_5 \cdot \Delta T^5}{\Delta T} & , \text{if } 2 \text{ K} < \Delta T < 25 \text{ K} \\ 300 & , \text{if } \Delta T \geq 25 \text{ K} \end{cases} \quad (3.20)$$

where  $h_0$ ,  $h_1$ ,  $h_2$ ,  $h_3$ ,  $h_4$  and  $h_5$  are fitting parameters whose values are presented in Table 3.5.

Table 3.5 – Parameters for calculation of the convective heat transfer coefficient.

<i>Parameter</i>	<i>Value</i>
$h_0$	$-1.893 \times 10^4$
$h_1$	$1.468 \times 10^4$
$h_2$	-2397
$h_3$	420.7
$h_4$	-25
$h_5$	0.4471

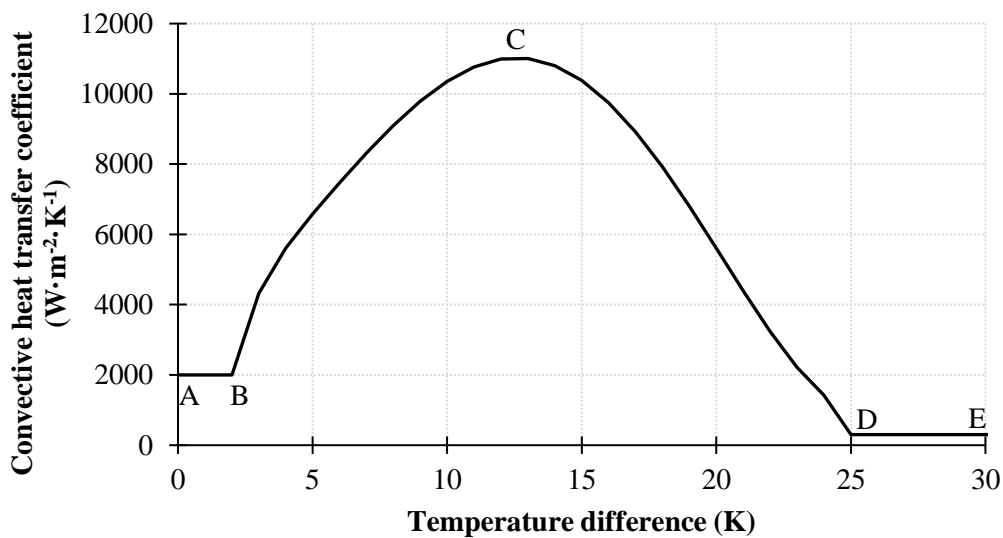


Figure 3.16 – Heat transfer coefficient as a function of temperature difference between the surface of superconducting tape and liquid nitrogen. A-B: Convective boiling. B-C: Nucleation boiling. C-D: Transition boiling. D-E: Film boiling. Adapted from [42].

In Figure 3.16, the region from A to B is governed by free convection, which occurs when the surface temperature of the tape is close to the boiling temperature of the liquid nitrogen. The region from B to C is characterised as nucleation boiling, in which there is an increase of convective heat transfer to liquid nitrogen causing the occurrence of vapour bubbles with origin on the tape surface. Between C and D, the transition boiling is characterised by a considerable degradation of heat exchange due to the emergence of large vapour near the tape surface area instead of liquid nitrogen. Lastly, the region from D to E, known as film boiling, is characterised as a critical stage of boiling in which the generated vapour dominates the heat transfer. The properties of the superconducting tape studied in this section are included in the model of the limiter, presented following.

### 3.2.2 Electromagnetic-Thermal Behaviour of the Limiter

The electromagnetic-thermal behaviour of the limiter, particularly in the over-critical current regime, is modelled by means of two distinct methodologies, based on the characteristics of the constitutive parts of the limiter. The first model, originally proposed in [96], is based on the maximum hysteresis loop of the limiter, in order to determine the line current and primary linked flux. This methodology was already implemented in Simulink [101] in order to allow simulating distinct and complex grids. The second model is based on the relationship between the primary magnetomotive force, the short-circuit time, and the current in the superconducting ring, in order to determine the latter.

#### 3.2.2.1 Maximum Hysteresis Loop

The first step of this methodology is the determination of the characteristic of the primary in the absence of the superconducting element. This is carried out by integrating the voltage induced in an auxiliary coil wound around the core, which is function of an excitation current from the primary winding, as depicted in Figure 3.17 [154]. The result of the integration provides an image of the primary linked flux, enabling to relate it to the line current.

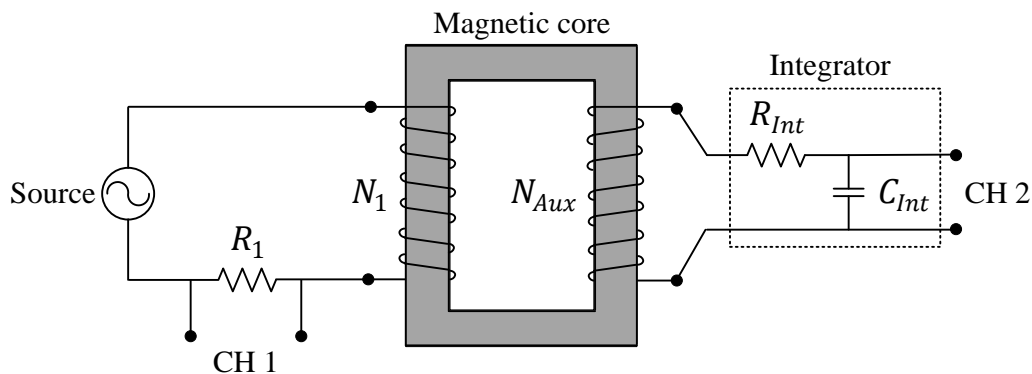


Figure 3.17 – Diagram of the experimental assembly for the determination of the characteristic of the primary in the absence of the superconducting element. In order to take into account the leakage reactance, the auxiliary winding is wound around the primary, therefore in the same limb.

A sinusoidal voltage of 50 Hz is injected in the primary by a voltage source and the voltage drop at the terminals of the auxiliary coil is integrated by a simple passive first-order integrator circuit with a time constant<sup>6</sup> of 1 s. In order to take into account the leakage reactance, the auxiliary winding is wound around the primary. The integrated voltage can be related to the primary linked flux by the relationship<sup>7</sup> (3.21),

<sup>6</sup> Values of resistance,  $R_{Int}$ , and capacitance,  $C_{Int}$ , are 1 M $\Omega$  and 1  $\mu$ F, respectively.

<sup>7</sup> The time constant is required to be much higher than  $1/(2 \cdot \pi \cdot f)$ , where  $f$  is the sine wave frequency.

$$\psi_0(t) = \frac{N_1}{N_{Aux}} \cdot \int u_{Aux} \cdot dt \quad (3.21)$$

where  $t$  is the time and  $N_1$  is the number of turns of the primary.  $N_{Aux}$  and  $u_{Aux}$  are the number of turns and voltage drop of the auxiliary coil, respectively. Thus, the primary linked flux is simply calculated from the multiplication between the constant relation  $N_1/N_{Aux}$  and the voltage at the terminals of the integrator.

The  $\psi_0(i_L)$  characteristic can be converted in the standard relationship between magnetic field,  $H$ , and flux density,  $B$ . Assuming uniformity of  $H$  and  $B$  in the core, the excitation current,  $i_L$ , is proportional to the line integral of the magnetic field, given by the Ampère's law (3.22),

$$H = \frac{N_1 \cdot i_L}{l} \quad (3.22)$$

where  $l$  is the mean magnetic path length.

On the other hand, the primary linked flux is proportional to the surface integration of the flux density in the core section, given by (3.23),

$$B = \frac{\psi_0}{N_1 \cdot S} \quad (3.23)$$

where  $S$  is the cross section of the magnetic core.

For simulation purposes, the primary linked flux is modelled according to (3.24),

$$\psi_0(i_L) = a_0 \cdot N_1 \cdot i_L + \frac{b_0 \cdot N_1 \cdot i_L}{c_0 + d_0 \cdot N_1 \cdot |i_L|} \quad (3.24)$$

where parameters  $a_0$ ,  $b_0$ ,  $c_0$  and  $d_0$  are determined by fitting from measurements, with *cftool* toolbox from Matlab [96]. Their values are presented in Table 3.6. A comparison between measured and modelled results is shown in Figure 3.18.

Table 3.6 – Parameters for defining the iron core characteristic.

<i>Parameter</i>	<i>Value</i>
$a_0$	$9.014 \times 10^{-12}$ H
$b_0$	0.912 H
$c_0$	1166
$d_0$	$1.824 \text{ A}^{-1}$
$N_1$	60 turns

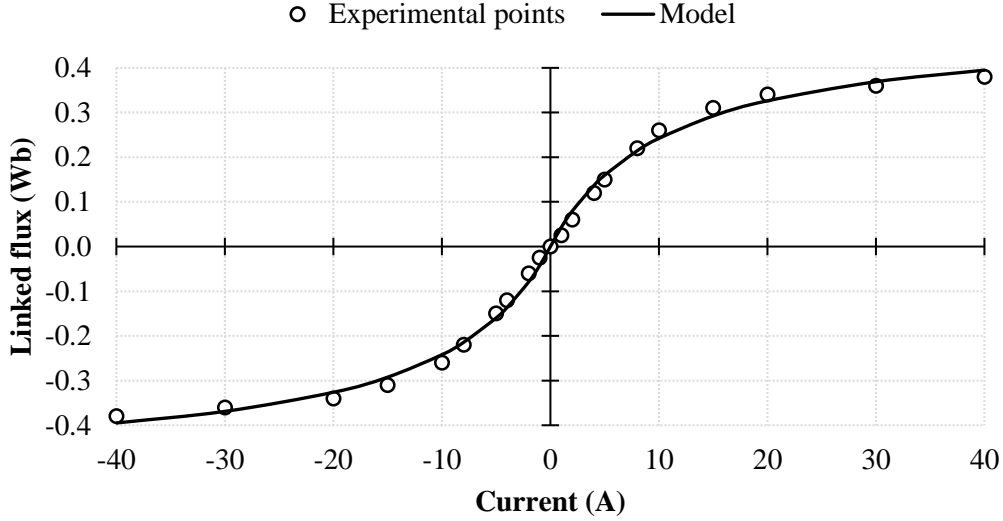


Figure 3.18 – Characteristic of the primary in the absence of the superconducting element.

The dynamical determination of the electromagnetic behaviour of the FCL is based on a maximum hysteresis loop that limits the excursion in the plan of line current and primary linked flux of the device. This maximum loop was previously illustrated in Figure 2.17. The excursion of the operating point of the limiter in the plan of line current and primary linked flux will be either determined by grid impedance, when inside the loop, either limited by ascending or descending branches of the latter. The detailed description of the methodology can be found in [99].

The ascending,  $\lambda_a$ , and descending,  $\lambda_d$ , branches of the loop are determined by (3.25),

$$\begin{aligned}\lambda_a(i_L) &= \psi_0(i_L - f(i_L)) \\ \lambda_d(i_L) &= \psi_0(i_L + f(i_L))\end{aligned}\quad (3.25)$$

where the auxiliary function  $f$  is defined by (3.26),

$$f(i_L) = \frac{I_{HTS}^*/N_1}{\cos\left(\frac{\pi}{2} \cdot \frac{I_{HTS}^*/N_1}{I_{SC}}\right)} \cdot \cos\left(\frac{\pi}{2} \cdot \frac{i_L}{I_{SC}}\right)\quad (3.26)$$

where  $I_{SC}$  is the short-circuit current of the grid and  $I_{HTS}^*$  is the maximum induced current in the superconducting element for which line current is not limited. The former depends on the grid and is generally calculated by circuit analysis. The determination of the latter is based on experimental measurements of the maximum induced current in the tape as a function of a primary winding in the absence of magnetic core.

To evaluate the maximum induced current in the superconducting ring for which line current is not limited,  $I_{HTS}^*$ , this is inserted inside the primary, without the iron core, and the former is supplied with sinusoidal current of different amplitudes [100]. The induced current in the superconductor is measured

using a Rogowski coil. The absence of a magnetic core is regarded to avoid saturation. In Figure 3.19, the electrical diagram and experimental apparatus are presented.

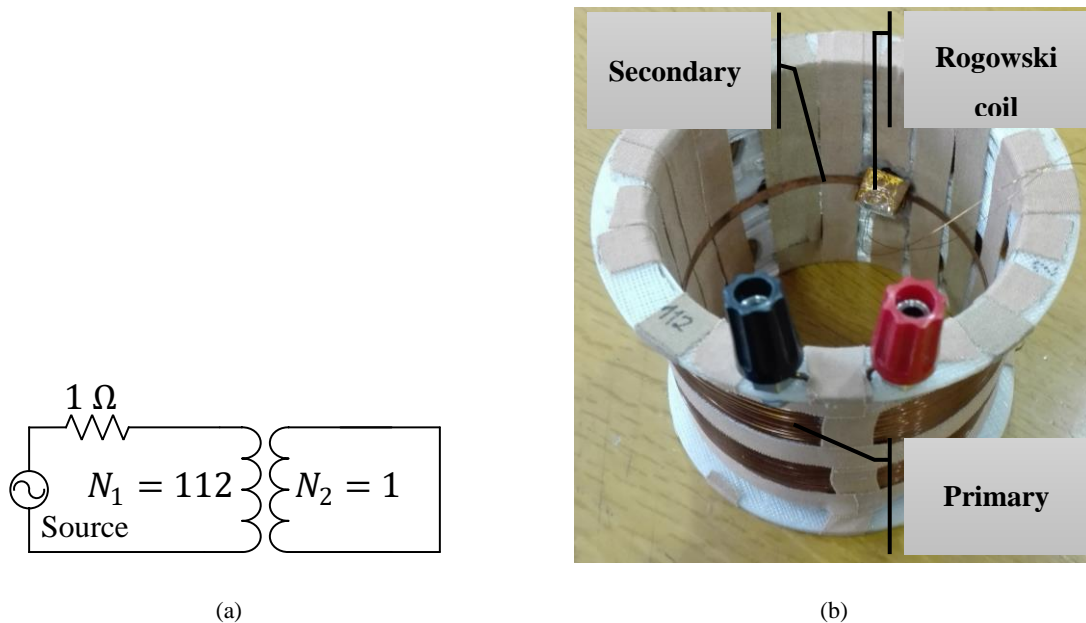


Figure 3.19 – Measurement of the maximum amplitude of the current in the superconducting ring (a) Equivalent circuit. (b) Experimental apparatus.

It is observed that current in the secondary saturates nearly on the same values for different amplitudes of magnetomotive force. Several tests at different amplitudes of primary magnetomotive force have been performed. Despite the growing primary magnetomotive force, up to 4240 A·t, the superconducting current does not increase more than 182 A·t. This latter value corresponds to the maximum secondary current that opposes the primary magnetomotive force, resulting in negligible voltage drop at the terminals of the primary. Since the superconducting ring is composed of only one turn, the maximum induced current in the superconducting element for which current limitation is not performed,  $I_{HTS}^*$ , is 182 A. These results are presented in Figure 3.20.

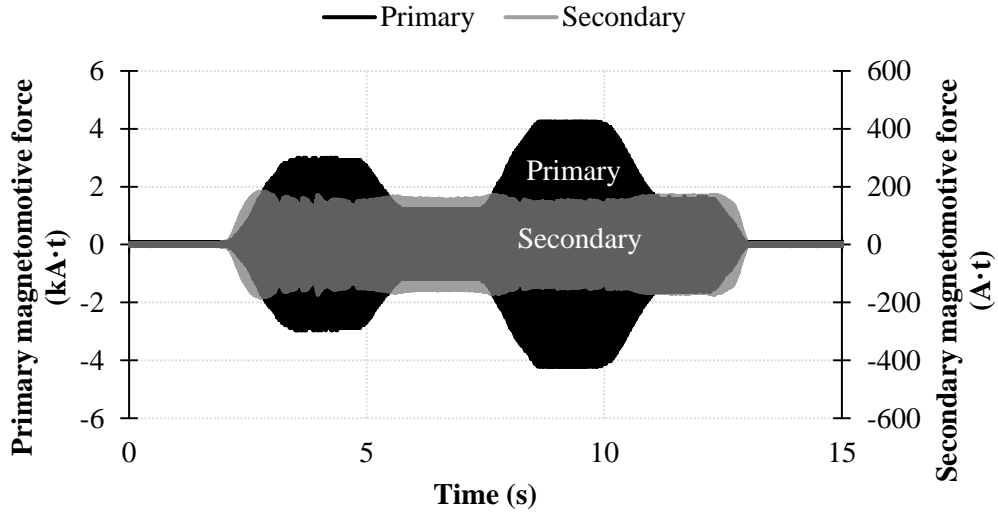


Figure 3.20 – Measured magnetomotive force in the primary and induced current in the secondary as a function of time in the absence of magnetic core. Current in the secondary saturates nearly on the same values for different amplitudes of magnetomotive forces.

Applying the value of the maximum induced current,  $I_{HTS}^*$ , to (3.25), the maximum hysteresis loop of the device is represented in Figure 3.21. It is expected that operation regimes are inside or, in extreme cases, in the boundaries of the loop.

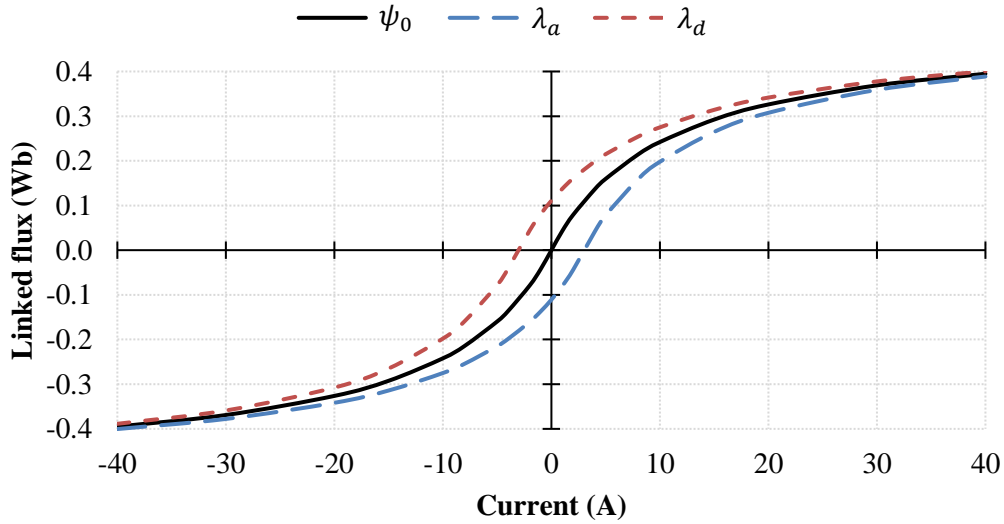


Figure 3.21 – Maximum hysteresis loop of the fault current limiter.

### 3.2.2.2 Current in the Superconducting Ring During Short-circuit Faults

The modelled dynamical behaviour of the induced currents in the implemented superconducting ring, when operating as a part of the fault current limiter, is based on the empirical knowledge of its induced current excursion as a function of short-circuit time and primary magnetomotive force. The magnetomotive force is calculated from a Hall probe whilst the current in the superconducting ring is measured with a Rogowski coil. Further details regarding this experimental procedure are presented in Chapter 5.

On the one hand, the relationship between the superconducting current amplitude and the primary magnetomotive force amplitude, during short-circuit condition, is not linear. This behaviour, obtained experimentally, is presented in Figure 3.22. These results show the maximum current amplitude in the superconducting ring as a function of the maximum primary magnetomotive force amplitude in the first period of a short-circuit. Each point corresponds to an experiment with different short-circuit levels. The peak current in the superconducting tape easily reaches 3-4 times the critical current defined at the nominal temperature, which is in accordance to [87]. On the other hand, during the short-circuit, the amplitude of the induced current in superconductor decreases as the time of short-circuit increases to values close to its critical current.

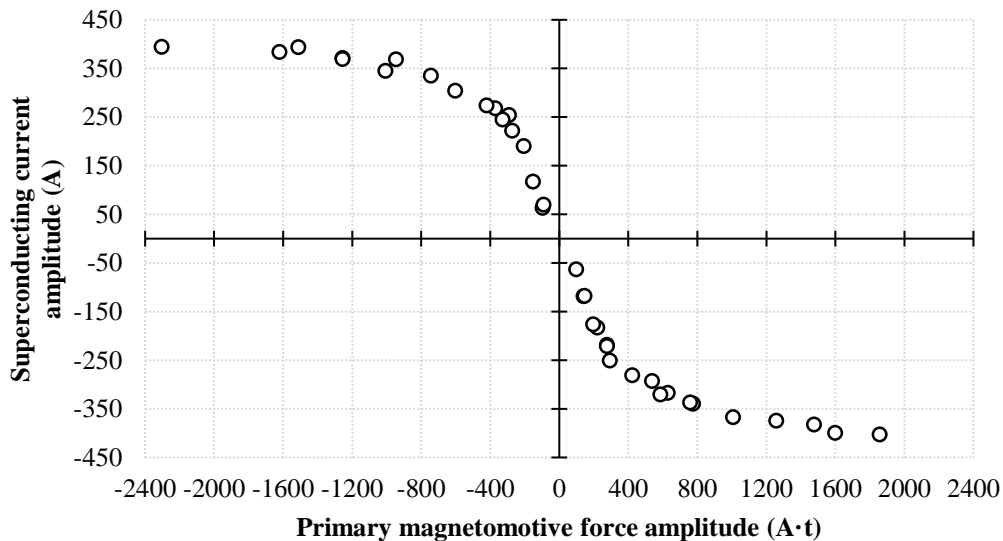


Figure 3.22 – Maximum current amplitude in the superconducting ring as a function of the maximum primary magnetomotive force amplitude in the first period of a short-circuit. Each point corresponds to an experiment with different short-circuit levels.

In order to model the dynamical behaviour of the current in the superconducting ring, during fault operation,  $i_{2,F}$ , the relationship between the current and the primary magnetomotive force are divided into seven segments, as illustrated in Figure 3.23. These behaviours are analytically modelled by (3.27),

$$i_{2,F}(N_1 \cdot i_L, t_{SC}) = \begin{cases} I_{2,p}(t_{SC}) \cdot \left[ \left( \frac{H-G}{C-D} \right) \cdot N_1 \cdot i_L + \left( H + D \cdot \left( \frac{H-G}{C-D} \right) \right) \right] & , \text{if } N_1 \cdot i_L \leq -C \\ I_{2,p}(t_{SC}) \cdot \left[ \left( \frac{G-F}{B-C} \right) \cdot N_1 \cdot i_L + \left( G + C \cdot \left( \frac{G-F}{B-C} \right) \right) \right] & , \text{if } -C < N_1 \cdot i_L \leq -B \\ I_{2,p}(t_{SC}) \cdot \left[ \left( \frac{F-E}{A-B} \right) \cdot N_1 \cdot i_L + \left( F + B \cdot \left( \frac{F-E}{A-B} \right) \right) \right] & , \text{if } -B < N_1 \cdot i_L \leq -A \\ I_{2,p}(t_{SC}) \cdot \left( -\frac{E}{A} \right) \cdot N_1 \cdot i_L & , \text{if } -A < N_1 \cdot i_L \leq A \\ I_{2,p}(t_{SC}) \cdot \left[ \left( \frac{F-E}{A-B} \right) \cdot N_1 \cdot i_L - \left( E + A \cdot \left( \frac{F-E}{A-B} \right) \right) \right] & , \text{if } A < N_1 \cdot i_L \leq B \\ I_{2,p}(t_{SC}) \cdot \left[ \left( \frac{G-F}{B-C} \right) \cdot N_1 \cdot i_L - \left( F + B \cdot \left( \frac{G-F}{B-C} \right) \right) \right] & , \text{if } B < N_1 \cdot i_L \leq C \\ I_{2,p}(t_{SC}) \cdot \left[ \left( \frac{H-G}{C-D} \right) \cdot N_1 \cdot i_L - \left( G + C \cdot \left( \frac{H-G}{C-D} \right) \right) \right] & , \text{if } N_1 \cdot i_L > C \end{cases} \quad (3.27)$$

where the constants  $A$ ,  $B$ ,  $C$  and  $D$  are magnetomotive force amplitudes obtained by fitting from measurements. The parameters  $E$ ,  $F$ ,  $G$  and  $H$ , also obtained by fitting from measurements, are multiplication constants of the maximum amplitude of the superconducting current,  $I_{2,p}$ , as a function of the short-circuit time,  $t_{SC}$ . This fitting is carried out with *cfTool* toolbox from Matlab. Their values are presented in Table 3.7. Please note that when the primary magnetomotive force grows positively (negatively), the superconducting current grows negatively (positively).

In normal operation, since the magnetomotive force amplitude is less or equal to the critical current, the current in the superconducting secondary,  $i_{2,N}$ , is inversely proportional to the magnetomotive force, given by (3.28),

$$i_{2,N}(N_1 \cdot i_L) = -N_1 \cdot i_L \quad (3.28)$$

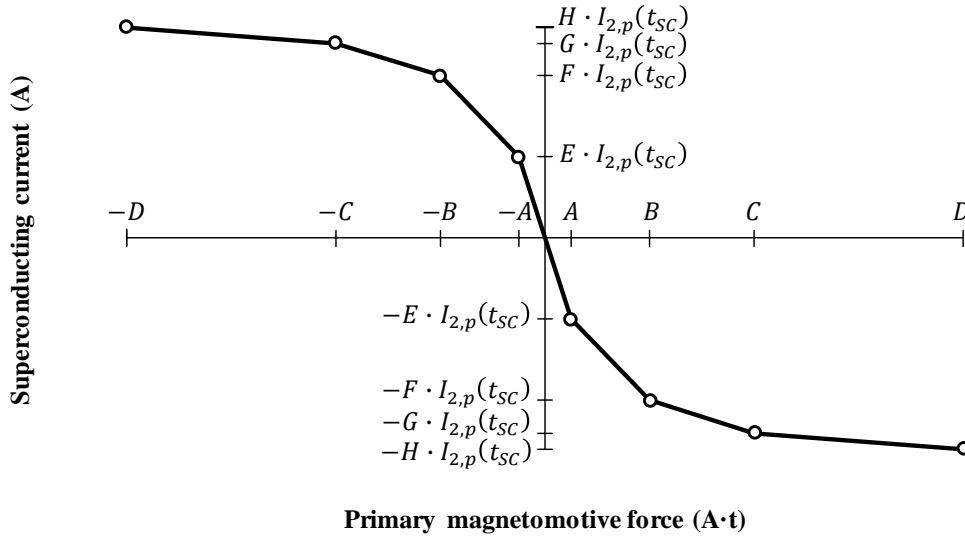


Figure 3.23 – Current in the superconducting coated conductor as a function of the magnetomotive force developed in the primary.

Table 3.7 – Fitting constants for the temperature dependency of current in the coated conductor.

<i>Parameter</i>	<i>Value</i>
<i>A</i>	293 A·t
<i>B</i>	585 A·t
<i>C</i>	1597 A·t
<i>D</i>	2304 A·t
<i>E</i>	0.628
<i>F</i>	0.844
<i>G</i>	1.026
<i>H</i>	1.051

The parameter  $I_{2,p}$ , is a correction coefficient for the amplitude of the current as a function of short-circuit time. This parameter is modelled as (3.29),

$$I_{2,p}(t_{SC}) = I_o + I_{p1} \cdot e^{-t_{SC}/\tau_1} + I_{p2} \cdot e^{-t_{SC}/\tau_2} \quad (3.29)$$

where  $I_o$ ,  $I_{p1}$ ,  $I_{p2}$ ,  $\tau_1$  and  $\tau_2$  are fitting parameters obtained from measurements. The variable  $t_{SC}$  is the short-circuit time. This function is obtained by the best fitting to experimental data using *cftool* toolbox. As fitting options, the nonlinear least squares method and Levenberg-Marquardt algorithm are used.

Since experimental measurements of the induced currents in this specific HTS tape are necessary, a lookup table with those experimental data can also be employed instead of a fitted function. The choice for a fitted function results in a simpler implementation of the simulation tool.

The induced current in the superconducting ring as a function of the short-circuit time during operation of the FCL in test grid was experimentally measured for five different scenarios, with prospective line currents of 47.5 A, 54.0 A, 60.5 A, 67.0 A and 73.5 A, as depicted in Figure 3.24. The constitutive parts of the FCL used for this measurement, namely magnetic core, primary and secondary have been presented in section 3.1. To measure the induced currents, a Rogowski coil has been used. Details concerning this current sensor are presented in section 5.1.

From the experimental results, the amplitude of the induced currents in secondary is higher as the prospective line current grows. However, the induced currents decay to similar values as the short-circuit time grows among the different tested scenarios. The constants that fit the model (3.29) are presented in Table 3.8. These values were achieved from the case in which the maximum short-circuit current was applied. The results of the model are also presented in Figure 3.24.

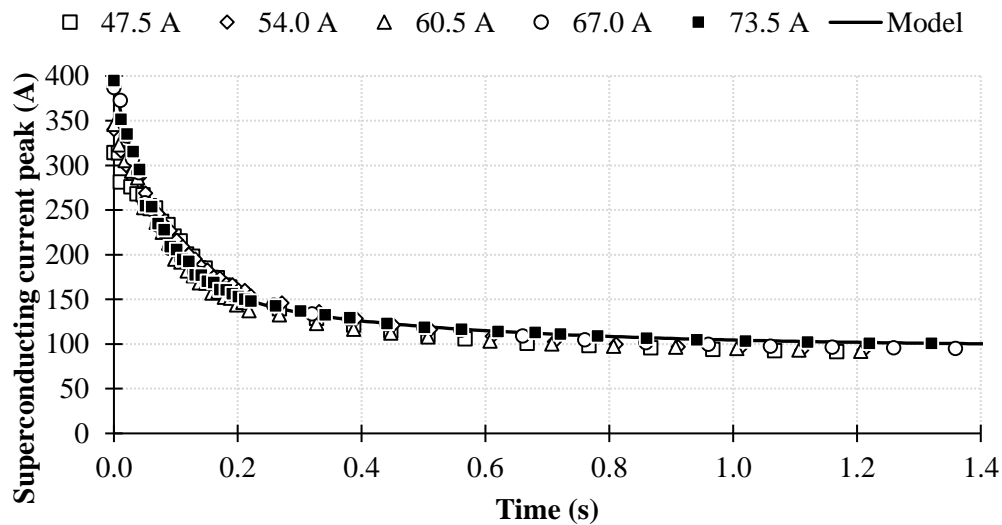


Figure 3.24 – Peak current in the superconducting ring as a function of short-circuit time for five different cases of prospective line currents.

Table 3.8 – Fitting constants.

<i>Parameter</i>	<i>Value</i>
$I_o$	97.7 A
$I_{p_1}$	70.4 A
$\tau_1$	0.42770 s
$I_{p_2}$	227.0 A
$\tau_2$	0.08776 s

This methodology is compared to experimental results in Figure 3.25. In the linear region, a good approximation is observed. As the primary magnetomotive force increases, the superconducting current tends to saturate, and results are not so accurate. Nevertheless, a good approximation to the maximum amplitudes during short-circuits are achieved.

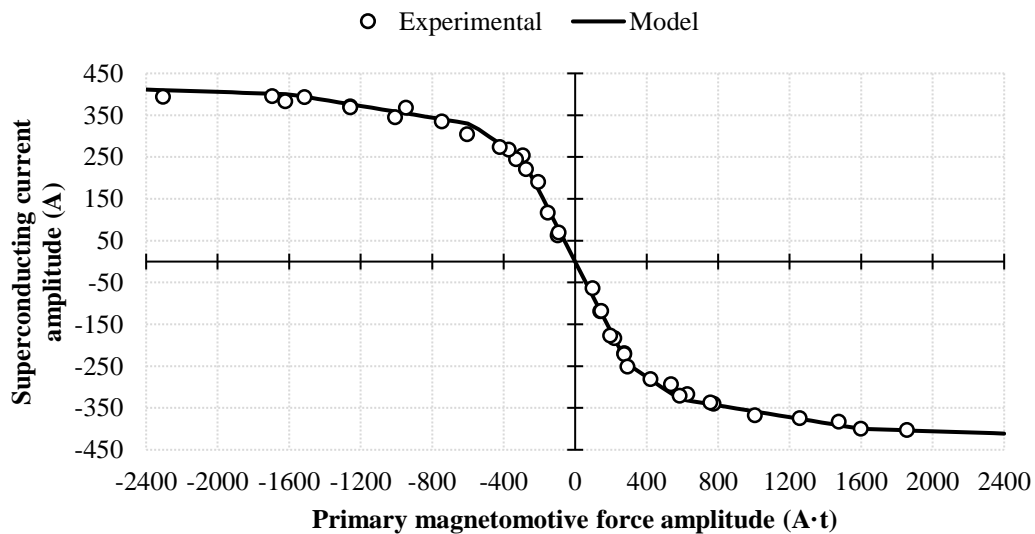


Figure 3.25 – Comparison between the empirical model of the current amplitude in the superconducting ring as a function of the primary magnetomotive force amplitude and experimental results, occurring in the first cycle of the short-circuit.

### 3.3 Summary

In this chapter, the constitutive parts of the inductive type FCL, i.e. magnetic core, primary, and HTS secondary, have been presented and their properties addressed.

The HTS secondary is built by commercial SuperPower SCS4050 2G HTS tape in the form of a short-circuited ring. To build such ring and reduce contact resistance, copper etchant has been applied on the surfaces of the 2G tape segments to be joined. Copper has been successfully removed from the tape after 20 minutes inside etchant, as observed in scanning electron microscopies and x-ray spectroscopies. In the soldering procedure of 2G tape segments, a bridge-type joint has been implemented. In this procedure, low melting point solder paste (220 °C) was applied between the surfaces to be joined and a stainless-steel holder was built to ease the manufacturing of such joints.

With the purpose of simulating the thermal behaviour of this superconducting tape (composed of copper, silver, Hastelloy and YBCO layers), models of the critical current density and  $n$ -value of YBCO layer as well as models describing the electrical resistivity, thermal conductivity, heat capacity and convective heat transfer, as a function of temperature, of copper, silver, Hastelloy and YBCO layers have been presented and discussed.

Lastly, to predict the behaviour of the designed limiter operating in electrical grids, a methodology based on the maximum hysteresis loop of the device has been used to determine the line current and primary linked flux, whereas the induced current in the short-circuited HTS secondary is determined from a model based on the empirical knowledge of its induced current excursion as a function of short-circuit time duration and primary magnetomotive force.





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## *Simulation of the Inductive FCL*

In order to simulate the dynamical behaviour of the limiter, both electromagnetic and thermal phenomena during transient states are considered. The reverse engineering methodology based on the electromagnetic behaviour of the constitutive parts of the FCL, developed in a previous work [96], was implemented and the influence of thermal phenomena was added in order to better predict the performance of the device. To implement this methodology, Simulink software from Matlab, widely used for simulations of electrical systems [155]–[157], is employed. The analysis was performed using some specific constitutive parts. Nevertheless, the presented methods can be adapted to any configuration of constitutive parts, only depending on modelling of those parts.

### **4.1 Methodology**

Using Simscape Power Systems toolbox from Simulink, a current limiting block was developed and inserted in an electrical circuit for simulation purposes, as depicted in Figure 4.1. This simulation block, implemented in a previous work [158], predicts the electromagnetic behaviour of the limiter, namely the line current and primary linked flux. The methodology implemented in the simulation block was previously validated with FEM simulations [96], [101]. In this work, the methodology is intended to be validated. Furthermore, the simulation tool is extended by including a block that predicts the current and the temperature in each layer of the superconducting tape.

The electromagnetic and thermal characteristics of the constitutive parts of the limiter are simulated at each time step according to the models presented in the previous chapter, allowing to study the transient behaviour of the device. All simulations were carried out using the ode23S solver from Simulink, in continuous mode.

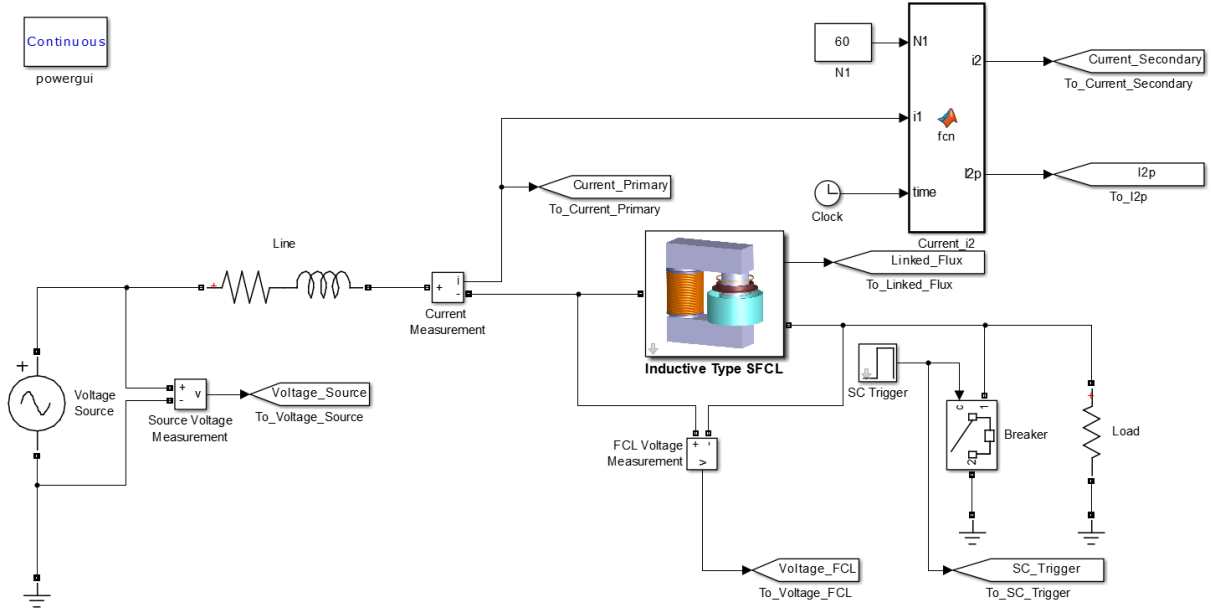


Figure 4.1 – Simulink simulation circuit.

#### 4.1.1 Determination of Limited Current

The determination of the limited current depends on the hysteresis loop of the device that relates primary linked flux,  $\psi_{FCL}$ , and line current,  $i_L$ . As presented previously in [96], the voltage across the terminals of the primary of the limiter is defined as (4.1),

$$u_{FCL} = \frac{d\psi_{FCL}}{dt} \quad (4.1)$$

Taking into account the ascending,  $\lambda_a$ , and descending,  $\lambda_d$ , branches expressed in (3.25), the dynamical behaviour of the limiter can be described as follows [101]:

- If  $i_L$  is increasing and  $\psi_{FCL}(i_L) > \lambda_a(i_L)$ , then  $\psi_{FCL}$  remains constant and  $u_{FCL}$  is zero. In this state, the device is invisible to the grid since the operation point is outside the ascending branch. The line current is only limited by grid impedance.
- If  $i_L$  is increasing and  $\psi_{FCL}$  intercepts the ascending branch,  $\lambda_a$ , then  $\psi_{FCL}(i_L) = \lambda_a(i_L)$ . The line current is limited by the developed voltage  $u_{FCL}$ .
- If  $i_L$  is decreasing and  $\psi_{FCL}(i_L) < \lambda_d(i_L)$ , then  $\psi_{FCL}$  remains constant and  $u_{FCL}$  is zero. In this state, the device is also invisible to the grid since the operation point is outside the descending branch. The line current is only limited by grid impedance.
- If  $i_L$  is decreasing and  $\psi_{FCL}$  intercepts the descending branch,  $\lambda_d$ , then  $\psi_{FCL}(i_L) = \lambda_d(i_L)$ . The line current is limited by the developed voltage  $u_{FCL}$ .

#### 4.1.1.1 Architecture of the Simulink Model

The architecture of the model, presented in Figure 4.2, is composed of three main blocks, whose functions are:

- **Logic block:** determines the operating point of the device according to the instant values of primary linked flux and line current. This block provides an input to the current control block specifying the operating point.
- **Limiting current determination block:** selects the branch of the maximum hysteresis loop ( $\lambda_a$  or  $\lambda_d$ ) to be related to  $\psi_{FCL}$ . In the case when  $|i_L| > I_{SC}$ ,  $\psi_0$  is chosen instead of the maximum branches. An input to the current control block is provided indicating the value of limited current.
- **Current control block:** depending on the input from the logic block, current can be limited by the device or by grid impedance, according to the aforementioned algorithm. A controlled current source is employed to limit, or not, the line current.

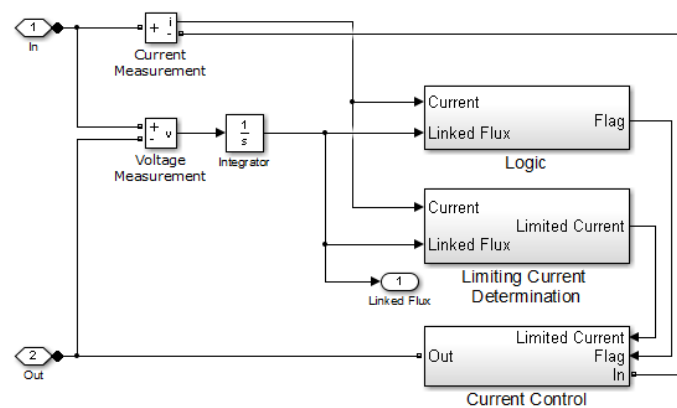


Figure 4.2 – Simulink FCL model architecture.

In this architecture, the line current is measured directly from the test grid by the native Current Measurement block from Simulink while the primary linked flux is integrated from the voltage drop at the terminals of the primary of the limiter, measured from the Voltage Measurement block from Simulink. Current and linked flux are inputs for the logic and limiting current determination blocks.

#### 4.1.1.2 Logic Block

The logic block, depicted in Figure 4.3, receives the primary linked flux and line current in order to determine the operation point of the device according to the previously presented algorithm. Depending on the operation point, a flag is used to specify such operating regime.

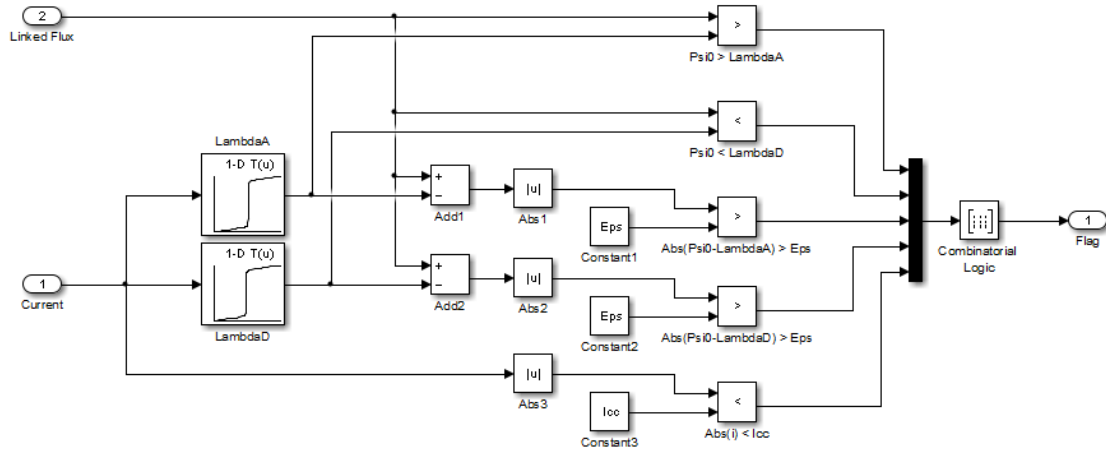


Figure 4.3 – Simulink logic block.

### 4.1.1.3 Limiting Current Determination Block

The limiting current determination block, whose architecture is presented in Figure 4.4, is based on the same principle as nonlinear inductances [159]. The line current to be imposed in the grid is determined from the linked flux by three lookup tables, corresponding to ascending,  $\lambda_a$ , and descending,  $\lambda_d$ , branches as well as the iron core characteristic,  $\psi_0$ . The chosen lookup table for current limitation is dependent on current evolution (if is increasing or decreasing) and exceedance (or not) beyond  $I_{SC}$ .

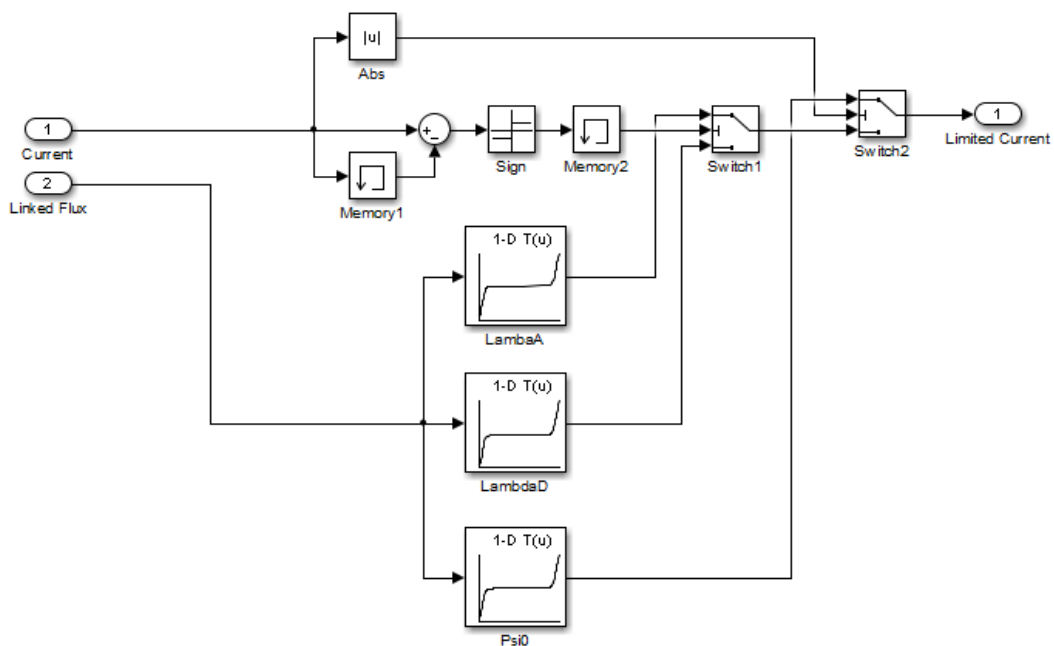


Figure 4.4 – Simulink limiting current determination block.

#### 4.1.1.4 Current Control Block

The current control block, whose constituent elements are presented in Figure 4.5, is controllable by a flag from the logic block that indicates the operating regime of the limiter. In the case of normal operation, the terminals of the limiter are short-circuited making it transparent to the grid under this regime. In fault condition, the current is imposed by a controlled current source that depends on the determined limited current from the limiting current determination block.

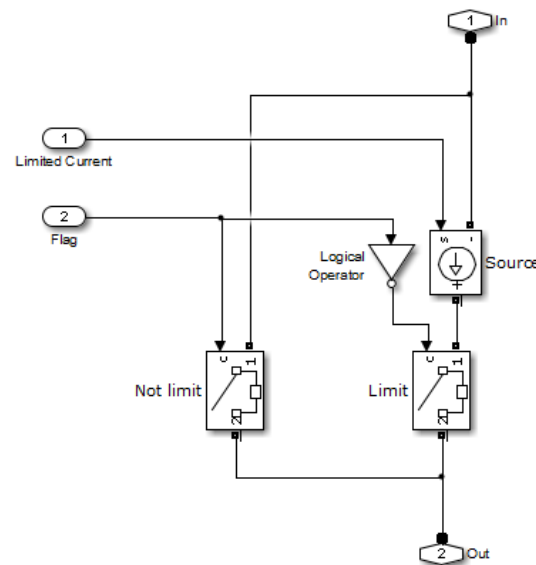


Figure 4.5 – Simulink current control block.

#### 4.1.2 Determination of Temperature

The determination of the temperature in each layer requires the knowledge of the induced current in the superconducting tape. The induced current is modelled as a current source and is in series with six resistors connected in parallel, as shown in Figure 4.6. These resistors represent the constituent layers of the tape, i.e. copper (inner and outer), silver (inner and outer), Hastelloy and YBCO. Thus, the current flowing in each layer is determined. This is implemented in Simulink. The contact resistance is omitted from the model. Relevant variables in the figure are:

- $i_2$ : induced current in the superconducting ring.
- $i_{Cu(i)}$ ,  $i_{Cu(o)}$ ,  $i_{Ag(i)}$ ,  $i_{Ag(o)}$ ,  $i_{Hast}$ ,  $i_{YBCO}$ : current in inner layer of copper, outer layer of copper, inner layer of silver, outer layer of silver, Hastelloy and YBCO, respectively.

- $R_{e,Cu(i)}$ ,  $R_{e,Cu(o)}$ ,  $R_{e,Ag(i)}$ ,  $R_{e,Ag(o)}$ ,  $R_{e,Hast}$ ,  $R_{e,YBCO}$ : electrical resistance of inner layer of copper, outer layer of copper, inner layer of silver, outer layer of silver, Hastelloy and YBCO, respectively.

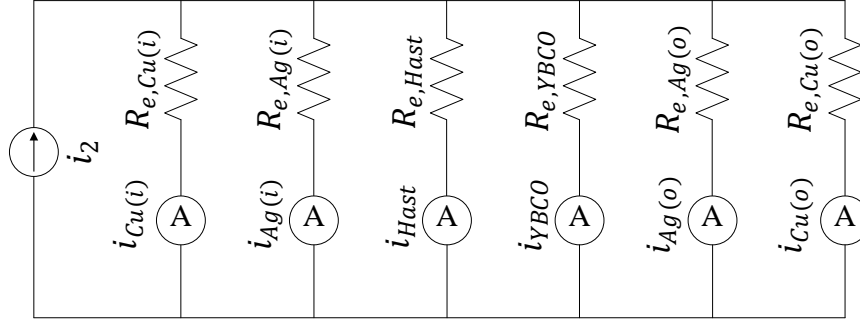


Figure 4.6 – Equivalent circuit for determination of the current in each layer.

Knowing the current in each layer, a thermal-electrical analogy, formerly applied to resistive and air-coil FCLs was adopted [88], [160]. The analogy, depicted in Figure 4.7, was implemented in Simulink. Relevant variables in the figure are:

- $R_{Conv(i)}$ ,  $R_{Conv(o)}$ : resistances representing the convective heat exchange with liquid nitrogen in inner and outer surfaces, respectively.
- $R_{t,Cu(i)}$ ,  $R_{t,Cu(o)}$ ,  $R_{t,Ag(i)}$ ,  $R_{t,Ag(o)}$ ,  $R_{t,Hast}$ ,  $R_{t,YBCO}$ : resistances representing heat conduction of inner layer of copper, outer layer of copper, inner layer of silver, outer layer of silver, Hastelloy and YBCO, respectively.
- $P_{Cu(i)}$ ,  $P_{Cu(o)}$ ,  $P_{Ag(i)}$ ,  $P_{Ag(o)}$ ,  $P_{Hast}$ ,  $P_{YBCO}$ : current source representing generated heat in inner layer of copper, outer layer of copper, inner layer of silver, outer layer of silver, Hastelloy and YBCO, respectively.
- $C_{Cu(i)}$ ,  $C_{Cu(o)}$ ,  $C_{Ag(i)}$ ,  $C_{Ag(o)}$ ,  $C_{Hast}$ ,  $C_{YBCO}$ : capacitance representing the volumetric heat capacity of inner layer of copper, outer layer of copper, inner layer of silver, outer layer of silver, Hastelloy and YBCO, respectively.
- $T_{Cu(i)}$ ,  $T_{Cu(o)}$ ,  $T_{Ag(i)}$ ,  $T_{Ag(o)}$ ,  $T_{Hast}$ ,  $T_{YBCO}$ : temperatures of inner layer of copper, outer layer of copper, inner layer of silver, outer layer of silver, Hastelloy and YBCO, respectively.

Previous variables are governed by (2.6) to (2.9). Temperatures are determined by the voltage drop between each point and the equivalent potential of the liquid nitrogen temperature,  $T_{LN_2}$ , corresponding to 77.3.

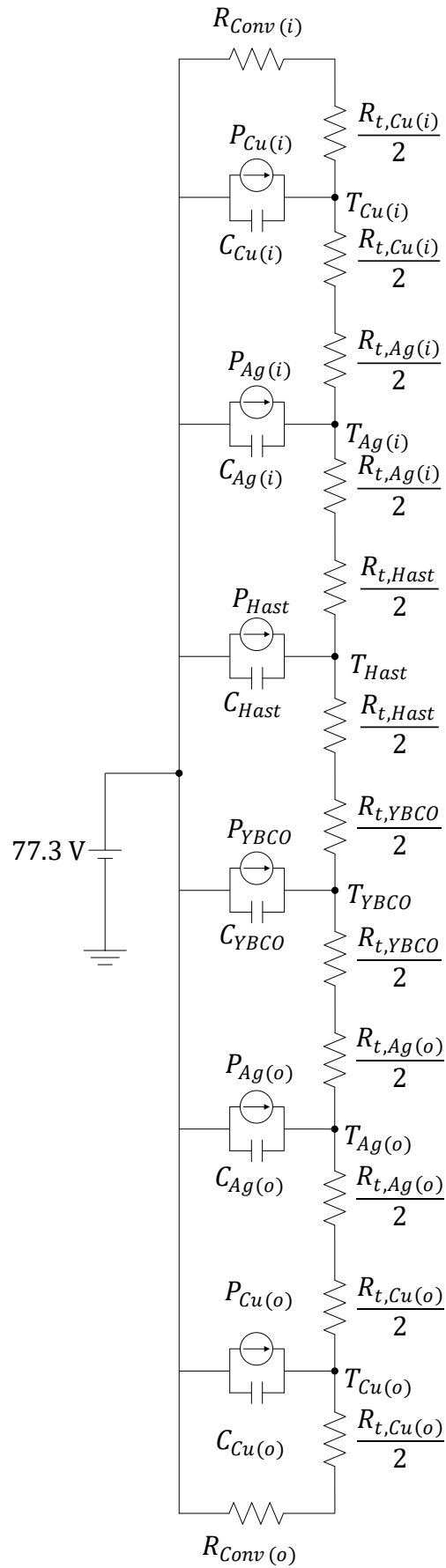


Figure 4.7 – Thermal-electrical analogy for thermal behaviour prediction [88].

### 4.1.3 Solution Routine

The flow diagram of the reverse engineering methodology is illustrated in Figure 4.8. In each time step, the dynamical electromagnetic state of the FCL is determined according to the maximum hysteresis loop methodology and the thermal condition of the superconducting element is calculated by means of the thermal-electrical analogy that provides the determination of the current in each layer of the superconducting secondary.

In the first part of the routine, the limited current is calculated from the primary linked flux. After, the current in the superconductor is determined based on the induced current from the primary magnetomotive force. Knowing the current in the superconducting element, the temperature is computed from the thermal-electrical analogy.

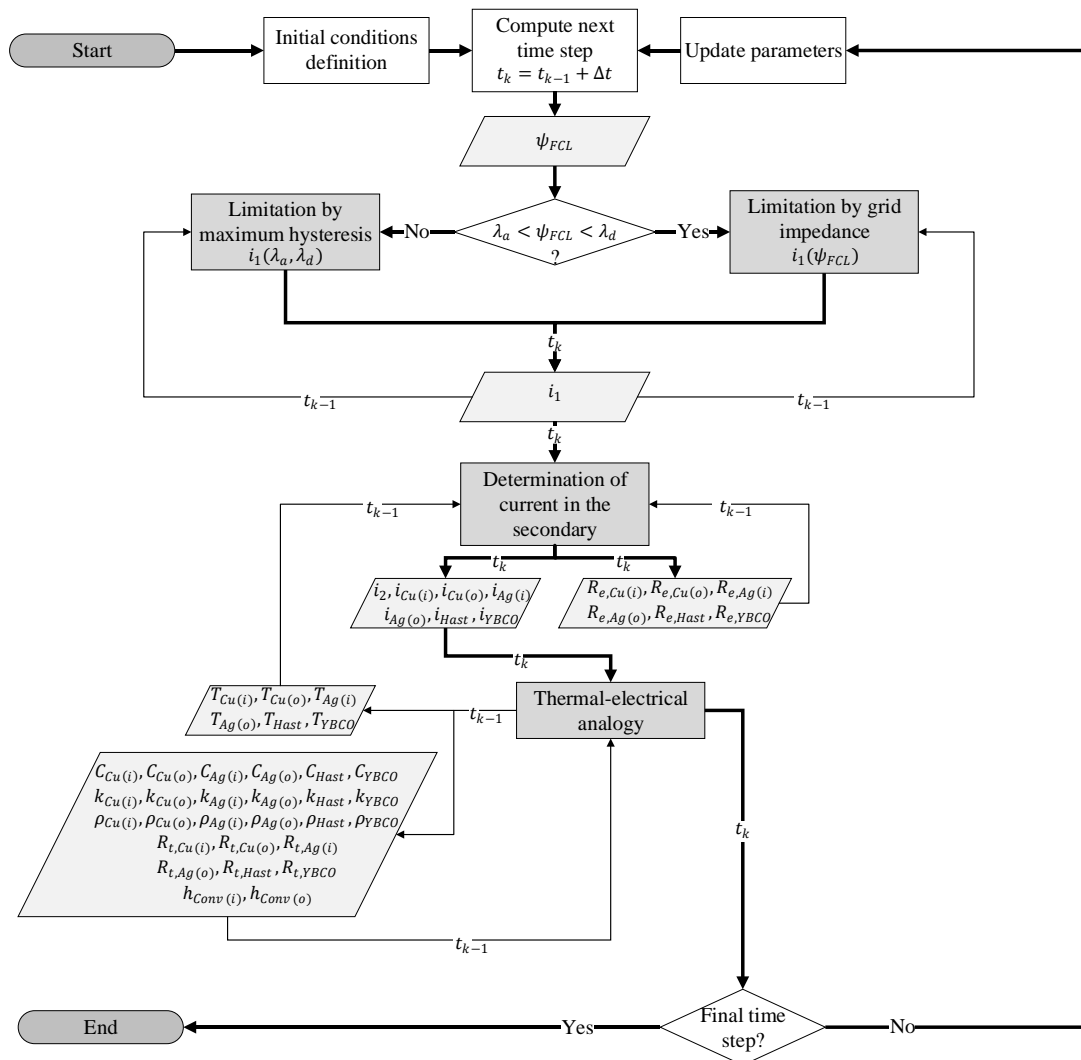


Figure 4.8 – Simultaneous electromagnetic and thermal computation flow diagram of the reverse engineering methodology. Thick arrows represent the main process cycle. Thin arrows correspond to input and output of the allocated variables.

## 4.2 Simulation Results

The device is simulated in different scenarios concerning different conditions in the test grid, depicted in Figure 4.9, namely the prospective short-circuit current controlled from the voltage source of the grid operating at 50 Hz. The values for the considered scenarios are presented in Table 4.1. A total time operation of 5 seconds is simulated. The load is short-circuited after 1 second of operation and cleared 2 seconds after this triggering.

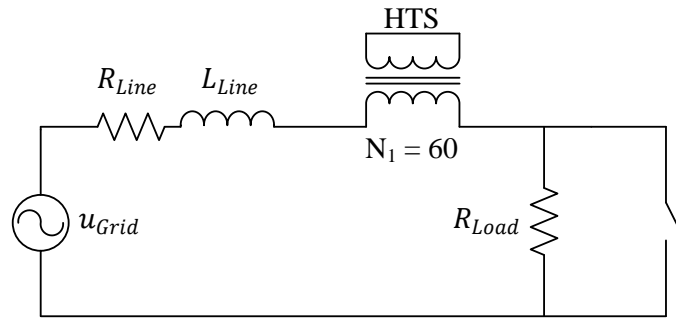


Figure 4.9 – Simulation grid with the FCL in series with the line.

Table 4.1 – Simulated scenarios concerning different conditions in the grid.

Scenario	Voltage source	Line impedance		Load resistance
1	73 V <sub>rms</sub>	1.4 Ω	5.3 mH	300 Ω
2	83 V <sub>rms</sub>			
3	93 V <sub>rms</sub>			
4	103 V <sub>rms</sub>			
5	113 V <sub>rms</sub>			

### 4.2.1 Line Current

In the first peak after fault, as the short-circuit level of the grid increases the current limiting capacity, defined as (4.2), decreases. This means that line current is not so effectively limited by the FCL in the presence of high prospective line currents,

$$I_{l\%} = \frac{i_p - i_l}{i_p} \times 100\% \quad (4.2)$$

where  $i_p$  and  $i_l$  are the prospective and limited current, respectively.

From simulated scenarios, the best case of limiting capacity is 45.1% and the worst is 29.9%. The results for all scenarios are presented in Table 4.2. After the first peak, these differences are minor but still relevant, as observed in Figure 4.10.

Table 4.2 – Limiting capacity in the first peak after fault.

<i>Scenario</i>	<i>Prospective current</i>	<i>Limited current (1<sup>st</sup> peak)</i>	<i>Current limiting capacity</i>
1	47.5 A	26.1 A	45.1%
2	54.0 A	31.9 A	40.9%
3	60.5 A	38.6 A	36.2%
4	67.0 A	45.1 A	32.7%
5	73.5 A	51.5 A	29.9%

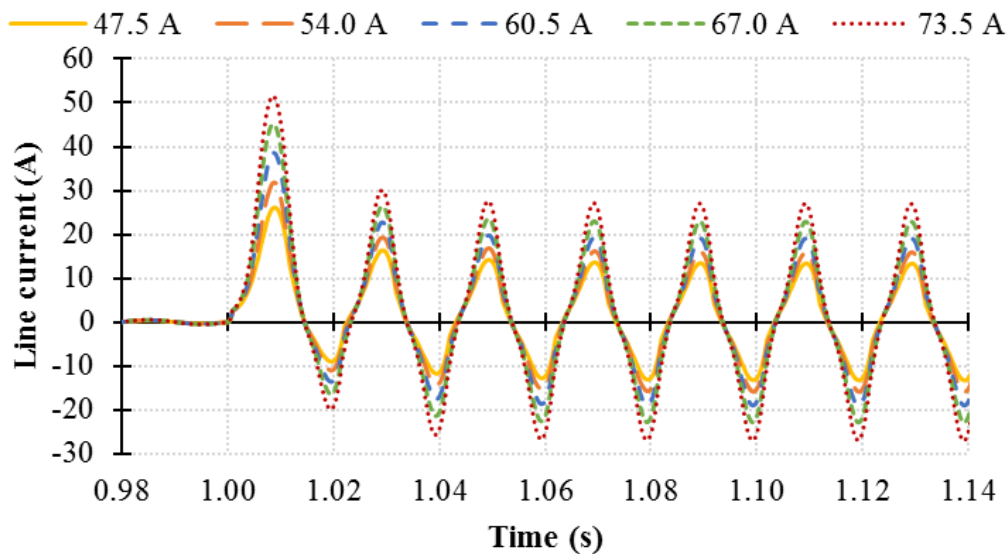


Figure 4.10 – Line current for different prospective line current scenarios.

#### 4.2.2 Primary Linked Flux

The results of the primary linked flux are depicted in Figure 4.11. Comparing all scenarios, the amplitude of the linked flux increases with the short-circuit level. However, differences are smaller between scenarios with higher short-circuit levels, meaning that the limiter is becoming highly saturated for those

cases. A strong saturation means lower limiting capacity. In the first peak after the fault, the maximum is 339 mWb for the case of scenario 1 and 423 mWb for scenario 5. In normal operation, the linked flux presents an offset, but very small flux variation occurs meaning that the voltage drop over the primary is negligible, as desired.

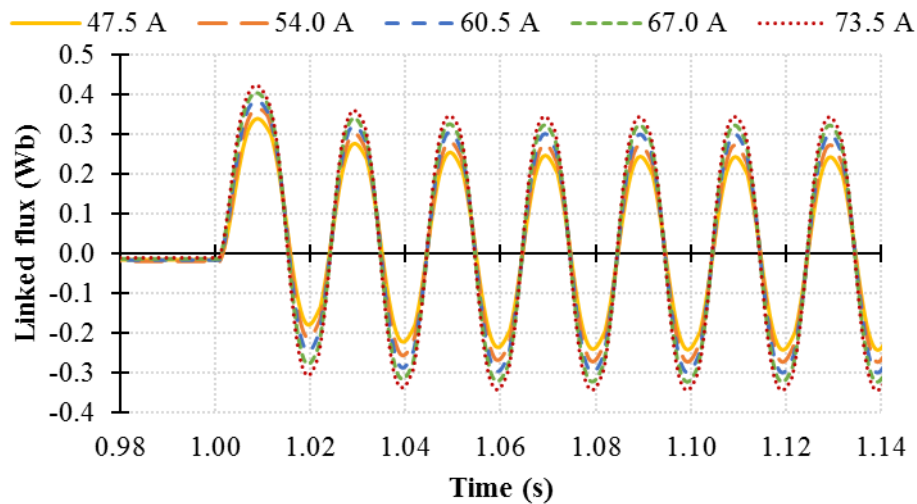


Figure 4.11 – Primary linked flux for different prospective line current scenarios.

### 4.2.3 Hysteresis Loop

As previously depicted, as the short-circuit current increase the primary linked flux also increase but saturation effect is observed, in Figure 4.12. During normal operation, the linked flux does not vary in time, remaining on a stable path, meaning that there is no voltage drop at the terminals of the limiter. In fault condition, a large hysteresis loop emerges. The results of all scenarios are bounded by the maximum loop.

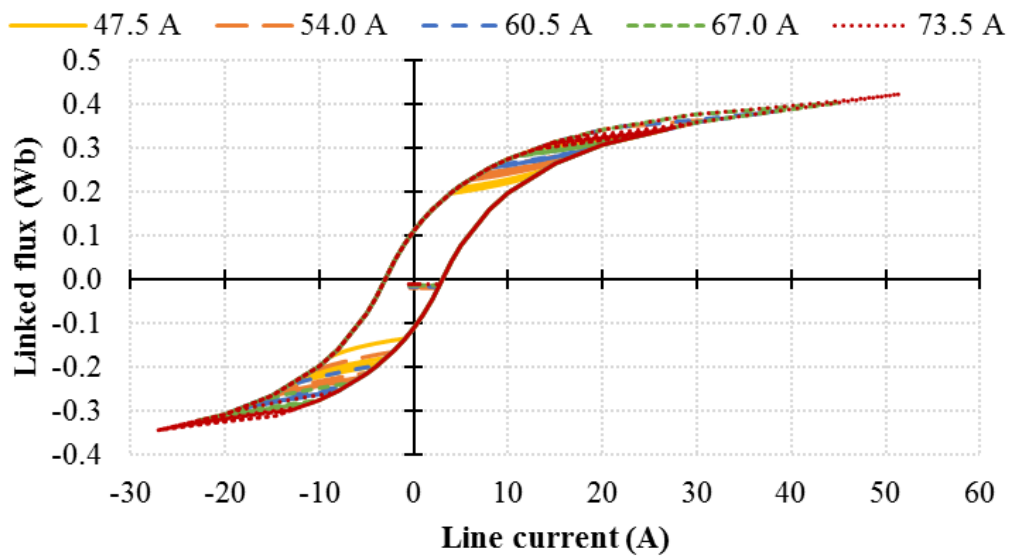


Figure 4.12 – Hysteresis loop for different prospective line current scenarios.

#### 4.2.4 Superconducting Current

The superconducting current for each scenario is presented in Figure 4.13. When the fault is triggered, high peak currents between 3-4 times the critical current of the superconductor are observed. Major differences among scenarios are observed in the first peak during fault regime. After the first peak, the decay of amplitude for each scenario is very similar in all cases.

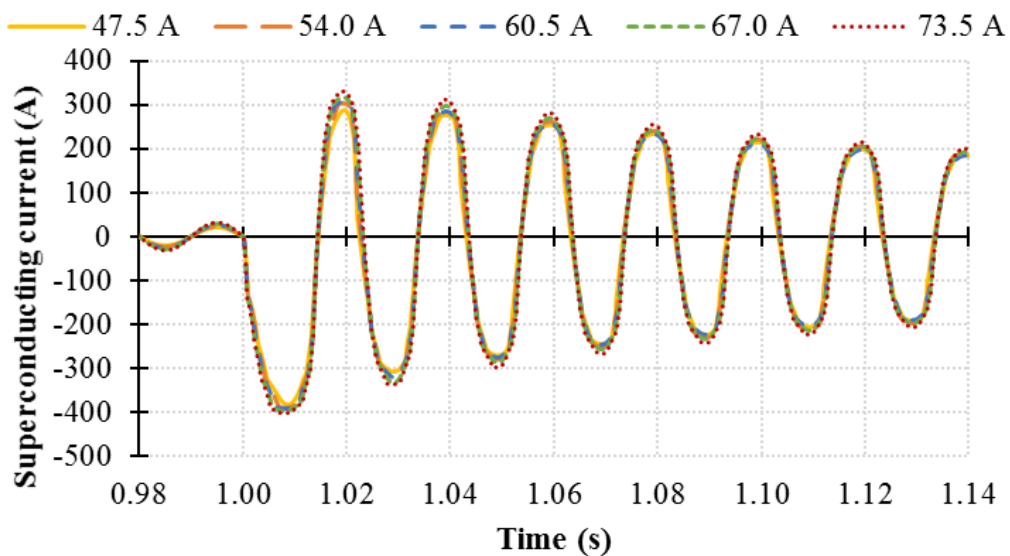


Figure 4.13 – Superconducting current for different prospective line current scenarios.

#### 4.2.5 Temperature in Superconductor

For determination of the temperature in the superconductor, the presence of the holder is taken into consideration. As for the primary, this holder provides mechanical support and ease of assembly in the core. In return, reduced convection in the inner layer of the superconducting tape is expected. By applying the thermal-electrical analogy, previously illustrated in Figure 4.7, it is considered that the convection in inner layer is negligible,  $R_{Conv(i)} \rightarrow \infty$ , whilst convection in outer layer is modelled by (3.20).

Because of high current peak values in the superconductor, the temperature in the inner layer of copper presents a peak in the subsequent instants after the fault, reaching 88.8 K in the worst scenario. After this transient regime, the temperature decreases to a stable path during fault operation. The temperature in each layer of the superconducting ring is very similar to each other. A comparison, concerning scenario 5, is made in Figure 4.14.

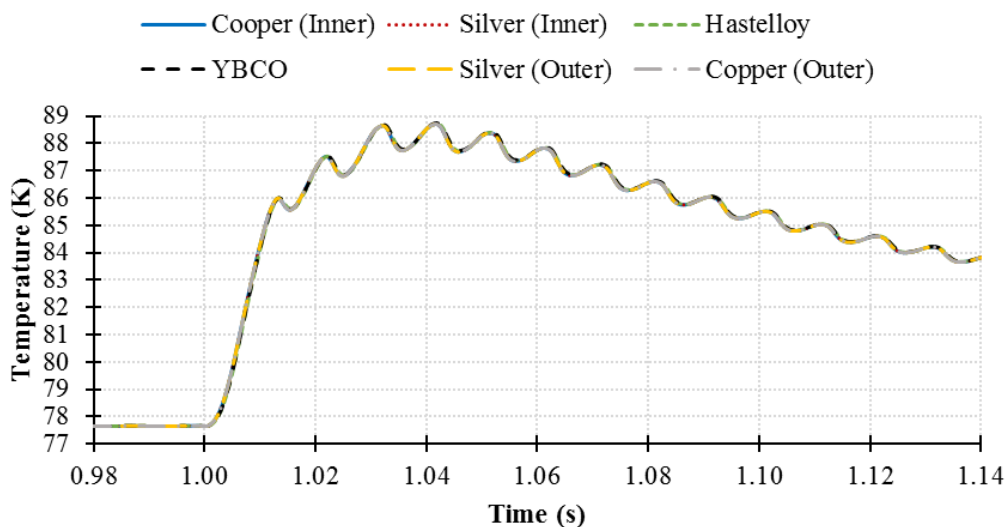


Figure 4.14 – Comparison between temperatures in each layer of the superconductor concerning simulation scenario 5.

Since minor differences in the temperature of each layer are observed, in order to compare all scenarios, the temperature in the inner layer of copper is considered for presenting results. Furthermore, in the validation presented in the next chapter, the temperature is measured on the surface of the inner layer of the copper.

Simulation results, presented in Figure 4.15, show that the temperature reaches a peak in the early moments after the short-circuit but decreases to a stable path afterwards, as presented in Figure 4.16. In the first three cycles after the fault, a maximum temperature of 88.8 K is reached for the most severe scenario and 86.6 K for the less severe scenario. After this transient, the temperature stabilises around

80.4 K and 79.9 K for the most severe and less severe scenarios, respectively. After the fault clearance, the temperature returns to its original temperature.

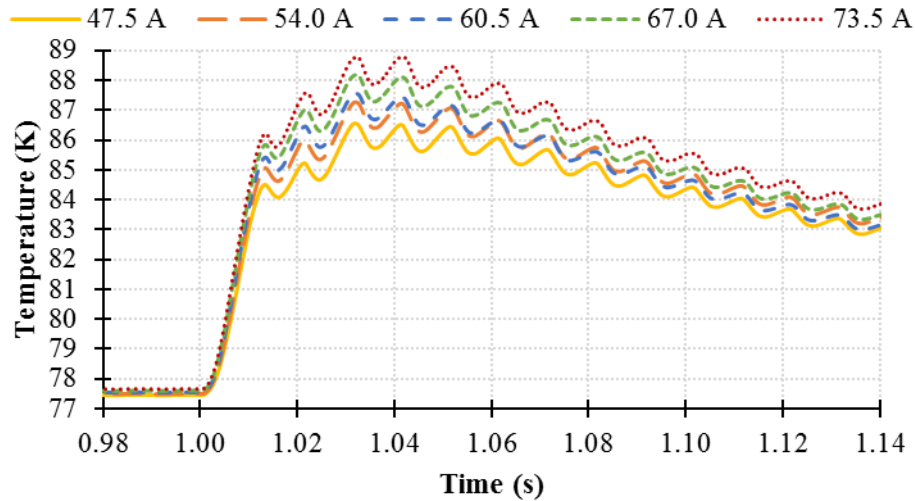


Figure 4.15 – Temperature in superconductor for different prospective line current scenarios.

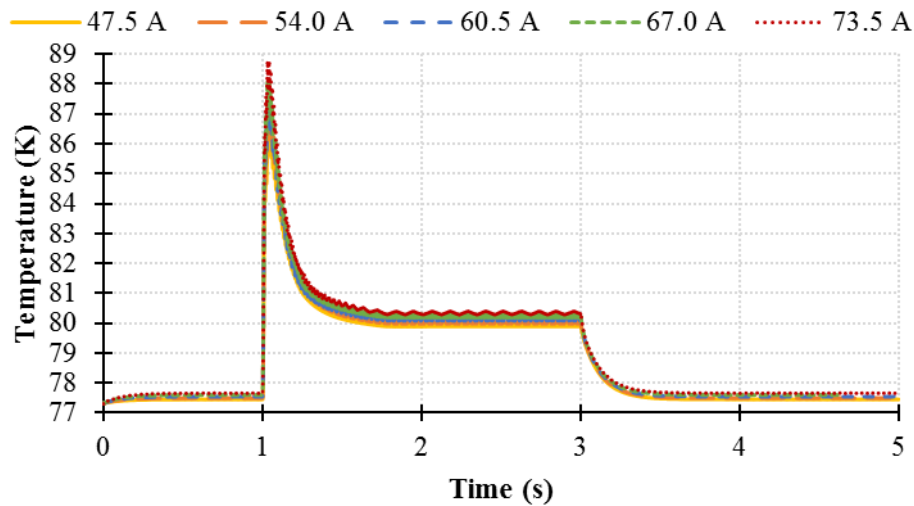


Figure 4.16 – Temperature in superconductor for different prospective line current scenarios.

Previous results considered the absence of convection in the inner surface of the superconducting ring due to the presence of a holder. In the ideal case, if the holder is removed, convection is expected to behave similarly either in outer and inner surfaces. In this case, convection in inner layer,  $R_{Conv(i)}$ , is equivalent to convection in outer layer,  $R_{Conv(o)}$ . This is modelled by (3.20). A comparison, concerning scenario 5, is presented in Figure 4.17. It can be seen that, as expected, the existence of convection in

the inner layer improves the thermal behaviour by reducing temperature during normal and short-circuit operation. Besides a lower temperature peak, the stable path of temperature during steady-state of fault is also lower, as depicted in Figure 4.18.

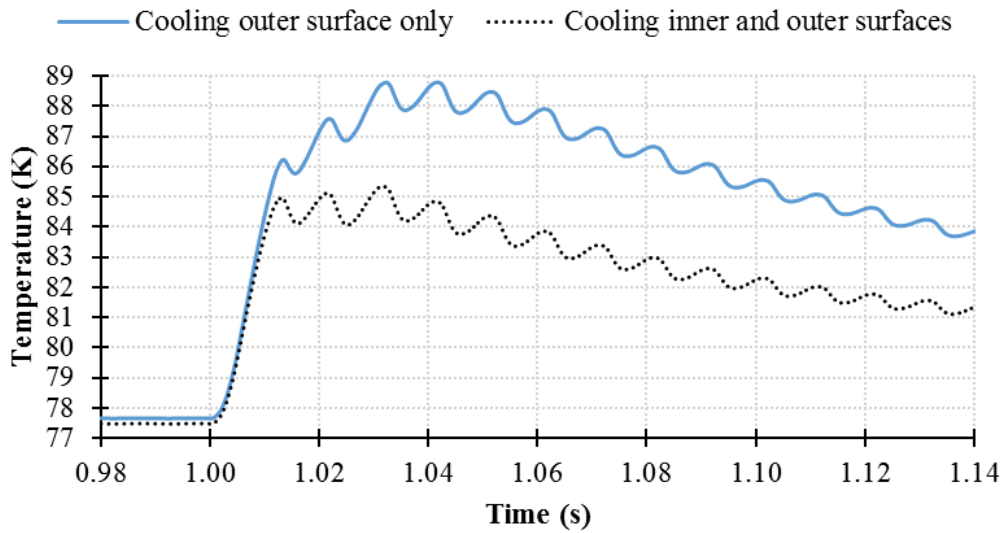


Figure 4.17 – Convection dependence of the temperature in superconductor concerning scenario 5.

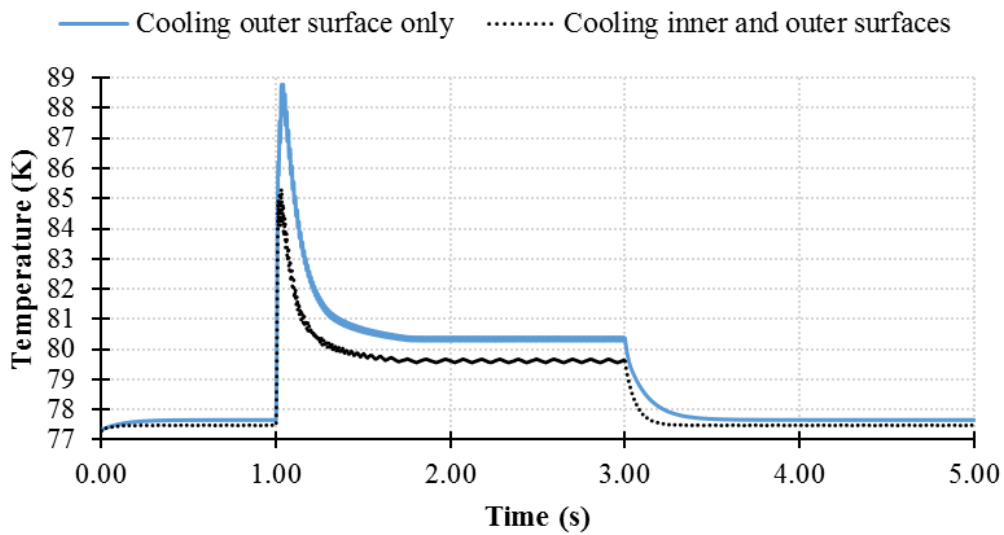


Figure 4.18 – Convection dependence of the temperature in superconductor concerning simulation scenario 5.

### 4.3 Summary

In this chapter, the simulation methodology and solution routine, implemented in Simulink, from Matlab, used to predict the dynamical electromagnetic-thermal behaviour of the limiter in electrical grids have been presented.

The methodology for the prediction of the electromagnetic behaviour of the limiter considered a reverse engineering methodology based on the maximum hysteresis loop of the device, presented in the previous chapter. On the other hand, a thermal-electrical analogy, also presented in the previous chapter, has been used for the determination of the temperature in each layer of the superconducting tape composing the limiter.

The developed simulation tool, fully compatible with Simscape Power Systems toolbox, from Simulink, provides simulation results in few minutes. Five scenarios, with different prospective line currents, have been simulated. A total simulation time of 5 seconds, with a long-term fault of 2 seconds, has been considered. Simulated line current, primary linked flux, current in HTS tape and temperature in each layer of the tape have been presented. Computation time of each scenario took less than 5 minutes. In the less severe simulation scenario (prospective current of 47.5 A), line current was limited to 26.1 A in the first peak after fault, meaning a limiting capacity of 45.1%. Concerning the most severe scenario (prospective current of 73.5 A), the current in the first peak after fault was limited to 51.5 A, meaning 29.9% of current limiting capacity. Simulation results of the limiter operating at fault condition, for the five different scenarios, are summarised in Table 4.3.

Table 4.3 – Summary of simulation results of the limiter subjected to a different prospective line current scenarios.

<i>Scenario</i>	<i>Prospective current</i>	<i>Limited current (1<sup>st</sup> peak)</i>	<i>Current limiting capacity</i>	<i>Linked flux (1<sup>st</sup> peak)</i>	<i>Superconducting current (1<sup>st</sup> peak)</i>	<i>Peak temperature</i>
1	47.5 A	26.1 A	45.1%	0.339 Wb	383.5 A	86.6 K
2	54.0 A	31.9 A	40.9%	0.364 Wb	390.5 A	87.3 K
3	60.5 A	38.6 A	36.2%	0.385 Wb	392.5 A	87.6 K
4	67.0 A	45.1 A	32.7%	0.404 Wb	398.0 A	88.2 K
5	73.5 A	51.5 A	29.9%	0.423 Wb	403.3 A	88.8 K

## 5

## *Experimental Validation of Models*

In order to validate the models, a prototype was subjected to short-circuit tests. Different short-circuit levels were considered. During the tests, several values were measured and registered, namely the grid voltage, the line current, the primary linked flux, as well as the current in the superconductor and its temperature.

### 5.1 Experimental Details

The developed prototype is shown in Figure 5.1. The prototype was installed in a test grid, as depicted in Figure 5.2. The grid is composed of a controllable voltage source, a line impedance<sup>8</sup> and a load resistance. The primary is connected in series with the grid under protection and the superconducting secondary is cooled in an open bath of liquid nitrogen. Faults were applied in the grid by short-circuiting the load through a circuit-breaker. The electrical parameters of the grid are presented in Table 5.1.

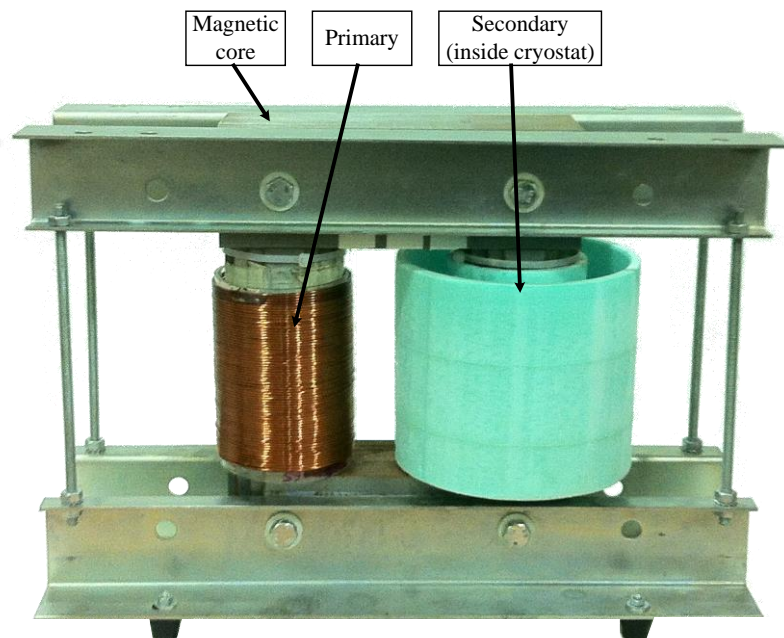


Figure 5.1 – Developed prototype for validation of models.

<sup>8</sup> In addition to the test resistance of 1.4  $\Omega$ , the resistance of the connection lines (0.2  $\Omega$ ) were also considered.

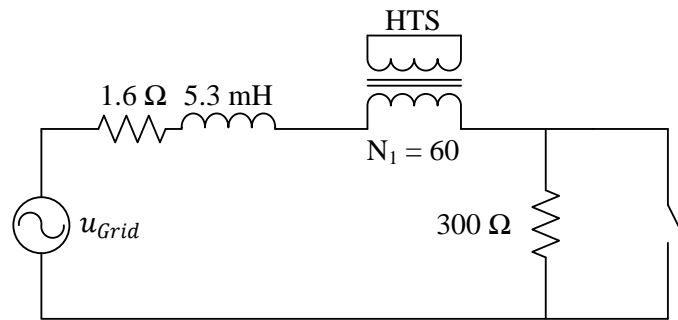


Figure 5.2 – Test grid with the FCL in series with the line.

Table 5.1 – Electrical parameters of the test grid.

<i>Parameters</i>	<i>Value</i>
Voltage source	49 – 113 V <sub>rms</sub>
Frequency	50 Hz
Line inductance	5.3 mH
Line resistance	1.6 Ω
Load resistance	300 Ω

### 5.1.1 Experimental Apparatus

The experimental test bench is schematically depicted in Figure 5.3. The following elements have been used:

- Auto-transformer: Allows to apply up to 400 V in the primary of the galvanic isolation transformer.
- Isolation transformer: A 2 kVA transformer, providing galvanic separation between the power grid and test grid.
- Line: An air-core copper coil with a resistance of 1.4 Ω and inductance of 5.3 mH. An additional resistance, introduced by the connection cables, is measured and taken into account for simulation purposes.
- Load: A 300 Ω resistor.
- Breaker: Inserted in parallel to the load, in order to intentionally introduce faults by short-circuiting the load.

- Fault Current Limiter: The prototype under study with the aforementioned constitutive parts (magnetic core, primary, superconducting secondary and cryostat).
- Auxiliary winding with integrator: Sensing device to measure the primary linked flux. The auxiliary winding is wound around the core and its voltage drop is integrated.
- Silicon diode: Temperature sensor, with reference DT-670 from Lakeshore. The diode is biased with a  $10\ \mu\text{A}$  DC current source.
- Rogowski coil with integrator and amplifier: Sensor to measure the current in the secondary. The coil is wound around the superconductor and the voltage is integrated and amplified.
- Hall probe: Hall effect current probe, with reference A622 from Tektronix, to measure the line current.
- Data acquisition board: Universal serial bus (USB) data logger (National Instruments-6008) to read the voltage of a hall probe sensing the line current (Tektronix A622), the voltage image of the primary linked flux, and the voltage proportional to the current in the superconducting ring.
- Digital multimeter: Data logger (Keithley-2001) over the standard 488 of the Institute of Electrical and Electronics Engineers (IEEE), generally known as IEEE-488, used to read the voltage of the silicon diode proportional to the surface temperature of the superconducting ring.
- Computer: Running a Matlab routine for data logging from USB and IEEE-488 interfaces. The sampling rate of the National Instruments-6008 acquisition board, via USB, is 2500 samples per second and 24 samples per second for the case of the Keithley-2001, via IEEE-488.

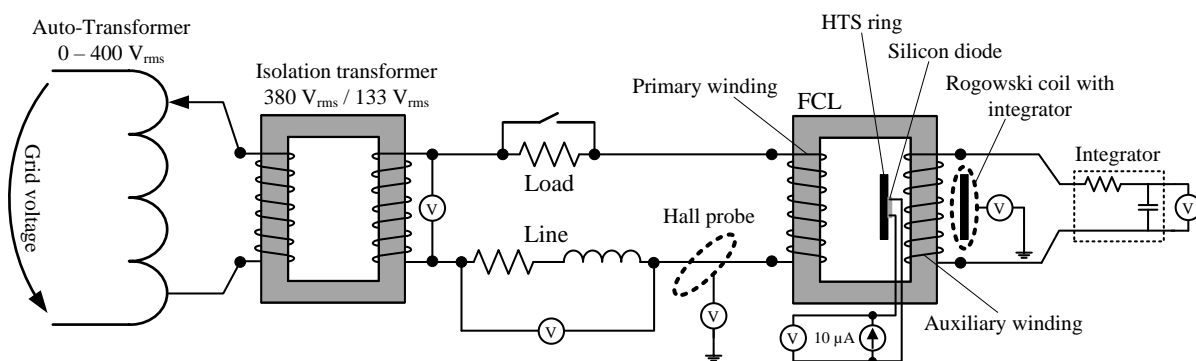


Figure 5.3 – Schematic diagram of the test bench. The auxiliary winding, represented in the same limb of the superconducting ring for diagram simplification, is wound around the primary to consider the leakage reactance.

The real apparatus is shown in Figure 5.4 and Figure 5.5.

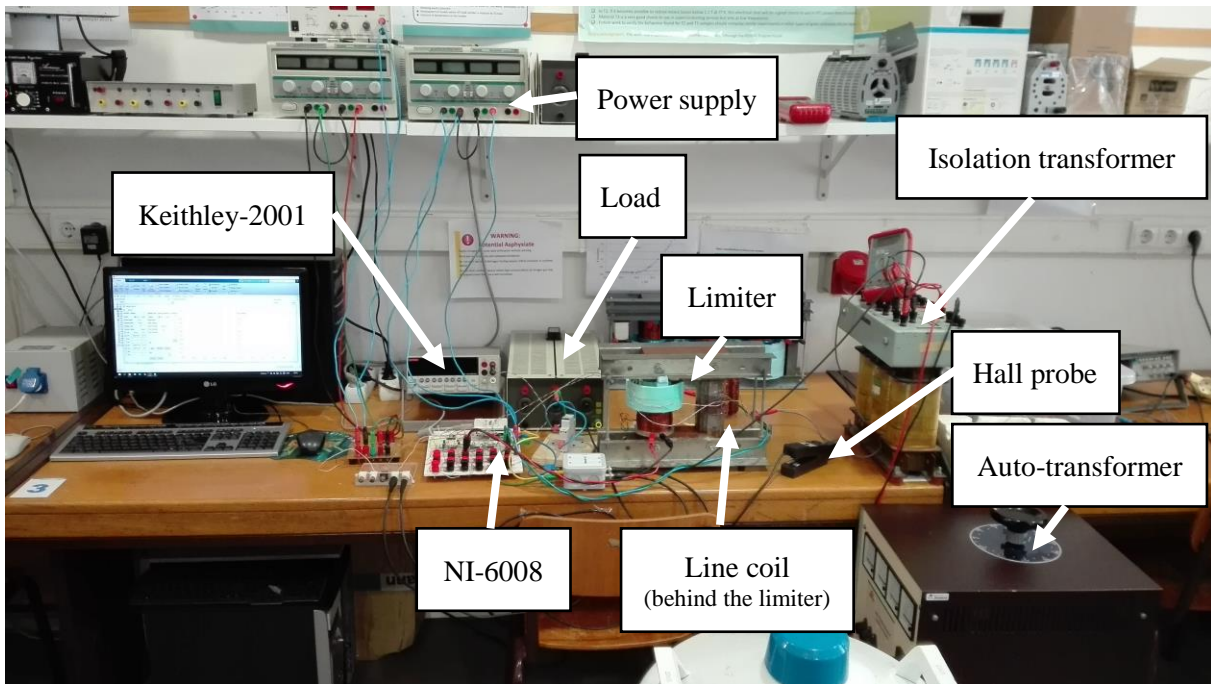


Figure 5.4 – Laboratory apparatus during experiments.

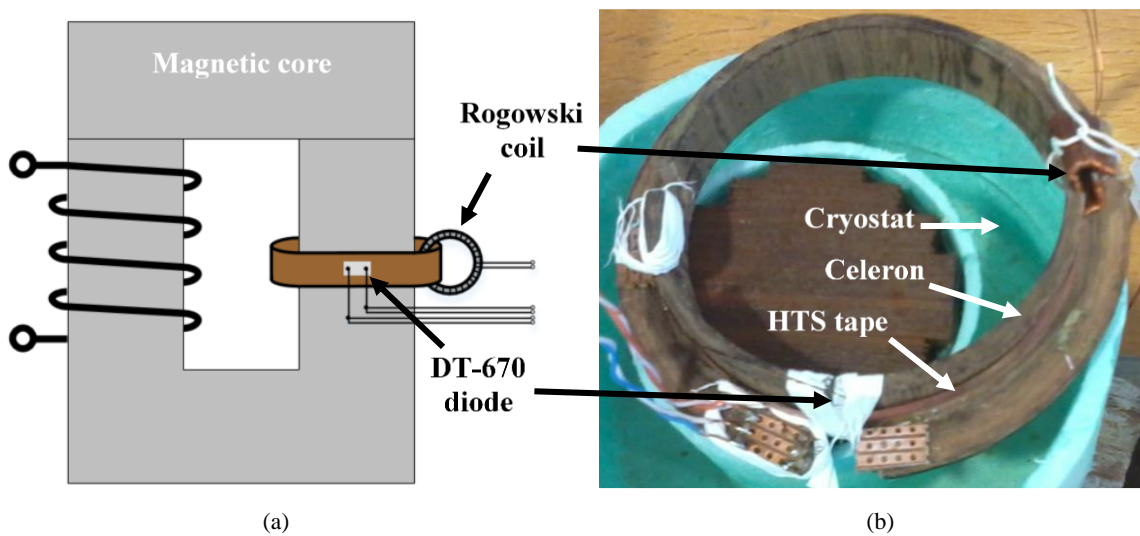


Figure 5.5 – Experimental details of the temperature and current sensors. The cryostat, Celeron holder and a part of the iron core are also shown. (a) Diagram. (b) Real apparatus.

Since the analogue inputs of the National Instruments-6008 are limited to  $\pm 10$  V, signal conditioning is required in order to measure higher voltages. Thus, a differential amplifier, as depicted in Figure 5.6, was used. A single supply quad operational amplifier MC3403 was employed. Supply voltage for the operational amplifier is provided from an adjustable power supply with reference PS23023 from Kiotto Company. The supply was defined as  $\pm 10$  V. The output of the differential amplifier is given by (5.2),

$$v_o = -v_1 \cdot \left(\frac{R_2}{R_1}\right) + v_2 \cdot \left(\frac{R_4}{R_3 + R_4}\right) \cdot \left(\frac{R_1 + R_2}{R_1}\right) \quad (5.1)$$

where  $v_o$  is the output voltage,  $v_1$  and  $v_2$  are the input terminals, and  $R_1$ ,  $R_2$ ,  $R_3$  and  $R_4$  are resistances for signal conditioning. When  $R_1 = R_3$  and  $R_2 = R_4$  the output can be simplified to (5.2),

$$v_o = \frac{R_2}{R_1} \cdot (v_2 - v_1) \quad (5.2)$$

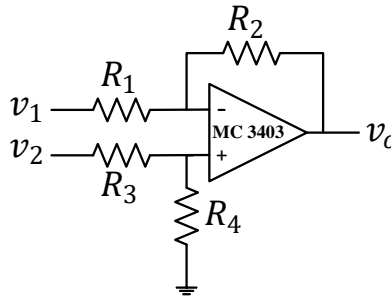


Figure 5.6 – Differential amplifier for signal conditioning of voltage measurements.

Considering (5.2), the gain of the differential amplifier, defined as the relation  $R_2/R_1$ , for each conditioned measured quantity is presented in Table 5.2. After data acquisition, an inverse gain is applied by software.

Table 5.2 – Electrical parameters of the signal conditioning.

<i>Analog input</i>	<i>Measured voltage</i>	$R_1$	$R_2$	$R_3$	$R_4$	<i>Gain</i>
1	Line impedance	10 k $\Omega$	1 k $\Omega$	10 k $\Omega$	1 k $\Omega$	0.1
3	Linked flux sensor coil <sup>9</sup>	22 k $\Omega$	22 k $\Omega$	22 k $\Omega$	22 k $\Omega$	1

The gain of the channel of the line current, measured with the Tektronix A622 current probe, is 100 mV/A, directly adapted from the measuring device. In the case of the Rogowski coil, the gain is 16 mV/A with no need for additional signal conditioning. Concerning data logging from digital multimeter Keithley-2001, there is no need for electronic signal conditioning since its voltage operating range is adequate for the voltage output range of the silicon diode.

<sup>9</sup> The signal conditioning gain is 1 but due to the turn number relation between the primary winding (60 turns) and sensor winding (70 turns), the final gain is the relation 60/70, corresponding to 0.857.

Due to the need of using two distinct data loggers operating at the same time with different interfaces, data acquisition is managed by means of a GUI in Matlab. This GUI, presented in Figure 5.7, allows logging measurements from data acquisition board and digital multimeter in parallel real time. Up to eight analogue input channels of the National Instruments-6008 in reference single ended mode and one differential input of the Keithley-2001 can be logged. Several definitions of data acquisition are available, such as sampling rate, voltage range, channel names, gains and resolution. After data recording, results can be observed directly in the GUI and a spreadsheet is generated with a defined filename.

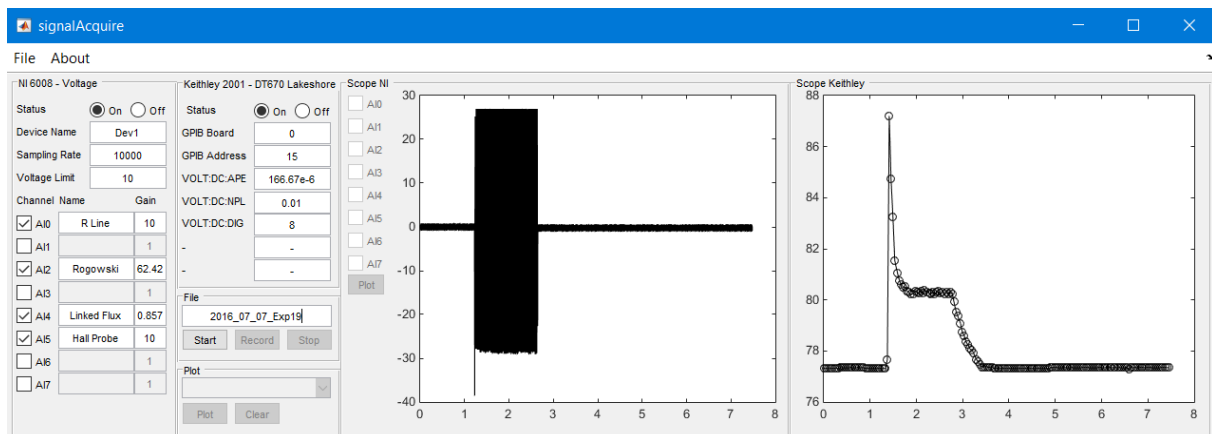


Figure 5.7 – Developed GUI for data logging from the data acquisition board National Instruments-6008 and digital multimeter Keithley-2001.

### 5.1.2 Rogowski Coil

A Rogowski coil, shown in Figure 5.8, specially adapted for the reduced dimensions of the coated conductor and a corresponding signal integrator were developed and calibrated. This coil is open-ended and flexible, allowing it to be wound around the superconducting tape. The measured values were acquired by the National Instruments data acquisition board. Line current and linked flux were also measured with this acquisition board.

An integrator and active amplifier with a gain of 16 mV/A was used for reading the output voltages of the Rogowski coil that are images of the current in the superconducting ring. It is taken into account that the output voltages are with 90° of phase shift with respect to current.



Figure 5.8 – Rogoswski coil with superconducting tape inserted.

### 5.1.3 DT-670 Silicon Diode

Measuring temperature in the superconducting tape can be performed by silicon diodes that are sensible to temperature. This solution has been used in several works, see e.g. [161]–[163]. In this work, a silicon diode sensor with reference DT-670 from Lakeshore [164] was used for temperature measurement on the surface of the coated conductor according to its standard calibration curve [165]. The surface of the temperature sensor was greased with Apiezon N and enclosed by Teflon tape between the Celeron holder and the superconducting tape, applied as shown in Figure 5.5. Voltage signals proportional to temperature were acquired with the Keithley-2001 and logged with the developed GUI from the IEEE-488 interface. The configurations of the Keithley-2001 are very important for sample rating. The most important configuration parameters for data acquisition over IEEE-488 bus are:

- **Aperture (APER):** It is the integration time of the analogue/digital converter, i.e. the period of time that the input signal is measured ( $166.67 \times 10^{-6}$  to  $200 \times 10^{-3}$  seconds). The integration time has influence in the resolution, reading noise as well as the sampling rate.
- **Number of Power Line Cycles (NPLC):** This parameter is also related to the integration time, corresponding to the number of power line cycles (0.01 to 10) that the input signal is measured. Despite leading to increased noise and lower resolution, a lower NPLC provides faster readings than a higher NPLC. Since APER and NPLC represent both the integration time, when setting NPLC, the aperture value is updated accordingly to the value of NPLC. If NPLC is not set, the defined value of APER is considered for the integration time.
- **Digits (DIG):** Measurement resolution (4 to 9 digits). Few digits for speed, many digits for high-resolution.
- **Filter:** Used to stabilise noisy measurements. Analog and digital filters are available. The analogue filter is a simple RC circuit. On the other side, two types of digital filters are available: averaging and advanced. The former is based on an average of readings inside a specified range

while the latter performs a dynamic average of reading considering readings inside and outside the specified range.

- Range: Measurement range ( $-1.1 \times 10^3$  to  $1.1 \times 10^3$  V). Affects resolution and accuracy.

These values, considering a trade-off between precision and speed, are presented in Table 5.3.

Table 5.3 – Configuration parameters for Keithley-2001 data acquisition over IEEE-488 bus.

Parameter	Value
APER	$166.67 \times 10^{-6}$ seconds
NPLC <sup>10</sup>	0.01 cycles
DIG	5 digits
Filter	Disabled
Range	1.04 – 0.98 V

The diode is connected to digital multimeter in a two-wire configuration for voltage measurement, as illustrated in Figure 5.9.

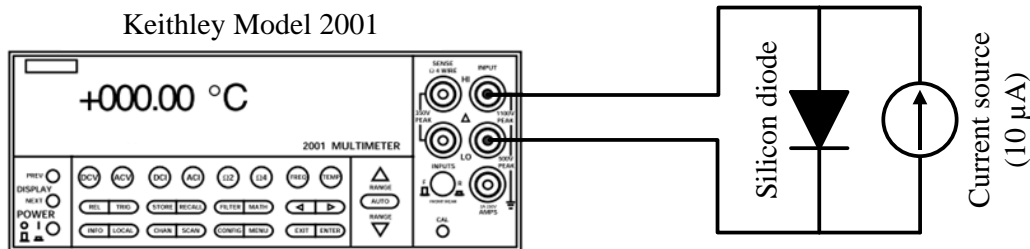


Figure 5.9 – Silicon diode connection to digital multimeter in two-wire configuration. Adapted from [166].

The silicon diode requires a stable  $10 \mu\text{A}$  DC current source. This current source was built as shown in Figure 5.10, in which the load is the diode. Supply voltage of  $\pm 10$  V to the OP 27 operational amplifier is provided from an adjustable power supply with reference PS23023 from Kiotto Company. Reference voltage,  $U_{Ref}$ , is provided from a power source ALR3003 from ELC Company. The parameters of reference voltage and resistance of current adjusting are presented in Table 5.4.

<sup>10</sup> If NPLC is not set, the defined value of APER is considered for the integration time of the analogue/digital converter. Otherwise, if NPLC is set, the APER parameter is not considered.

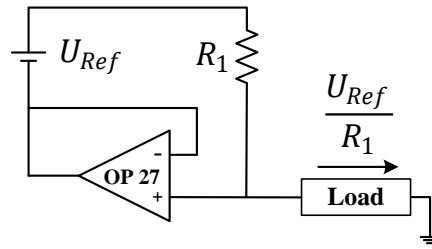


Figure 5.10 – Precision 10  $\mu\text{A}$  current source.

Table 5.4 – Parameters for precision 10  $\mu\text{A}$  current source.

<i>Parameter</i>	<i>Value</i>
$U_{Ref}$	4.99 V
$R_1$	499 k $\Omega$

From the standard curve of the diode [165], presented in Figure 5.11, the temperature measured,  $T_D$ , in the range 75 – 95 K can be approximated by (5.3),

$$T_D = \frac{1.165 - v_D}{0.001773} \quad (5.3)$$

where  $v_D$  is the voltage drop at the terminals of the diode.

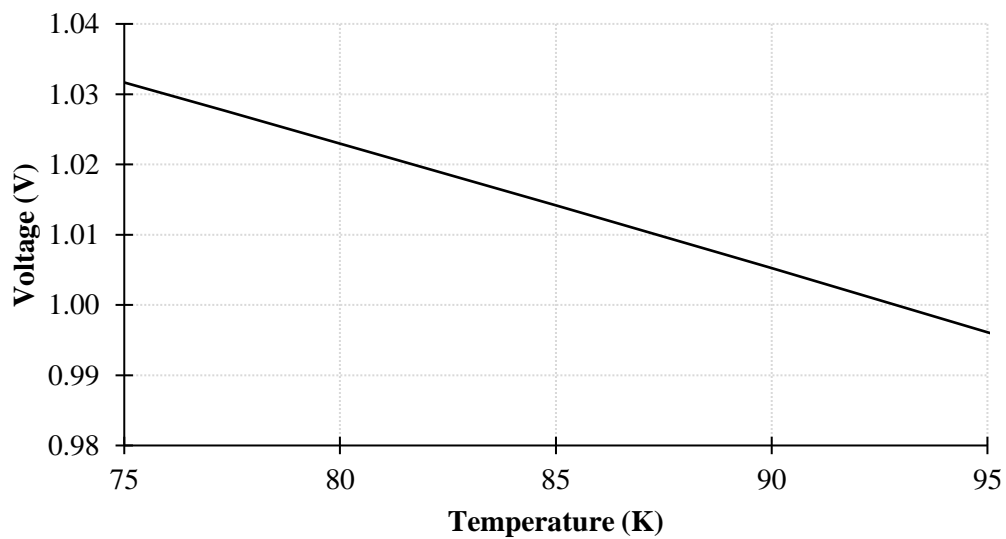


Figure 5.11 – Temperature response curve of the DT-670 silicon diode in the range 75 – 95 K. Adapted from [165]

## 5.2 Comparison Between Simulations and Experimental Results

A total time operation of 5 seconds was considered. Using a quad-core 2.83 GHz processor, 8 GB RAM computer, the simulation of this problem took less than 5 minutes. In order to quantify divergences between simulated and experimental results, the percentage error,  $E_{\%}$ , defined in (5.4), is used,

$$E_{\%} = \left| \frac{x_{Exp} - x_{Sim}}{x_{Exp}} \right| \times 100\% \quad (5.4)$$

where  $x_{Exp}$  and  $x_{Sim}$  are experimental and simulated quantities, respectively.

### 5.2.1 Line Current

The results of the line current are presented and compared in Figure 5.12. The maximum prospective line current of 30.1 A was limited to 18.4 A in the first peak during fault operation in the simulated case and 18.9 A in the experimental case. During this first cycle, the error is 2.6% in the positive peak and 1.0% in the negative peak. After the first cycle in fault operation, the line current amplitude sets around 11.9 A, for both simulation and experimental cases, with a very reduced error.

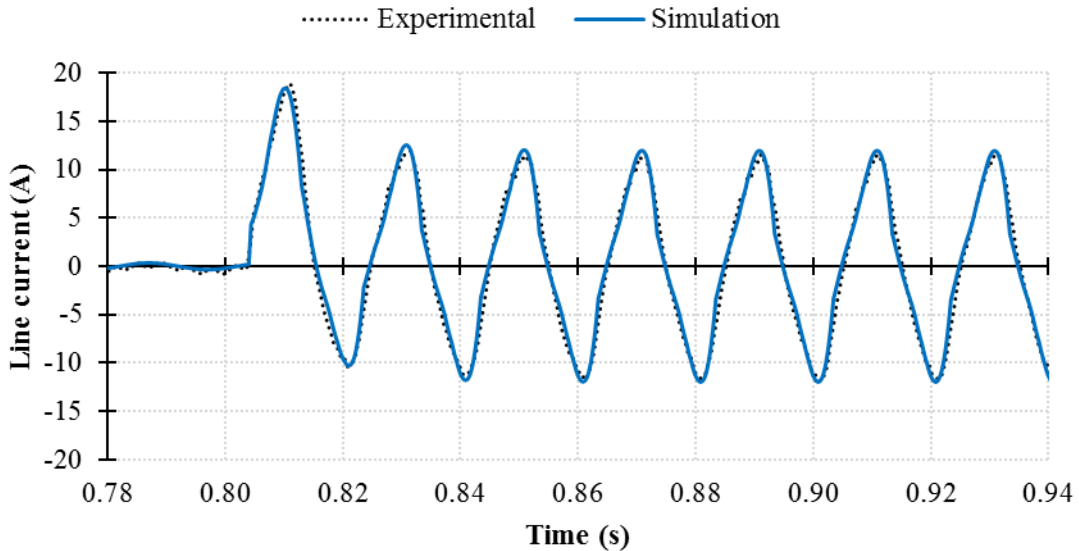


Figure 5.12 – Comparison between simulation and experimental results of the line current.

### 5.2.2 Primary Linked Flux

The primary linked flux as a function of time is depicted in Figure 5.13. Similarly to results of line current, the major difference occurs during the first peak after the fault, in which the maximum amplitudes are 292 mWb and 242 mWb for the simulated and experimental cases, respectively,

corresponding to an error of 20.7%. The error is reduced to 12.3% (simulated value of 200 mWb and experimental value of 228 mWb) and 5.5% (simulated value of 230 mWb and experimental value of 218 mW) in second and third peaks, respectively. In the following cycles during fault condition, the maximum experimental flux amplitude sets around 210 mWb for both simulation and experimental cases. A small phase shift between measurements and simulations is observed.

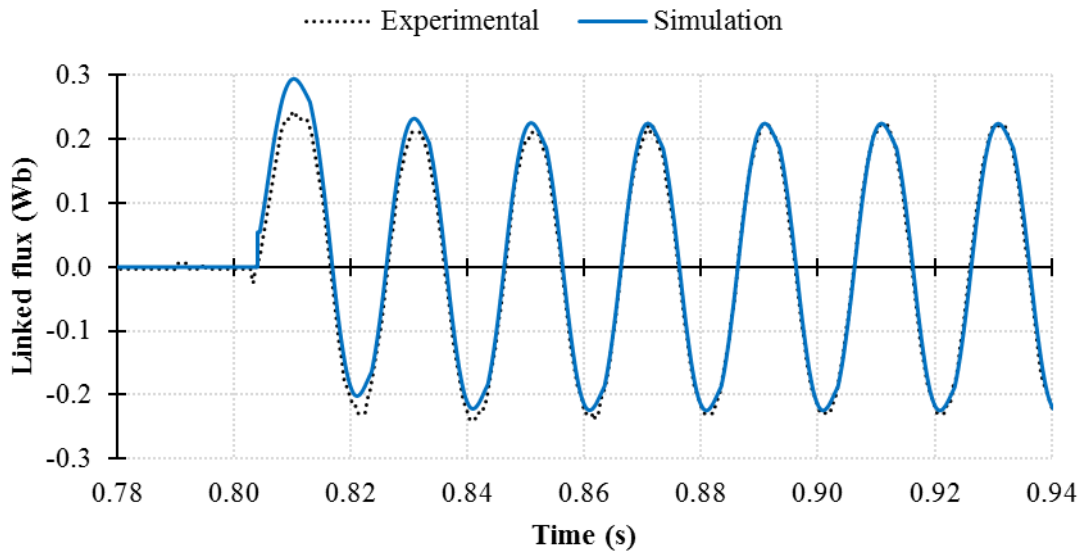


Figure 5.13 – Comparison between simulation and experimental results of the primary linked flux.

### 5.2.3 Hysteresis Loop

The excursion of the hysteresis loop from a transition between the fault operation and normal operation is depicted in Figure 5.14. The shape of the experimental loop is in agreement with simulations. The wider path cycles observed in the experimental results correspond to the initial cycles after the fault triggering. After the initial cycles, minor differences are observed. This behaviour suggests that the parameter  $I_{HTS}^*$  of the methodology based on the maximum hysteresis loop can be dynamic.

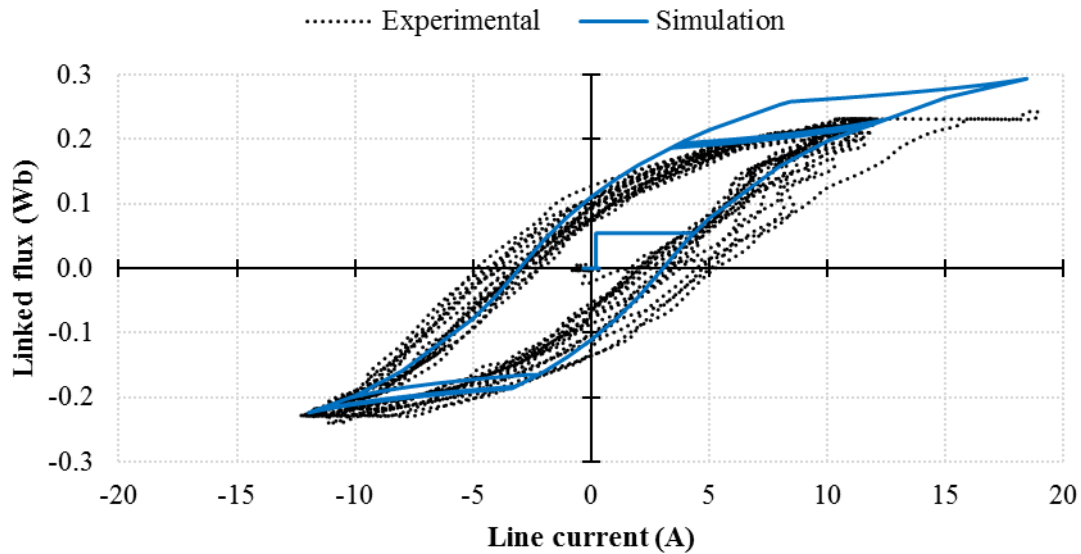


Figure 5.14 – Comparison between simulation and experimental results of the hysteresis loop.

#### 5.2.4 Superconducting Current

The current in the superconductor is shown in Figure 5.15. The measured peak current, during fault condition, reached three times the critical current but decreased to nearly its critical value during this regime. This is an important remark for thermal stability. Comparing experimental results to simulations, despite some differences in the first two periods after fault, results are in great accordance. The major difference between simulation and experimental results occurs in the first peak after fault, corresponding to an error of 15.7% (simulated value of 357.5 A and experimental value of 308.9 A). In the next peaks, the error is reduced to 3.7%, 11.3% and 1.8% for second, third and fourth peaks, respectively. In the following cycles, results are in great accordance. For prospective line currents higher than 40 A, the experimental results of the superconducting current show a non-sinusoidal behaviour. This means that the simple model for the determination of the induced current as a function of primary magnetomotive force correctly determines the amplitude of the current but non-sinusoidal phenomenon, arising from high current values, is not properly represented. Nevertheless, in the case of smaller amplitudes, the non-sinusoidal behaviour is not so evident whereby the shape of the simulated results is closer to the experimental results, as presented in Appendix D. Since these simulation results are used as input for the determination of the temperature in the superconducting tape, it is important to understand their relevance. This task is performed following.

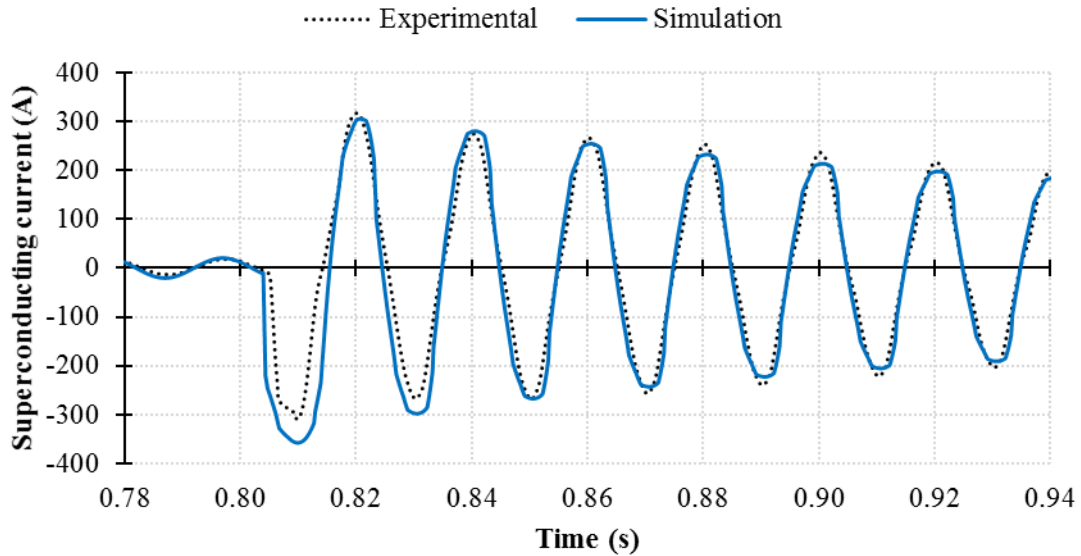


Figure 5.15 – Comparison between simulation and experimental results of the superconducting current.

### 5.2.5 Temperature in Superconductor

The temperature in the superconductor is represented in Figure 5.16. Experimental results show a peak of about 85.5 K in the early moments after the short-circuit but decrease, in about 0.5 seconds, to a stable path around 80 K. This means that safe operation is achieved from the thermal stability point of view. When the fault is cleared, the recovery of the initial temperature takes about 0.6 – 0.8 seconds.

At normal regime operation, a small difference in temperature between simulation and experimental results are observed. Whilst the experimental results give 77.4 K, the simulation results estimate 77.7 K. This means an error of 0.4%. In fault condition, the simulated peak temperature is 86.0 K, representing an error of 0.6% with respect to experimental measurements. During fault operation, good agreement between experiments and simulations are observed. However, due to discrete measurements, the true peak may not have been computationally acquired, but a point near instead. This constraint is explained from the reduced sampling rate of the digital multimeter over IEEE-488 bus interface due to high precision measurement needs. A small shift is also observed which is due to the thermal inertia of the sensor.

Despite not having relevance unless a fault occurs at that moment, the most significant difference between simulation and experimental results occurs in the following moments after the fault clearance. Besides the thermal inertia of the sensor, this can be explained by a hysteretic behaviour of the convection. From the literature, it is suggested that the heat transfer coefficient, when cooling from high temperatures, the boiling regions may be hysteretically extended down [86], [167]. The presence of Teflon tape around the superconducting tape also contributes for a slower heat removal.

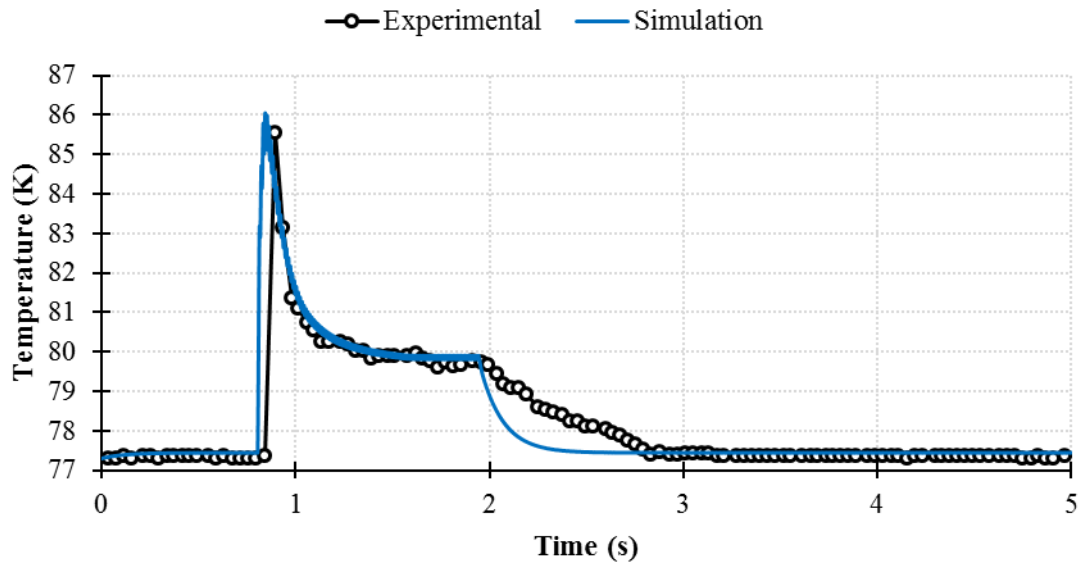


Figure 5.16 – Comparison between simulation and experimental results of the temperature in the tape.

### 5.3 Summary

In this chapter, the experimental details of the implemented prototype and sensors for data acquisition have been presented. The prototype has been inserted in a test electrical grid and subjected to several short-circuit faults with prospective currents from 30.1 A to 69.2 A. Line current, primary linked flux, current in superconducting secondary as well as temperature in the surface of the superconducting secondary have been measured. A commercial Hall probe and silicon diode have been used to measure line current and temperature on the surface of the superconductor, respectively. On the other hand, an auxiliary winding for measuring the primary linked flux and a Rogowski coil for the measurement of the current in superconductor have been prototyped. The temperature on the surface of the superconductor was acquired with a high precision digital multimeter whilst the other quantities were acquired by a data acquisition board. All these quantities have been compared to simulations. Good agreement was achieved. Results of the peak values of the limiter operating at fault condition, for a prospective line current of 30.1 A, in simulation and experimental cases, are summarised in Table 5.5. More results can be found in Appendix D.

Table 5.5 – Summary of experimental and simulation results of the limiter subjected to a prospective line current of 30.1 A.

Scenario		Limited current amplitude		Linked flux amplitude		Superconducting current amplitude		Temperature	
		Value	Error	Value	Error	Value	Error	Value	Error
Steady state (normal)	Simulation	0.3 A	0.0%	<0.005 Wb	0.0%	18.0 A	4.3%	77.7 K	0.4%
	Experimental	0.3 A		<0.005 Wb		18.8 A		77.4 K	
1 <sup>st</sup> peak (fault)	Simulation	18.4 A	2.6%	0.292 Wb	20.7%	357.5 A	15.7%	86.0 K	0.6%
	Experimental	18.9 A		0.242 Wb		308.9 A		85.5 K	
2 <sup>nd</sup> peak (fault)	Simulation	10.2 A	1.0%	0.200 Wb	12.3%	305.2 A	3.7%	-	-
	Experimental	10.3 A		0.228 Wb		316.9 A		-	
3 <sup>rd</sup> peak (fault)	Simulation	12.5 A	5.0%	0.230 Wb	5.5%	297.7 A	11.3%	-	-
	Experimental	11.9 A		0.218 Wb		267.5 A		-	
4 <sup>th</sup> peak (fault)	Simulation	11.7 A	5.4%	0.222 Wb	7.1%	279.8 A	1.8%	-	-
	Experimental	11.1 A		0.239 Wb		274.9 A		-	
5 <sup>th</sup> peak (fault)	Simulation	12.0 A	5.3%	0.224 Wb	5.7%	266.9 A	0.1%	-	-
	Experimental	11.4 A		0.212 Wb		267.1 A		-	
6 <sup>th</sup> peak (fault)	Simulation	11.9 A	2.6%	0.224 Wb	6.3%	254.3 A	4.4%	-	-
	Experimental	11.6 A		0.239 Wb		266.1 A		-	





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## *Conclusions*

In this work, a contribution for the development of inductive type superconducting fault current limiters has been made by providing experimental details and models that might be included in the design of such type of limiters operating in electrical power grids. The influence of the constitutive parts composing the limiter has been studied in order to design, model and simulate such type of limiter.

The research question of this work, presented in Chapter 1, aims to identify how the properties of the constitutive parts of the inductive type FCL can be considered to model, simulate and design such limiter. In this work, an electromagnetic-thermal analysis of the constitutive parts composing the FCL has been carried out, namely: primary winding, superconducting secondary, magnetic core and cryostat with liquid nitrogen. The behaviour of the magnetic linkage between primary and superconducting secondary during normal and fault operation has been studied. Thermal dependent properties of the superconductor have been taken into account, namely: critical current density,  $n$ -value, resistivity, thermal conductivity, heat capacity and convection. A laboratory-scale prototype has been built and experimental data have been acquired in order to validate previous models based on electromagnetic and thermal phenomena. A simulation tool, providing fast simulations of the electromagnetic-thermal behaviour of the inductive limiter operating in a grid, has been proposed.

Regarding the hypothesis, also presented in Chapter 1, a relationship between the independent variable (simulation methodology) and dependent variable (simulation results compared to real experimental results) can be reached. The developed simulation tool, implemented in Simulink, provide simulation results of the limiter operating in electrical grids with reasonable agreement to experimental results. Furthermore, with the use of this tool, fast simulations, in the order of few minutes (less than 5 minutes), can be performed. This is particularly important, since simulations of FCLs in electrical grids generally require time-consuming computation, as e.g. FEM simulations [72], [79].

### **6.1 Summary and Discussion**

The performed activities of this work are presented and discussed following:

- Design of an inductive type FCL composed of a two-legged closed magnetic core wound by a primary winding, made by copper wire, and a short-circuited superconducting secondary, made

by SuperPower SCS4050 tape. The latter is supported by a Celeron holder and housed inside a cryostat with liquid nitrogen. Related tasks:

- Design of an acrylic holder to support the primary winding and ease the assembly in the limiter. Copper with a cross section of  $1.5 \text{ mm}^2$  was chosen due to ease of winding manufacturing and low price. An auxiliary winding, separated from the primary, was also wound around the acrylic holder. This auxiliary winding, also made by copper, is used to measure the linked flux with the primary.
  - Design of a cryostat wounding a leg of the magnetic core. This cryostat, made by extruded polystyrene, was designed focusing an easy assembly for experimental measurements. It can store about 0.25 L of liquid nitrogen.
  - Development of a holder to perform joints of superconducting tapes in the form of rings. This holder, adapted to support heating and cooling cycles, was made from stainless-steel in a CNC machine. With this holder, both terminals of superconducting tape are soldered with Sn96.5-Ag3.5 paste, performing rings with 40 mm radius. Prior to soldering, copper overlays of the tape (on the joint regions) have been removed by chemical etching. This procedure requires to deep the tape inside etchant for at least 20 minutes in order to completely remove copper layers, as observed by scanning electron microscopies and energy disruptive x-ray spectroscopies.
  - Design of a Celeron holder to support superconducting rings. Presenting low thermal expansion, Celeron is a suitable material to be housed inside the cryostat. Besides, it also allowed to use a Rogowski coil wounding the superconducting ring.
- Development of a fast simulation tool, in Simulink/Matlab, for the prediction of the electromagnetic-thermal behaviour of the designed limiter operating in a grid. Several short-circuits with different prospective line currents have been simulated. In the less severe scenario presented (prospective current of 47.5 A), the current limiting capacity was 45.1% whilst in the most severe scenario (prospective current of 73.5 A), the current limiting capacity was 29.9%. Temperatures in superconducting tapes range from 86.6 K (less severe scenario) to 88.8 K (most severe scenario). Related tasks:
- Experimental characterisation of critical current density and  $n$ -index of the commercial SuperPower SCS4050 superconducting tape. Four points method technique, according to IEC 61788-3, has been performed. At 77.3 K, self-field, the sample subjected to measurement presented an engineering current density of  $255.8 \text{ A} \cdot \text{mm}^{-2}$  and  $n$ -value of 31.71.
  - Modelling (based on literature) of the temperature dependence of critical current density and  $n$ -index of YBCO as well as the temperature dependence of electrical resistivity,

heat capacity and thermal conductivity of each layer composing the superconducting tape, i.e., copper, silver, Hastelloy and YBCO. The convective heat transfer between the surface of the superconducting tape and liquid nitrogen has also been modelled. These properties are applied in a thermal-electrical analogy used to predict the thermal behaviour of each layer of the superconducting tape.

- Development of an electromagnetic model describing the dynamical behaviour of the induced currents in superconducting secondary of the limiter. This model is based on the empirical knowledge of the induced currents in superconducting ring as a function of the primary magnetomotive force and time after the beginning of short circuit fault. The determined values are used as input in the thermal-electrical analogy. The model correctly determines the current in superconductor for low amplitudes of prospective currents (up to about 40 A). However, for higher prospective line currents, the measured induced currents in superconducting ring present a non-sinusoidal behaviour that is not predicted in simulations. This leads to further investigations regarding such non-sinusoidal behaviour.
- Experimental characterisation of the device according to the maximum hysteresis loop methodology, namely measurement of the relation between primary linked flux and current in the absence of the superconducting secondary as well as measurement of the maximum induced current in superconductor for which current limitation is not performed. The value of this maximum induced current, measured with a Rogowski coil, was 182 A.
- Experimental assessment of a developed prototype (based on the performed design) and validation of simulation methodologies. In order to gather experimental results, the prototype is inserted in a test electrical grid subjected to fault occurrences, allowing to measure line current, primary linked flux, current in superconductor and temperature on the surface of superconductor. The prototype has been subjected to short-circuit faults with prospective line currents from 30.1 A to 69.2 A (in the main body of the text, results concerning a prospective line current of 30.1 A are presented and discussed whilst other scenarios are presented in Appendix D). The results provided by the maximum hysteresis loop methodology, namely primary line current and linked flux, have been compared to experimental results. These results are in good accordance meaning that the methodology is suitable for the prediction of the electromagnetic behaviour of the limiter. On the other hand, the thermal-electrical methodology correctly determines the amplitude of the current in superconducting ring. However, for prospective line currents higher than 40 A, non-sinusoidal behaviour of the induced currents in superconductor is experimentally observed. The modelling of this behaviour must be investigated in future works since the simulation model correctly predicts the amplitude values

but not the non-sinusoidal behaviour. Concerning the temperature prediction, the thermal-electrical methodology present simulation results in good accordance to experimental measurements (for instance, in the case of a prospective line current of 30.1 A, simulation results of peak temperature gave 86.0 K whilst measured results gave 85.5 K, meaning a relative error of 0.4%). The greatest differences are observed during fault clearance, whereby this should be investigated in future works in order to fully validate the methodology. These measurements have been performed by using several equipment. Related tasks:

- Measurement of line current with a commercial Tektronix A622 Hall probe sensor. Measurement of linked flux with a prototyped auxiliary coil (wounding the magnetic core). Measurement of superconducting current with a prototyped Rogowski coil (wounding the superconducting ring) specially built to be inserted inside the cryostat. Measurement of temperature in the surface of superconducting tape with a commercial Lakeshore DT-670 silicon diode.
- Development of a graphical user interface for laboratory measurements with data acquisition board NI-6008 (over USB interface) and digital multimeter Keithley-2001 (over IEEE-488 interface) operating simultaneously. With this graphical interface, it is possible to start and stop data logging, from both USB and IEEE-488 interfaces, at the same timestamp. The properties and acquired results of these data loggers can be managed, saved and observed directly from the graphical interface. Line current, linked flux and superconducting current have been measured with NI-6008 whilst temperature in the surface of superconducting tape has been measured with Keithley-2001.

## 6.2 Future Work

The following aspects are recommended to be considered for future work:

- The parameter  $I_{HTS}^*$  of the electromagnetic methodology based on the maximum hysteresis loop of the limiter should be considered dynamic in order to simulate the hysteresis loop more realistically, especially in the initial transient after a fault.
- The amplitude decay of the current in the superconducting ring as a function of short-circuit time must be devoted to further investigations. A theoretical model based on the dimensions and properties of the superconducting tape should be able to determine peak amplitude and decay as a function of time, when a short-circuit is occurring in the inductive limiter. This will avoid the need for experimental assessment for characterisation of secondary superconducting rings, during the design stage of a limiter.
- The equivalent circuit model to determine the current in each layer of the tape does not take into account the contact resistance of the soldered joint of the superconducting ring. Further studies

must be devoted in order to assess the influence of the contact resistance of the joint region in quench phenomena.

- The fast method to determine the induced currents in the superconducting ring should be further investigated in order to better predict the non-sinusoidal behaviour of these currents observed experimentally.
- Study of the temperature decay in the superconducting ring after a fault clearance. The hysteretic behaviour of convective heat transfer coefficient should be clarified. The influence of auxiliary materials, such as Teflon, in the cooling process, should also be studied.
- Study of prototypes at higher power ratings and validation of simulation methodologies at such power ratings.






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**Appendix A**

**Dimensions of Celeron Holder**

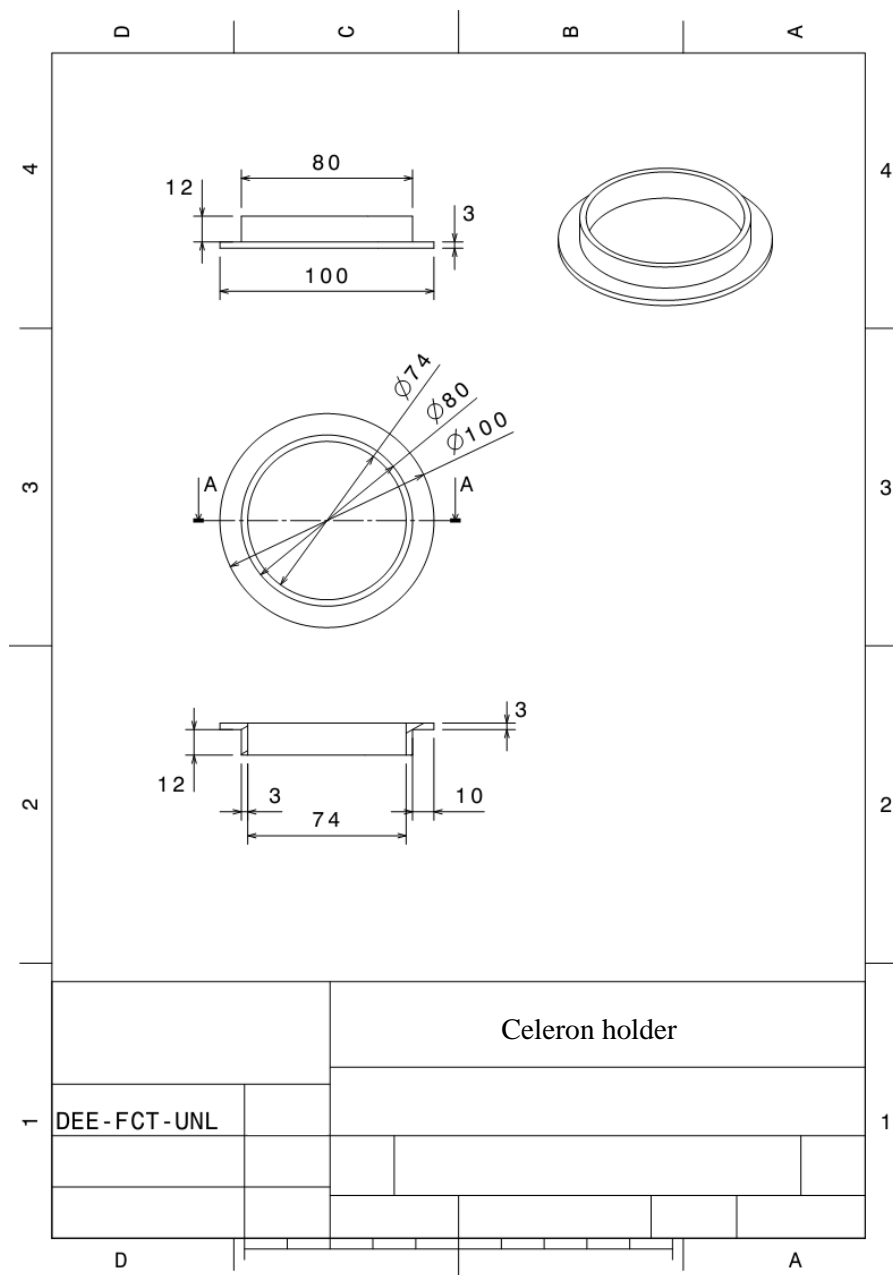


Figure A.1 – Dimensions, in mm, of the Celeron holder.

## Dimensions of Cryostat

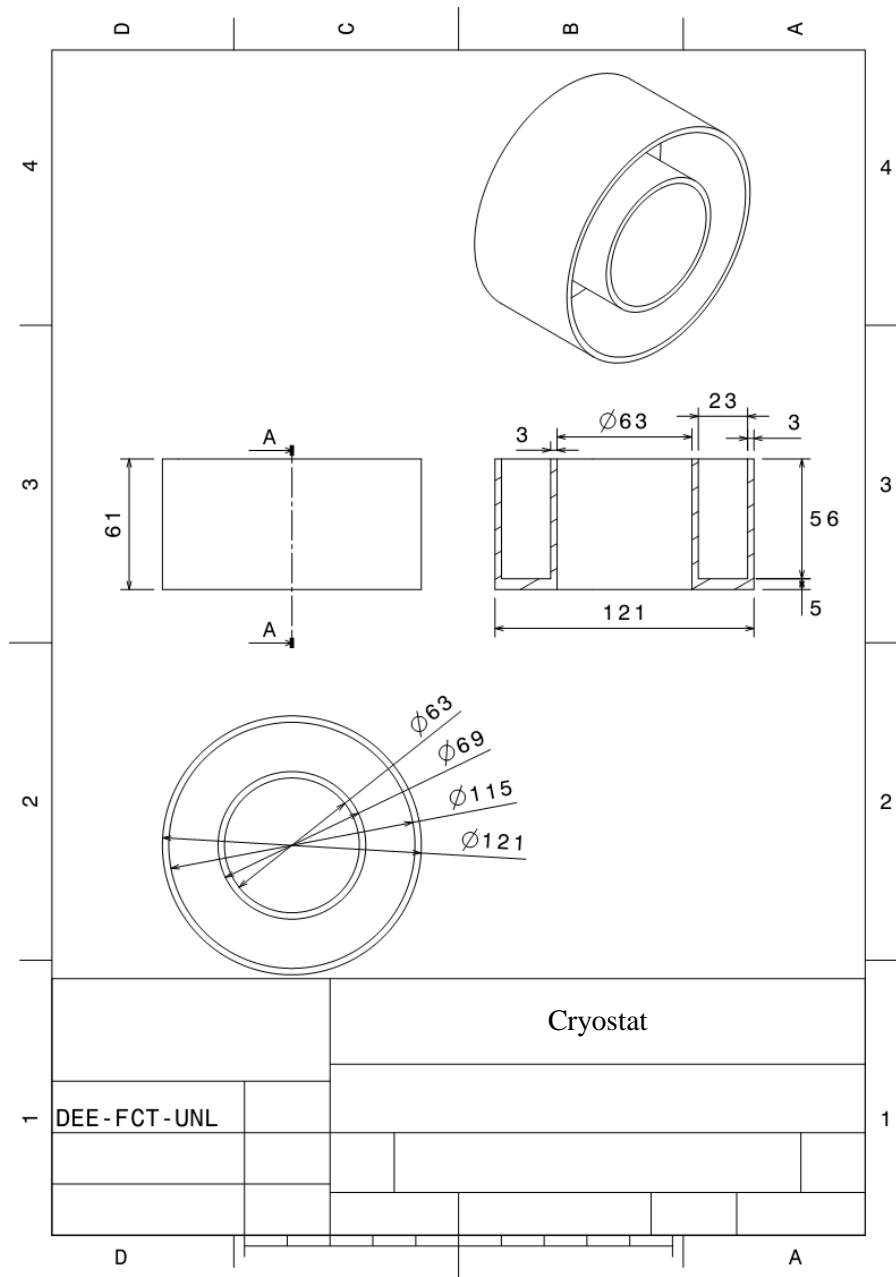


Figure A.2 – Dimensions, in mm, of the cryostat.



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## *Appendix B*

### **Resin Encapsulation Procedure and Metallographic Preparation**

Procedure:

1. Pre-heating cycle at 100 psi (Room temperature – 140 °C).
2. Heating cycle at 4200 psi (140 – 150 °C).
3. Cooling cycle at 4200 psi (150 °C – Room temperature).

Metallographic preparation:

1. Polish at 600 rpm with water polisher (SiC P4000) to clean/eliminate remains of resin.
2. Fine polish at 700 rpm with diamond paste (Diamix 0.25 µm) and solution of distilled water (~90%) with Teepol (~10%) during 100 seconds.

Mounting press: Buehler SimpliMet.

Resin: Buehler TransOptic.

Polisher: Presi Minitex 333.





## Appendix C

### Dimensions of Holder for Ring Type Joining

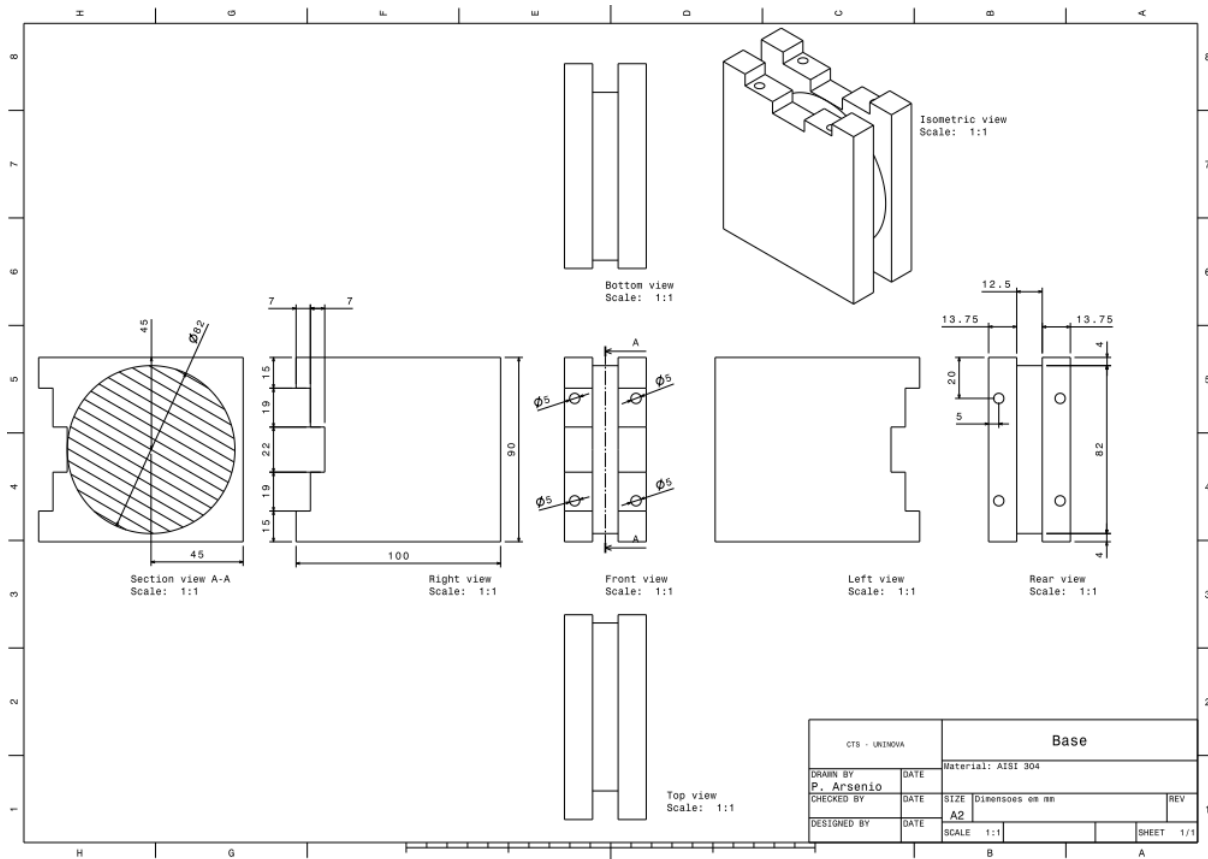


Figure C.1 – Dimensions, in mm, of the base piece of the stainless-steel holder (not to scale).

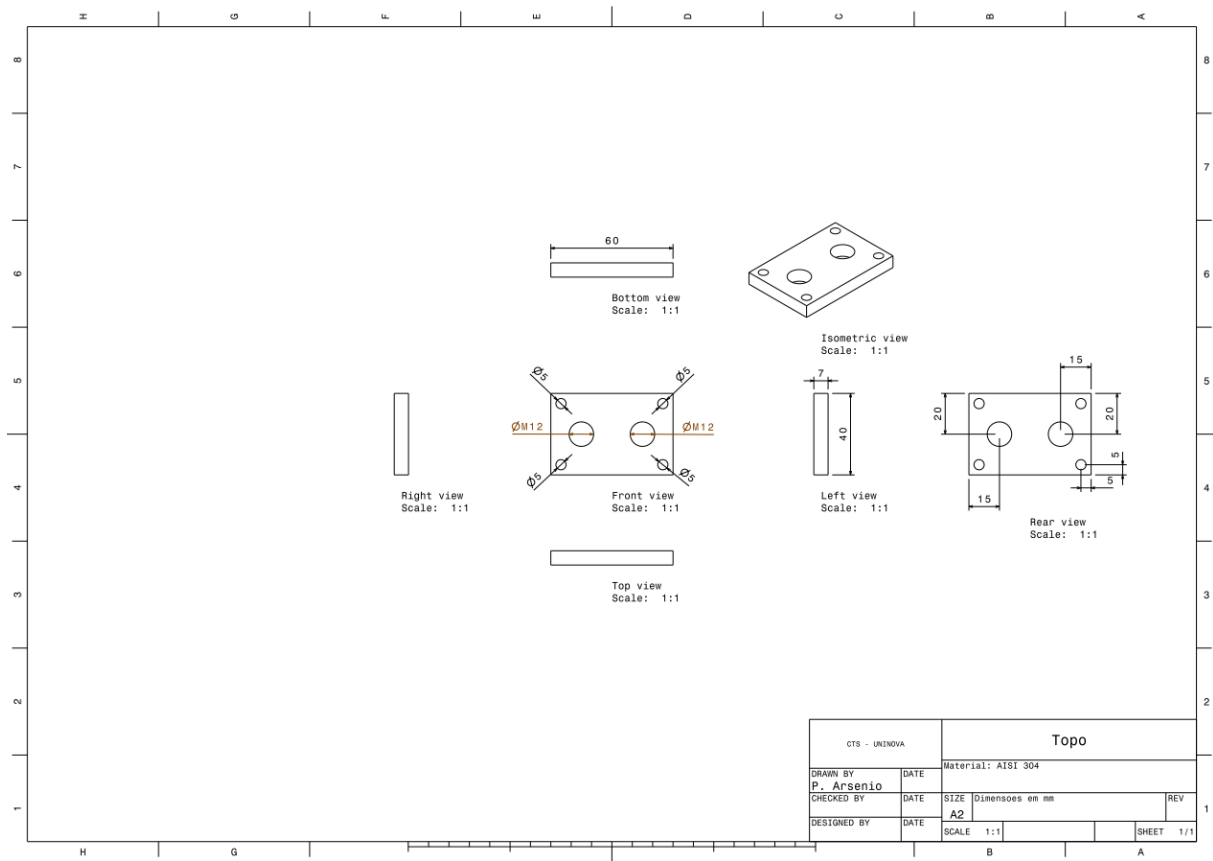


Figure C.2 – Dimensions, in mm, of the top piece of the stainless-steel holder (not to scale).

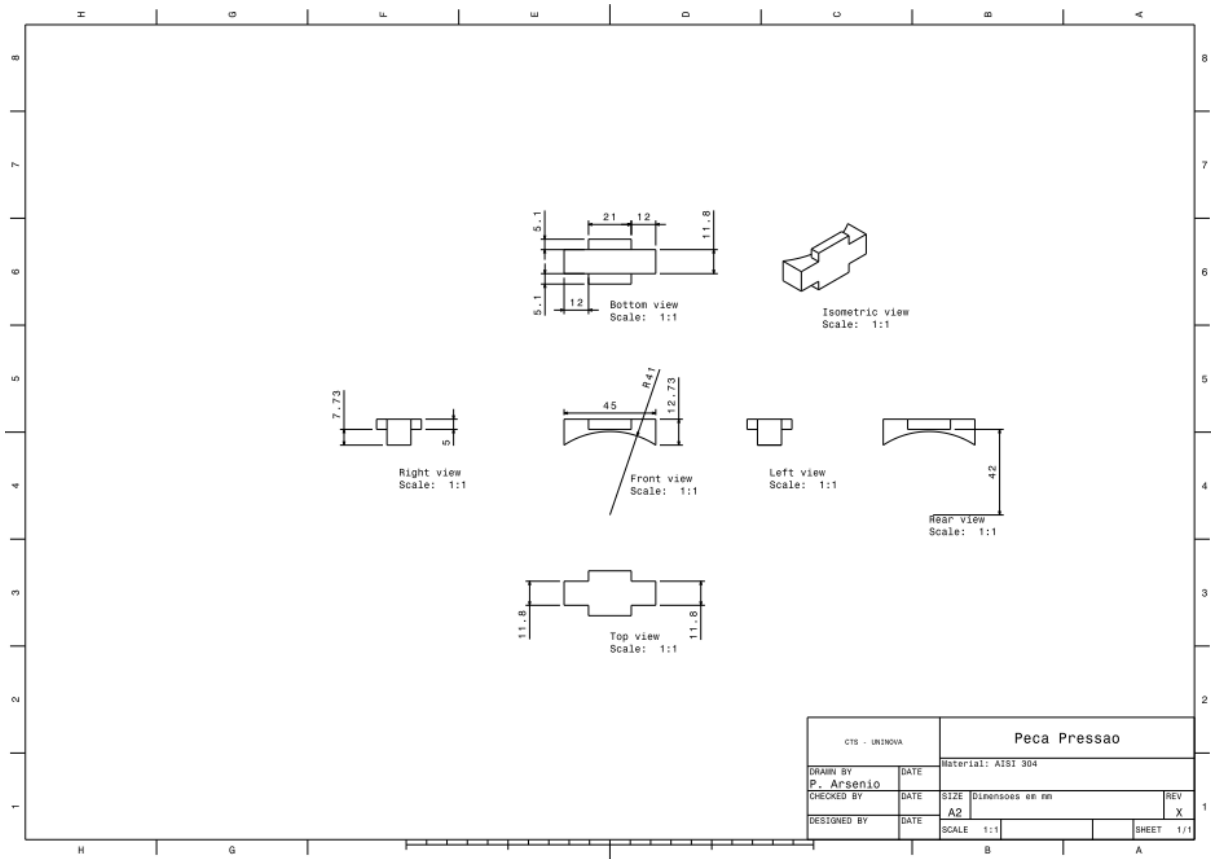


Figure C.3 – Dimensions, in mm, of the pressure piece of the stainless-steel holder (not to scale).





## Appendix D

### Simulated and Experimental Line Current

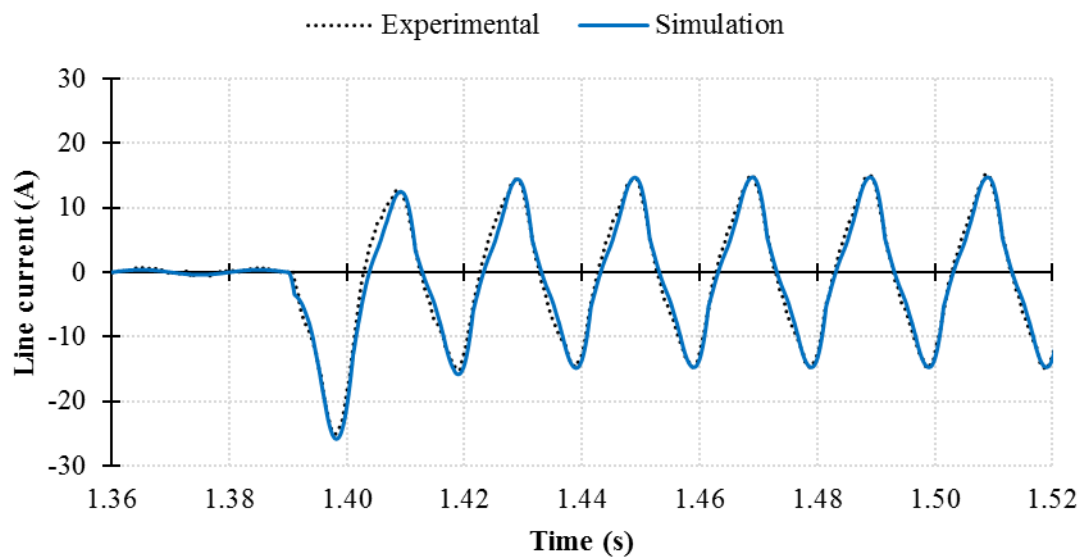


Figure D.1 – Comparison between simulation and experimental results of the line current for a prospective short-circuit current of 40.2 A.

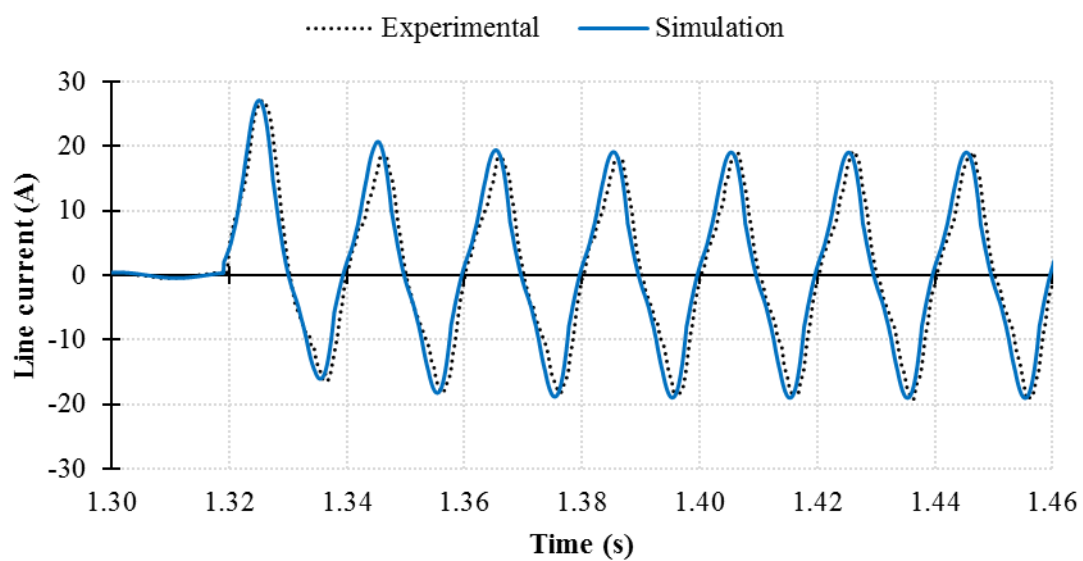


Figure D.2 – Comparison between simulation and experimental results of the line current for a prospective short-circuit current of 60.5 A.

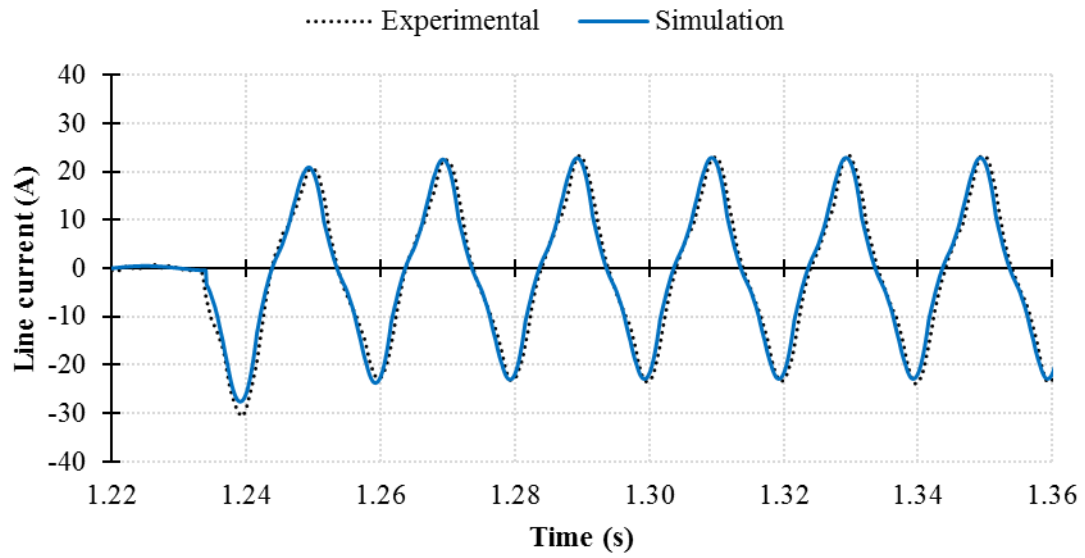


Figure D.3 – Comparison between simulation and experimental results of the line current for a prospective short-circuit current of 67.0 A.

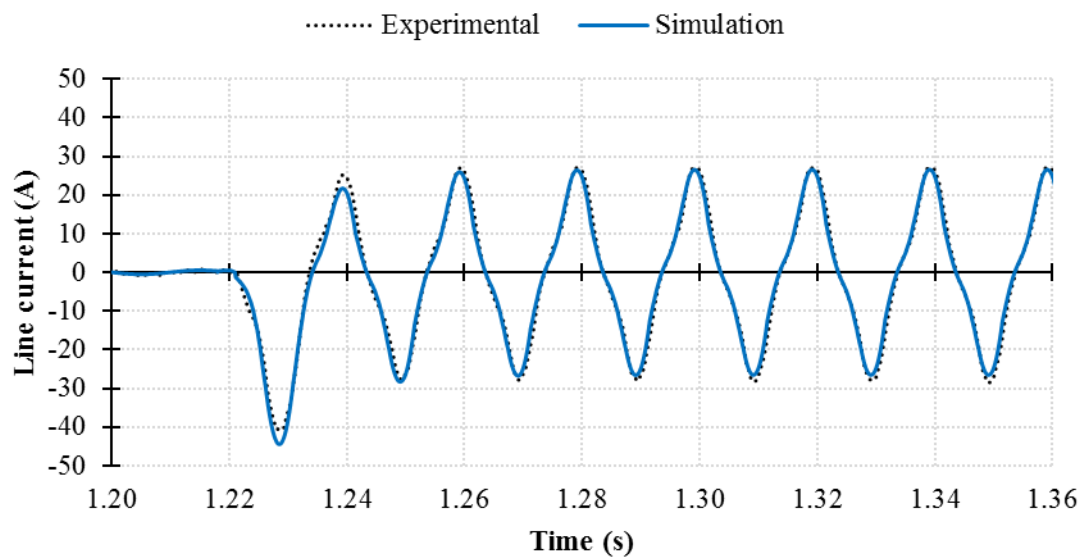


Figure D.4 – Comparison between simulation and experimental results of the line current for a prospective short-circuit current of 69.2 A.

## Simulated and Experimental Primary Linked Flux

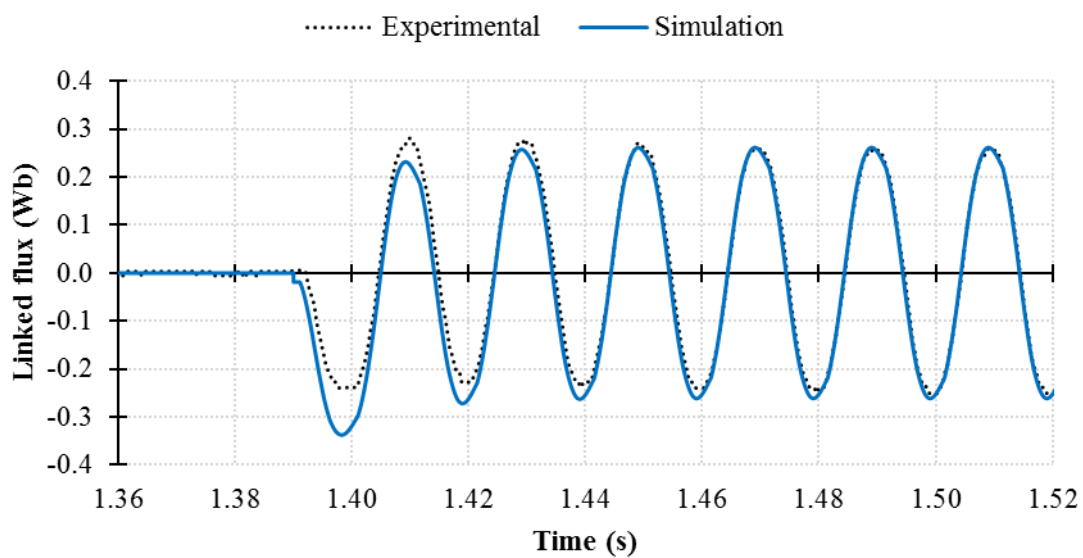


Figure D.5 – Comparison between simulation and experimental results of the primary linked flux for a prospective short-circuit current of 40.2 A.

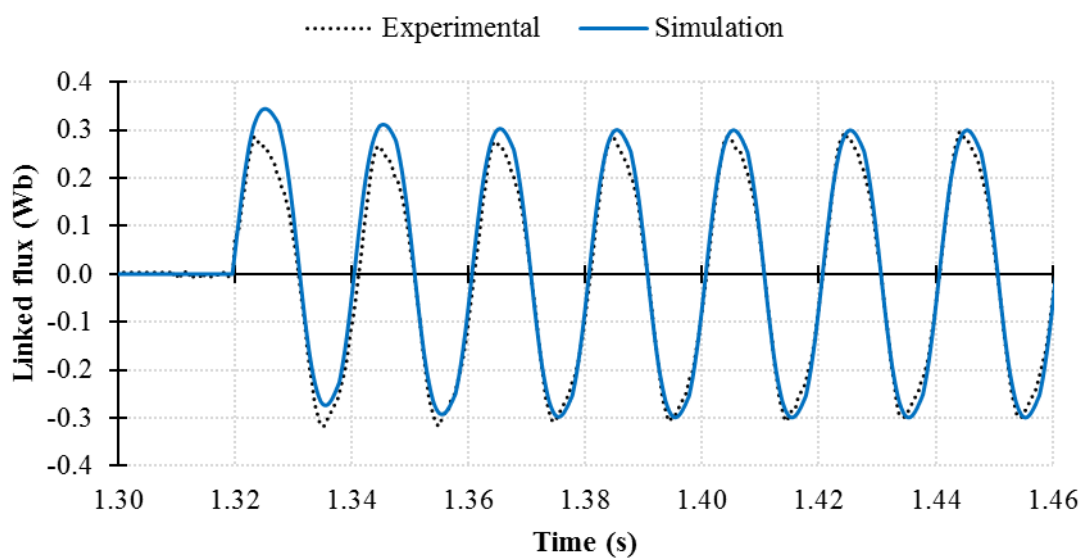


Figure D.6 – Comparison between simulation and experimental results of the primary linked flux for a prospective short-circuit current of 60.5 A.

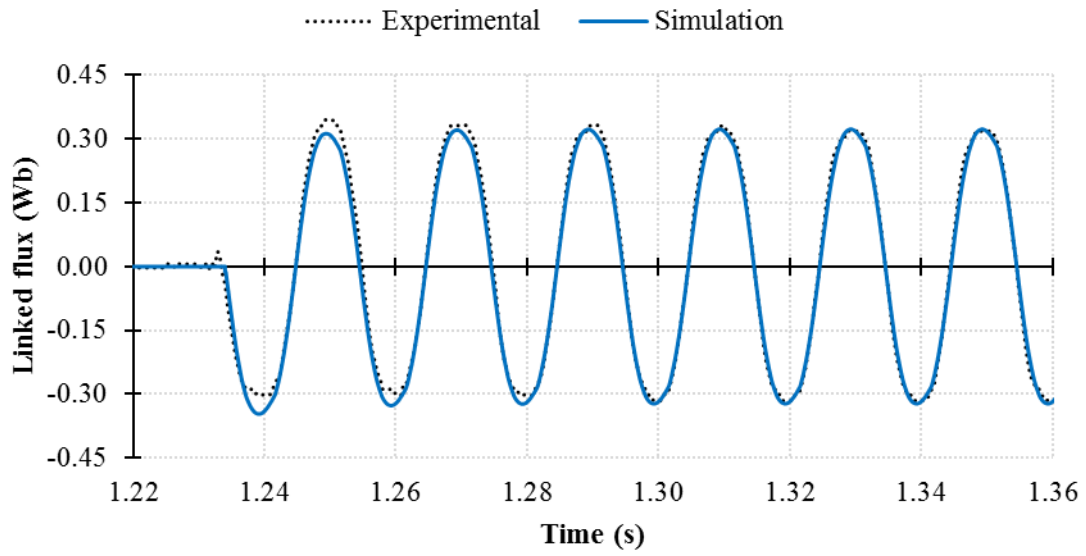


Figure D.7 – Comparison between simulation and experimental results of the primary linked flux for a prospective short-circuit current of 67.0 A.

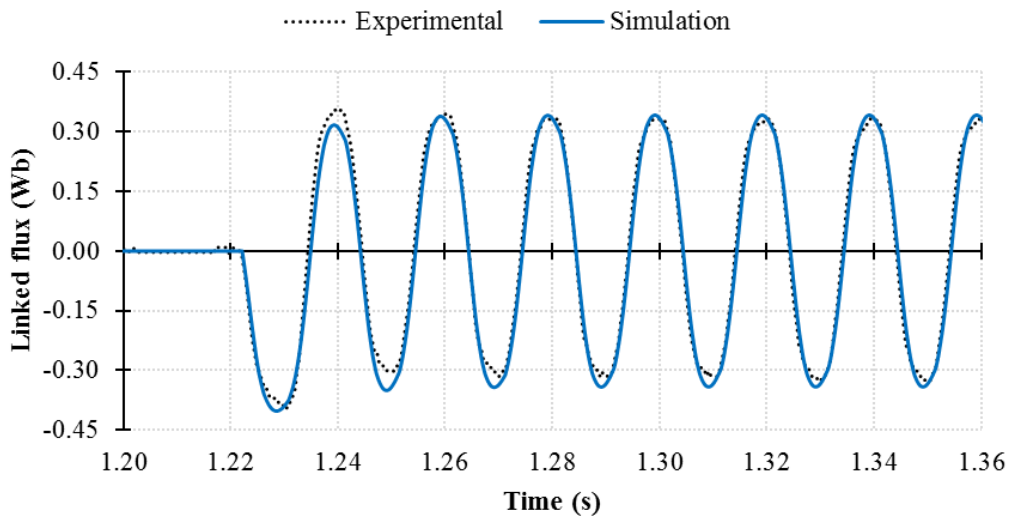


Figure D.8 – Comparison between simulation and experimental results of the primary linked flux for a prospective short-circuit current of 69.2 A.

## Simulated and Experimental Hysteresis Loop

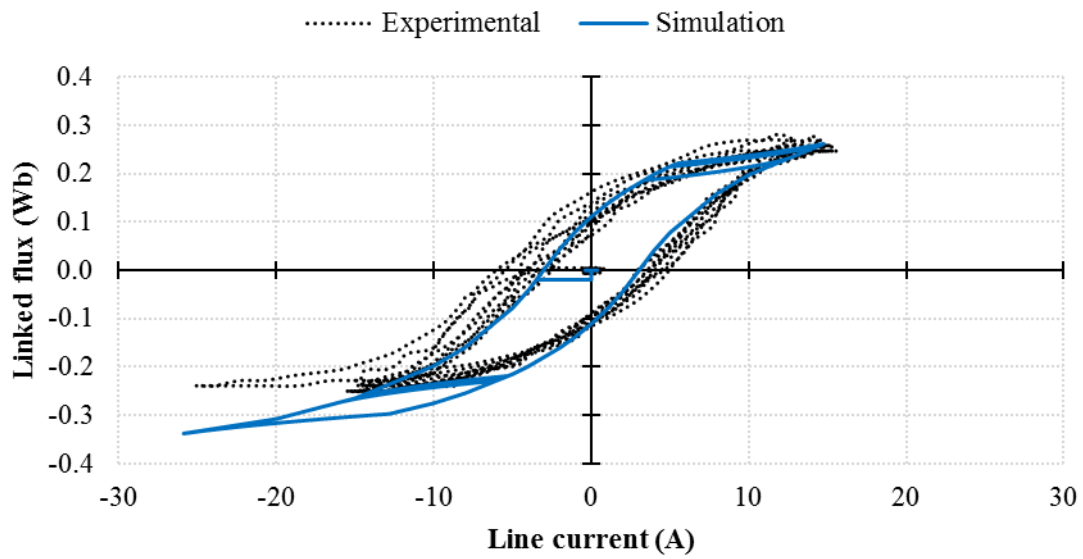


Figure D.9 – Comparison between simulation and experimental results of the hysteresis loop for a prospective short-circuit current of 40.2 A.

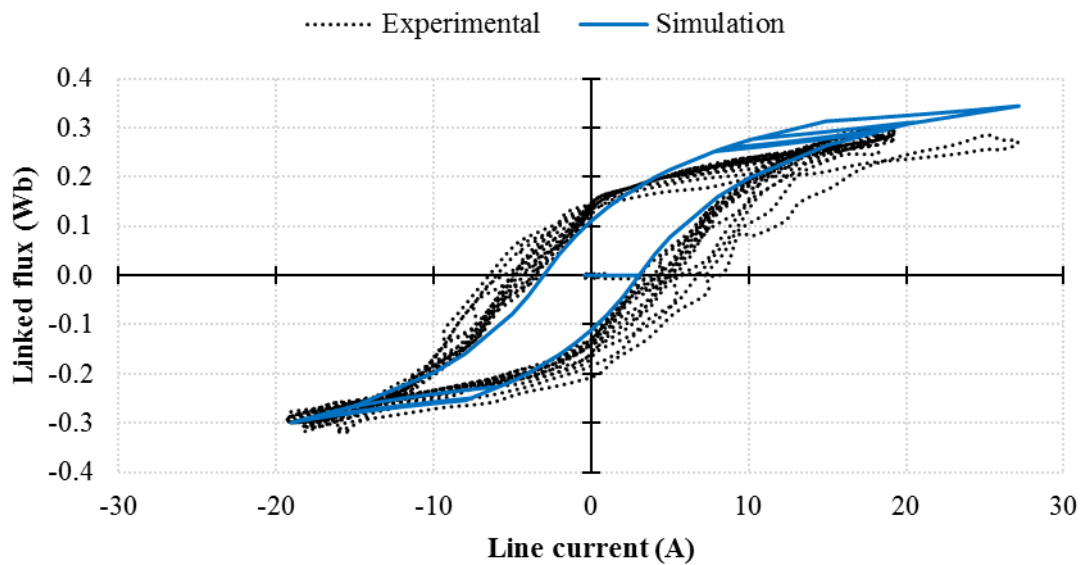


Figure D.10 – Comparison between simulation and experimental results of the hysteresis loop for a prospective short-circuit current of 60.5 A.

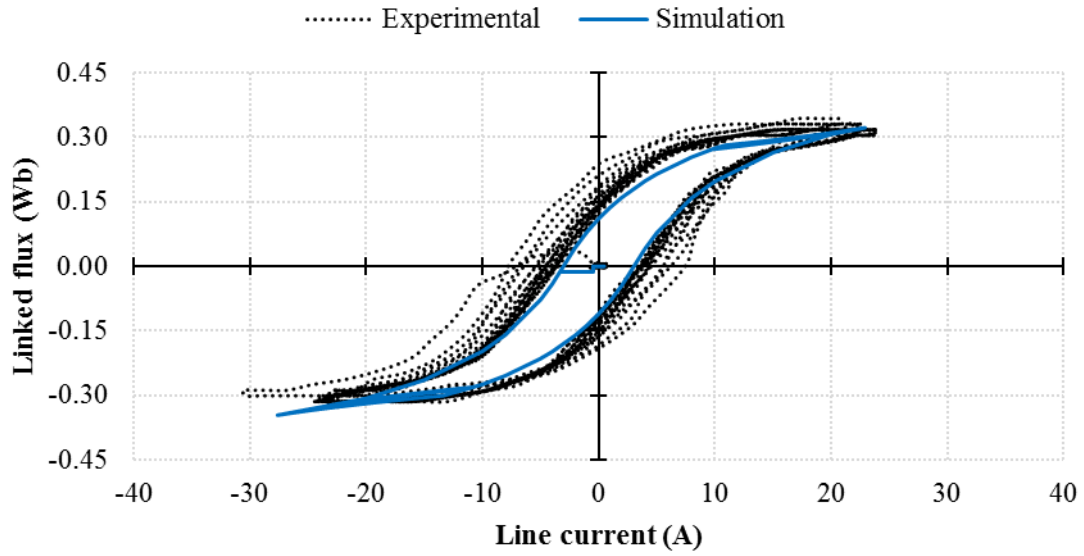


Figure D.11 – Comparison between simulation and experimental results of the hysteresis loop for a prospective short-circuit current of 67.0 A.

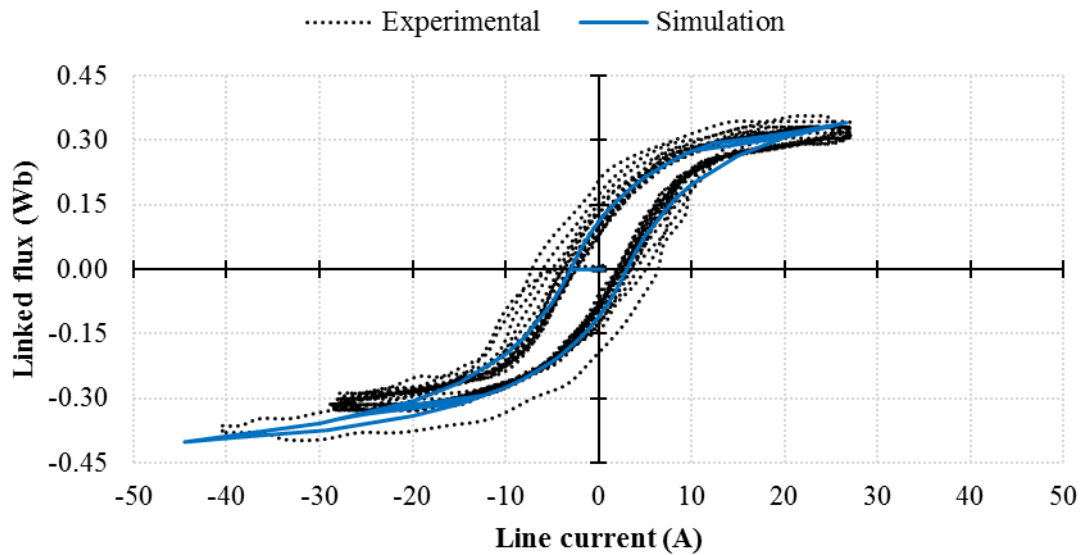


Figure D.12 – Comparison between simulation and experimental results of the hysteresis loop for a prospective short-circuit current of 69.2 A.

## Simulated and Experimental Superconducting Current

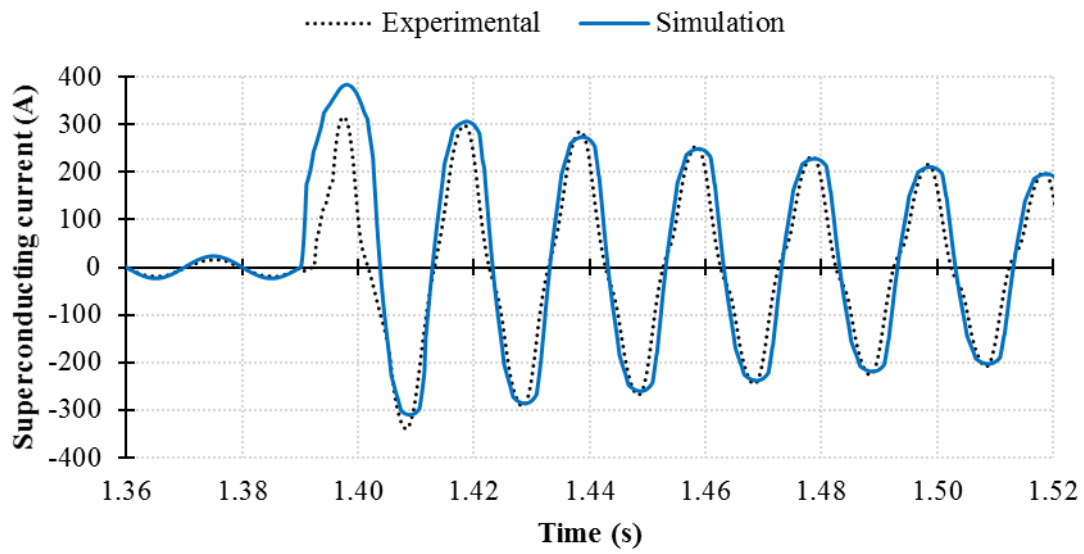


Figure D.13 – Comparison between simulation and experimental results of the superconducting current for a prospective short-circuit current of 40.2 A.

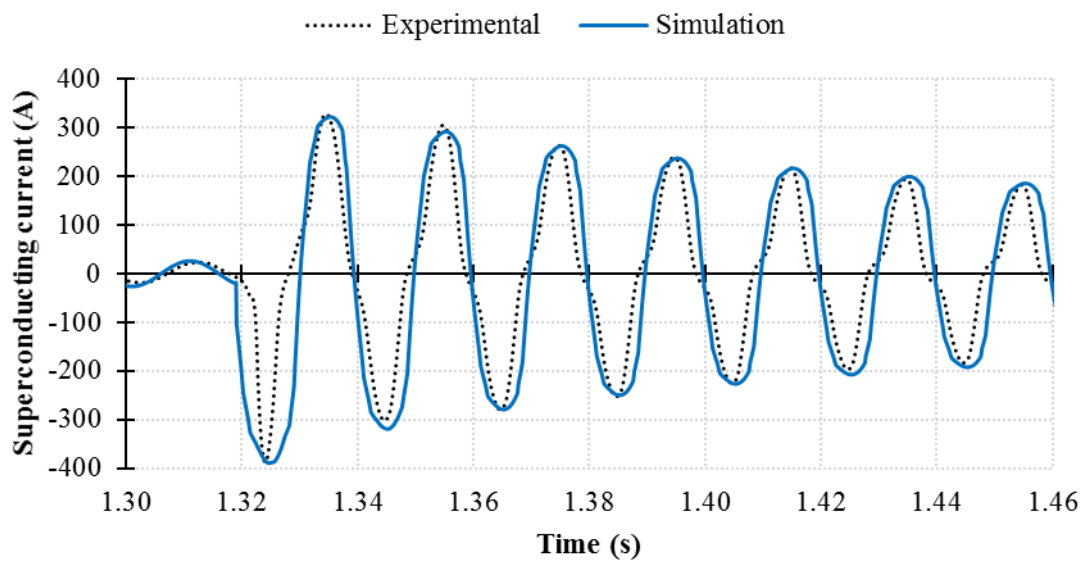


Figure D.14 – Comparison between simulation and experimental results of the superconducting current for a prospective short-circuit current of 60.5 A.

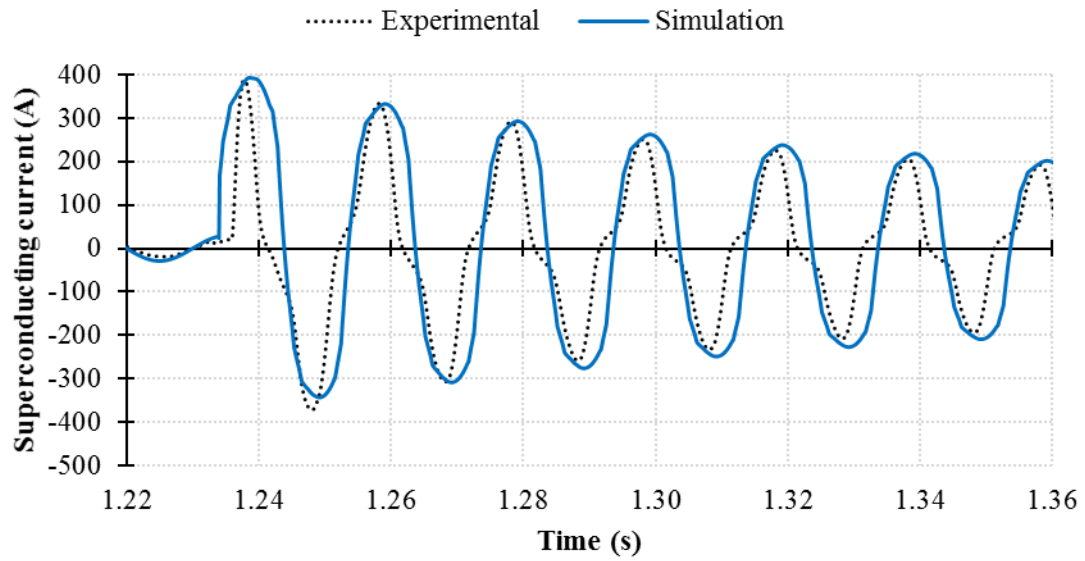


Figure D.15 – Comparison between simulation and experimental results of the superconducting current for a prospective short-circuit current of 67.0 A.

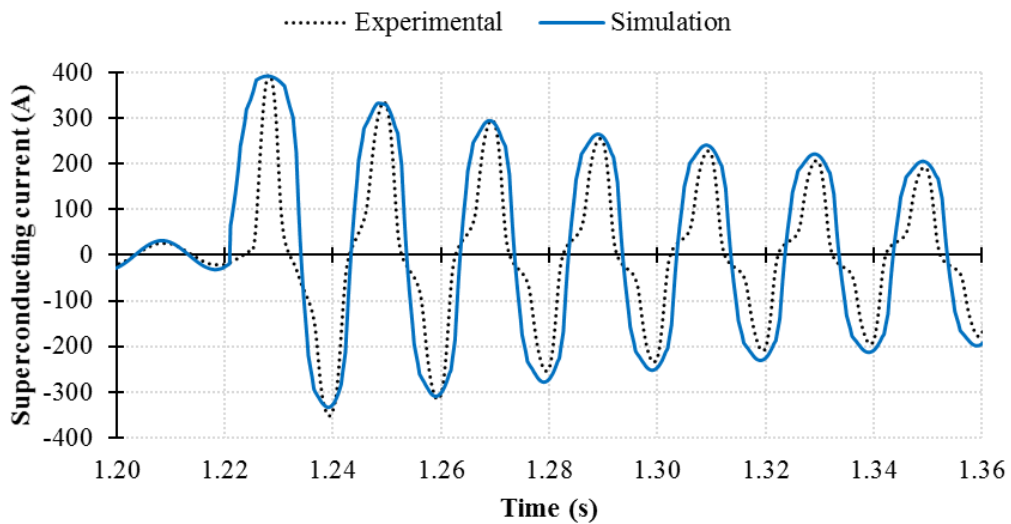


Figure D.16 – Comparison between simulation and experimental results of the superconducting current for a prospective short-circuit current of 69.2 A.

## Simulated and Experimental Temperature in Superconductor

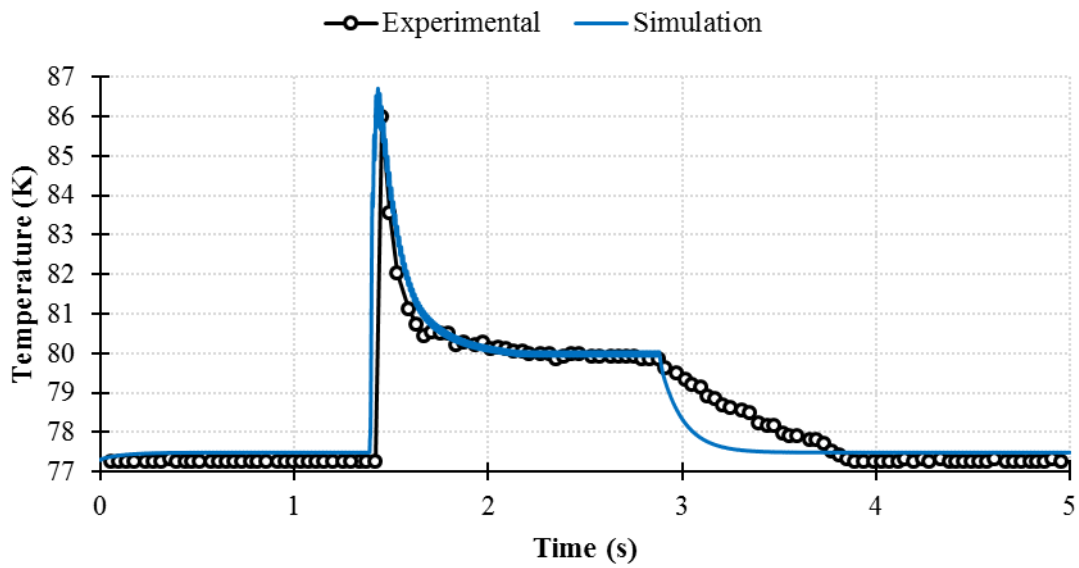


Figure D.17 – Comparison between simulation and experimental results of the temperature in superconductor for a prospective short-circuit current of 40.2 A.

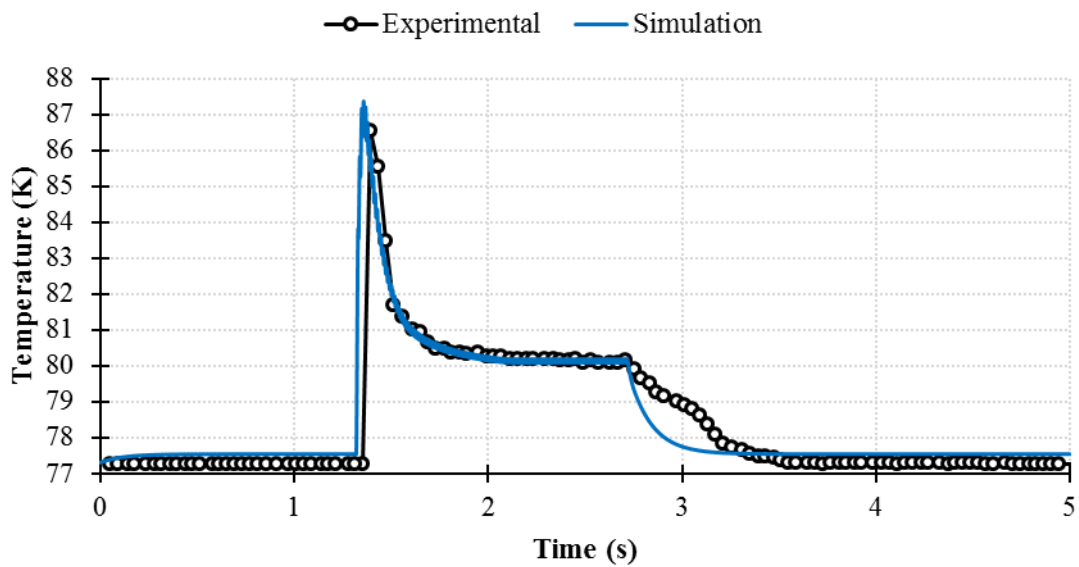


Figure D.18 – Comparison between simulation and experimental results of the temperature in superconductor for a prospective short-circuit current of 60.5 A.

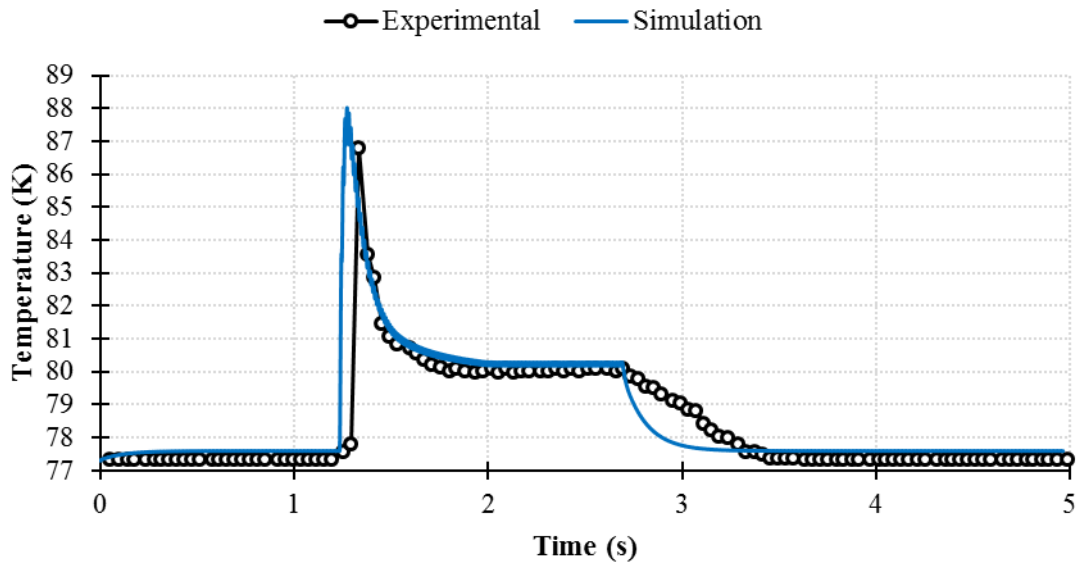


Figure D.19 – Comparison between simulation and experimental results of the temperature in superconductor for a prospective short-circuit current of 67.0 A.

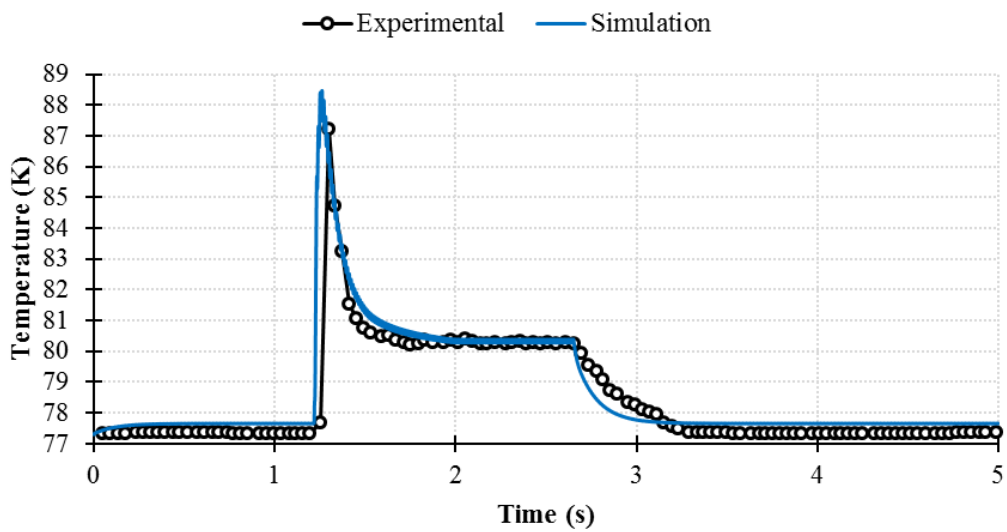


Figure D.20 – Comparison between simulation and experimental results of the temperature in superconductor for a prospective short-circuit current of 69.2 A.